# **MAINTENANCE MANUAL** MASTR CONTROLLER

**SERIES 539 & 549** 



Audio Output

Speaker

Line

Line Loop Impedance (DC Control only)

Compression Range

Frequency Response

Power Requirement

Dimensions (HxWxD)

5 Watts at 3.5 ohms.

+11 dBm (600 ohm load) (150 and 900 ohms optional).

11,000 ohms (8000 line +3000 termination) maximum.

With audio increase of 30 dB beyond start of compression, output level increases less than 3 dB.

+1, -3 dB (300 to 3000 Hz).

20 W (TX), 35 W (RX), 15 W (Stby) 117 VAC  $\pm$  20%, 50/60 Hz

5.12" x 12" x 12.58"

\*These specifications are intended primarily for the use of the serviceman. Refer to the appropriate Specification Sheet for the complete specifications.

**SERIES 539 & 549** 

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#### - WARNING -

No one should be permitted to handle any portion of the equipment that is supplied with high voltage; or to connect any external apparatus to the units while the units are supplied with power. KEEP AWAY FROM LIVE CIRCUITS.

# COMBINATION NOMENCLATURE

	1st Digit	2nd Digit	3rd Digit	4th Digit	5th Digit	6th Digit	7th Digit
	Product	Type of Control	Mechanical Package	Frequency Control	Channel Guard Option	Color	Repeat Disable Option
	D	m	9	4	-	v	-
CC	Remote Control	DC Control	Standard	l Freq.Tx l Freq.Rx	Standard	Standard	Standard
		4		0	N		a
		Tone Control		2-Freq.Tx 1-Freq.Rx	Channel Guard		Repeat Disable
OPTIONS	NS			C	ACCES	ACCESSORIES	
	DC & TONE CONTROL	TROL		)			
8528				2-Freq.Tx	8542	Handset with Hookswitch Channel Guard Desk Mike	Handset with Hookswitch Exchange for Channel Guard Desk Mike
8531		vo meter Control Line Surge Kit		vu ha i - z	8543	Handset with Hooks Standard Desk Mike	Handset with Hookswitch Exchange for Standard Desk Mike
8532		sation Kit		٥	8544	PWB Extension Cables	[es
8534	Partial Speaker Mute 12 Hour Clock	aker Mute ck		1-Fred Tv	5227	Dual Footswitch	
8535		ck ck		2-Freq.Rx	5014	Single Footswitch	
8536					5229	Headset, Head band	
8539		ine Selection		œ	5228	Headset Earmount	
8553		udio Kit			x546	Headset Adanten Dox	•
8566	Switch Name Mod	Mod. Kit		1-Freq.Tx	8549	Boom Mike Exchange for CG Deek Mike	A for CG Dock Wike
	DC CONTROL ONLY	ΓX		1	8550	Boom Mike Exchange	Boom Mike Exchange for Standard Mike
8526	Battery Standby	ndby Kit		OI TWO KX	5179	Stepdown Transformer 230/115 VAC	er 230/115 VAC
8527	Parallel Tra	Parallel Transmit Indicator		U	5273	6-Watt Headset, Earmount	rmount
8530		lling		D	5274	6-Watt Headset, Head band	ad band
8537	Supervisory Control	Control		2-Freq.Tx			
	TONE CONTROL ONLY	ONLY		PSLM(1Rx) or Sim. Mon	-0	INTERFACE KIT OR CABLE FOR ENCODER OR DECODER	LE FOR ENCODER
8538	Take Over Control	ontrol			X560	Interface for Tune	Interface for Two 90 or 90 Tone Decedes
8540	Auxiliary No. 1	o. 1 Control				interface for type	so or se tone Decoder
8541		o. 2 Control			8561	Interface for Type 90 Encoder	90 Encoder
8545		er Kit			8 5 6 2	Interface for Type 99 Encoder	99 Encoder
8547	Two Level St	Two Level Squelch Control	1		8563	Interface for Secode Digital Encoder	de Digital Encoder
8555	Notch Filter	Control & Noten Filter	191		8564	4' Extension Cable	4' Extension Cable for Type 90 Tone Encoder
8548	CG ON-OFF				8565	4' Extension Cable	4' Extension Cable for Type 90 or 99 Tone D
8557	CG and Repeater	ater ON-OFF			8559	Interface for Conne	Interface for Connection to Voting Selector

		- - - -
		-
		-

#### DESCRIPTION

The General Electric MASTR Controller is a compact desk top control console designed for remote control and repeater base stations. The MASTR Controller is provided for DC control (Series 539) or for tone control (Series 549).

The MASTR Controller is housed in a compact cabinet with the selector switches mounted on a slight incline for ease of operation. The standard unit is equipped with a built-in speaker, ON-OFF power switch, volume control, PTT bar and selector switches for the functions provided. A transistorized dynamic microphone is used with the Controller. Blank panels are mounted in the unused switch positions. Light Emitting Diodes are included with each function switch and PTT bar as well as the ON-OFF switch for status indication.

A 12-hour or 24-hour clock and a VU meter are optional accessories that may be located in the vertical panel alongside the speaker grille.

#### DC Control (Series 539)

The Series 539 MASTR Controller utilizes DC current selectively applied to a telephone line to activate circuits at the remote base station. Three current levels are available:  $\pm 6$  milliamps (adjustable to  $\pm 5$  mA.),  $\pm 11$  milliamps (adjustable to  $\pm 15$  mA.), and -2.5 milliamps (adjustable to -6 mA.). The 2.5 mA level provides extra control capability, such as Channel Guard disable with two-frequency transmit and two-frequency receive functions.

An E&M signaling option, along with four-wire audio operation, allows separation of the transmit and receive audio paths and signaling on the M lead of the E&M control pair.

#### Tone Control (Series 549)

The Series 549 MASTR Controller uses audio tones to provide function selection. A total of 12 functions are available. Each function is preceded by a "Secur-it" tone which is a high-level burst of 2175 Hertz transmitted each time a function is selected. The Secur-it tone is decoded at the base station, killing the receiver line audio and enabling the function decoders for a period of 200 milliseconds. After a 125 ms delay, the selected function tone is transmitted for a period of 40 ms. The proper function decoder responds at the station.

The Secur-it tone is used at a level 30 dB below the initial level when the transmit function is selected. This holds the transmitter keyed as long as the PTT switch is depressed.

#### Circuit Boards

System Board AllOl is common to both the DC and tone control versions of the MASTR Controller. To expand the function capability, function boards are plugged into the proper sockets on the System Board and the appropriate function switches are snapped into place. Bead-chain connectors from the switches are connected to the proper pins on the System Board. Audio Board 19D416629Gl is also common to both series of Controllers.

#### TELEPHONE LINE CHARACTERISTICS

As a result of propagation conditions, ambient noise levels, space limitations or other conditions, the most advantageous location for the dispatcher may not be the best location to originate or receive transmissions. The MASTR Controller permits the dispatcher to transmit, receive, select transmitter and receiver frequencies, etc. over telephone lines. Control currents applied to the telephone lines from the controller are normally translated into the desired operation at the base station by the remote control panel.

The key link in a remote control installation is the telephone pair between the Controller and the base station. To obtain the most satisfactory service over this link, some general knowledge of the capabilities of such lines is required.

A telephone pair is simply a pair of wires, normally ranging from AWG #19 to AWG #26 in size. These wires, furnished by the local telephone company, pass through over-head cables, underground cables, through junction points, and switchboards. To the user, however, they may be considered a simple pair of wires. Equipment that is designed to operate with such a pair should have nominal impedance of 600 ohms. A telephone pair will normally have a maximum length of about 12 miles before amplification is added by the telephone company to make up for line losses. There is an inherent loss in any telephone line installation due to the series inductance and resistance and the shunt capacitance of the wires. This loss is a direct function of the length of the line, and varies with the wire size used. As an example, with AWG #19 wire, a distance of six miles may be covered before one-half the input voltage of a 1,000 Hz tone is lost. With AWG #26 wire, only two and one-quarter miles may be covered before one-half the input voltage is lost. Line losses as high as 30 dB can be tolerated in operating a transmitter from the Controller, but such high losses should be avoided whenever possible. Although the telephone pair is fairly well balanced, some noise will be induced into the line, especially if an unshielded run has to be made in a fluorescent-lighted building.

The amount of noise pickup is a function of the length of the line and the environment through which it passes. Assume, for instance, that 0.01 Volt of noise is picked up in a particular installation. If the audio output of the Controller is 1 Volt and the line loss is 10:1, the audio signal at the base station is 0.1 Volt, only 10 times (20 dB) higher than the noise.

This relatively high background noise would greatly reduce the intelligibility of the system and, consequently, the maximum working range. Now, consider a short line in which the noise pick-up is only 0.002 Volt and the line loss only 2:1. The signal at the receiving end would then be 250 times (48 dB) greater than the noise. For the best signal-to-noise ratio, the shortest, lowest loss line available is desired.

The DC resistance of any telephone pair will affect the control circuits between the Controller and the base station. Current regulators incorporated in the MASTR controller minimize these variations after initial adjustment. The Controller operates with a total control line loop resistance as great as 8000 ohms. There is a possibility, however, that stray currents, due to leakage, noise, faults, earth currents, etc., may cause faulty operation.

Three types of telephone line connections are commonly used. Before choosing one of these types, consider the cost and performance of each, as one type may be available at a much lower rate. Also, some telephone companies offer no choice. The following chart contains information to assist in selecting the control method and type of telephone line to be used in DC control applications.

Any transmission circuit capable of handling audio frequencies in the 300 to 3000 Hz range can be used for tone control.

It is not necessary to observe polarity in wire line connections.

# DC Control Telephone Line Connections (Refer to Figure 1)

Connect the telephone lines to Terminal Board TB1101, using one of the following methods:

Method 1 - Single telephone pair (control voltage simplexed line to line)

- a. Connect telephone pair to TB1101-1 and TB1101-2.
- b. Connect jumper between TB1101-3 and TB1101-5.
- c. Connect jumper between TB1101-4 and TB1101-6.

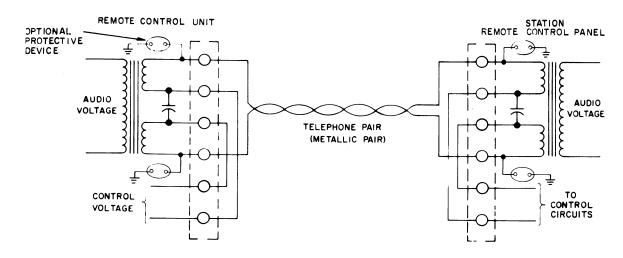
Method 2 - Single telephone pair (Control voltage simplexed line to ground)

- a. Connect telephone pair to TB1101-1 and TB1101-2.
- b. Connect jumper between TB1101-4 and TB1101-5.
- c. Connect jumper between TB1101-6 and TB1101-17.
- d. Connect jumper between TB1101-3 and TB1101-4.

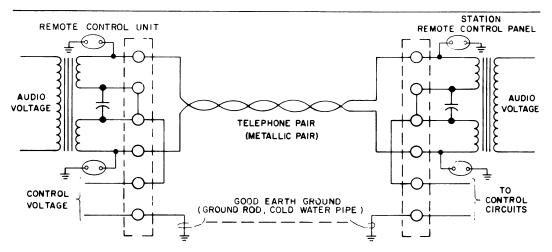
Method 3 - Separate Control and audio pair

- a. Connect audio pair to TB1101-1 and TB1101-2.
- b. Connect control pair to TB1101-5 and TB1101-6.
- c. Connect jumper between TB1101-4 and TB1101-3.
- d. Remove jumpers between holes 14 and 15 and between holes 16 and 17 on System Board Allol.

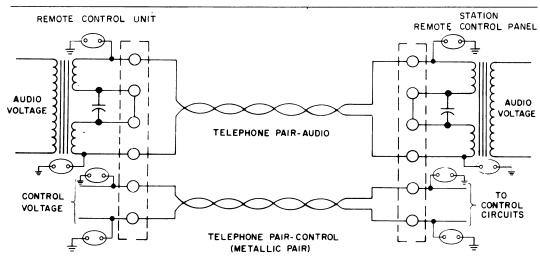
METHOD	DESCRIPTION	ADVANTAGES OR DISADVANTAGES
1	One metallic pair: for both audio and control voltages with control voltage simplexed from line to line.	Economical; dependable where earth currents may be large, or where a good earth ground cannot be obtained; keying clicks will be heard in paralleled Remote Control Units.
2	One metallic pair: for both audio and control voltages with control voltages simplexed from line to ground.	Economical; earth ground currents (encountered near power company substations) may result in interference with control functions; keying clicks minimized.
3.	Two telephone pairs; one for audio voltage and one for control voltage (metallic pair).	Provides best performance; keying clicks will not be heard; least susceptible earth ground currents which may interfere with control functions.



METHOD I - SINGLE TELEPHONE PAIR WITH CONTROL SIMPLEXED LINE TO LINE



METHOD 2- SINGLE TELEPHONE PAIR WITH CONTROL SIMPLEXED BETWEEN CENTER TAP AND GROUND



METHOD 3- SEPARATE CONTROL AND AUDIO PAIRS

RC-2556 A

#### Proper Grounding Practices (Method 2)

The telephone company specifies that their customer's equipment signal ground should be made using the proper connection to a ground electrode such as a metallic cold water pipe.

The ground connection should be made with a single No. 14 AWG or larger copper conductor. The conductor should be short, straight and a continuous piece of wire. Attention should be given to providing the lowest possible resistance at the connection at each end of the ground wire.

When optional line surge protection devices are provided in the customer equipment, it is imperative that the good earth ground be used. If the telephone company also provides protective devices, the customer provided device earth ground connections should be located close to the telephone company earth ground connection but should not use the same ground clamp that the telephone company uses.

If a good earth ground as described above cannot be obtained, Method 2 should not be used. Also, the addition of surge protective devices are of little value without the proper earth ground.

#### Four-Wire Audio

In remote control two-way radio systems where customer-owned multiplex/microwave systems are utilized, or where leased lines obtained from the local telephone company do not utilize hybrids in the transmission path, 4-wire audio operation may be required. The 4-wire audio system provides separate connections for the receive audio path and the transmit audio path. See Figure 2.

The 4-Wire Audio Kit (Option 8553) consists of a separate transformer mounted to the System Board. Refer to the Installation Instructions for Option 8553.

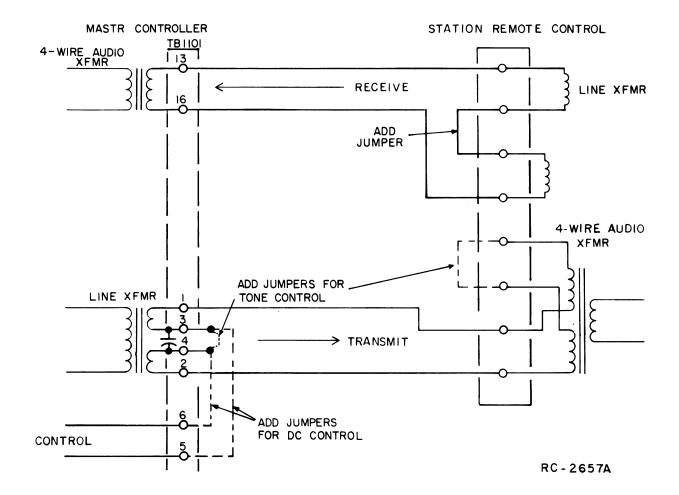


Figure 2 - Typical 4-Wire Audio Installation

#### E & M Signaling

E & M lead signaling systems derive their name from certain historical designations of the signaling leads on circuit drawings. An "M" lead is associated with the transMit function while the "E" lead is associated with the recEive function. In two-way radio systems with remote control, E & M Signaling may be the only type of supervision offered by the available carrier circuits.

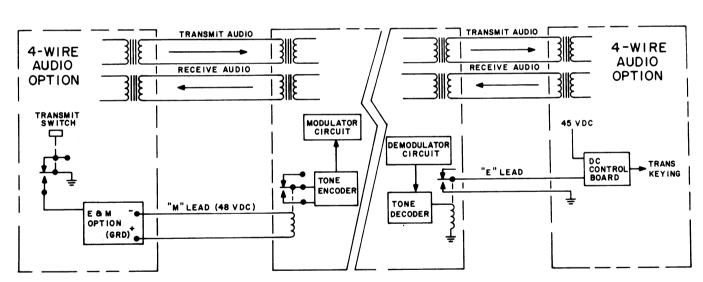
Generally both 4-Wire Audio and E & M Signaling options are used to interface between the radio and carrier systems. However, 2-Wire Audio may be used in the two-way radio portion of the control system if hybrids are installed to provide transition between the 2-wire and 4-wire connections. Usually the E & M Signaling is separated from the audio (separate line) in both 2-wire and 4-wire installations.

Figure 3 illustrates a typical interface between a two-way radio system and a multiplex/microwave system. The Remote Control Console and Base Station are equipped with the E & M Signaling Option and 4-Wire Audio Option. The console provides a regulated -48 VDC output (or -24 VDC with minor modifications) to the "M" lead when the TRANSMIT switch is pressed. This -48 volts activates a tone encoder (usually 3825 Hertz) in the multiplex rack. The tone encoder modulates the carrier frequency which is transmitted over the microwave link.

At the station end of the microwave link, the signal is demodulated and the 3825 Hertz tone operates a tone decoder in the multiplex rack. The output of the decoder results in a contact closure to provide transmitter keying in the Remote Control Base Station.

REMOTE CONTROL UNIT

MULTIPLEX/MICROWAVE SYSTEM BASE STATION (I FREQ TX & RX)



RC-2688

Figure 3 - Typical Application of E & M Signaling

#### DC CONTROL CIRCUIT ANALYSIS

(Refer to DC Control System Diagram)

#### Control Functions

By using accessory kits and options, the MASTR Controller can perform a max-mum of six different DC control functions.

This is accomplished by applying three different levels and changing the polarities of the control current to activate switches at the station remote control panel. The control current requirements for selecting each function in "T" series MASTR Professional Remote and Repeater Stations are listed in Table 1.

TABLE 1

DC CONTROL CURRENT AND FUNCTION

FUNCTION	CONTROL CURRENT IN MILLIAMPS					
	-11	-6	-2.5	0	+6	+11
l Freq. TX (P) l Freq. RX				Receive	Transmit	
2 Freq. TX (P) 1 Freq. RX				Receive	TX-F1	TX-F2
1 Freq. TX 2 Freq. RX		RX-F2		RX-F1	Transmit	
2 Freq. TX 2Freq. RX		RX-F2		RX-F1	TX-F1	TX-F2
l Freq. TX & PSLM or 2 separate Receivers	RX-F2	RX-F1		RX-F1&F2	Transmit	
2 Freq. TX & PSLM or 2 separate Receivers	RX-F2	RX-F1		RX-F1&F2	TX-F1	TX-F2
l Freq. TX (P) l Freq. RX with Channel Guard Disable			CG D <b>i</b> sable	Receive With CG	Transmit	
2 Freq. TX (P) 1 Freq. RX with Channel Guard Disable			CG Disable	Receive With CG	TX-F1	TX-F2
1 Freq. TX 2 Freq. RX with Channel Guard Disable	RX <b>-</b> F2 CG Disable	RX-F2 with CG	RX-F1 CG Disable	RX-F1 with CG	Transmit	
2 Freq. TX 2 Freq. RX with Channel Guard Disable	RX-F2 CG Disable	RX-F2 with CG	RX-F1 CG Disable	RX-F1 with CG	TX-F1	TX-F2
Repeater Disable		Repeater Disable		Receive	Transmit	
Repeater Disable & Channel Guard	Repeater Disable & CG Disable	Repeater Disable	CG D <b>i</b> sable	Receiver With CG	Transmit	

- NOTE -

Functions marked with symbol (P) can be used in Parallel consoles. When units with Channel Guard are paralleled, CG Disable must be a momentary function.

#### DC Control of KC16 Remote Control Panel

The control current required to select each function in the KCl6 Remote Control Panel is given in Table 2.

TABLE 2

DC CONTROL CURRENT AND FUNCTION FOR KC16 CONTROL PANEL

FUNCTION		CONTROL CURRENT IN MILLIAMPERS			
	-15**	-6**	0	+6*	+15**
1 Freq. TX 1 Freq. RX (P)			Receive	Transmit	
2 Freq. TX 1 Freq. RX			Receive	TX-F1	TX-F2
1 Freq. TX 2 Freq. RX		RX-F2	RX-F1	Transmit	
2 Freq. TX 2 Freq. RX		RX-F2	RX-F1	TX-F1	TX-F2
1 Freq. TX and PSLM or 2 Separate Receivers	RX-F2	RX-F1	RX-F1&F2	Transmit	
2 Freq. TX and PSLM or 2 Separate Receivers	RX-F2	RX-F1	RX-F1&F2	TX-F1	TX-F2
1 Freq. TX and Receive with Channel Guard (P)			Channel Guard Receive	Monitor (Noise Squelch)	Transmit
Repeater Disable		Repeater Disable	Receive	Transmit	
Repeater Disable Channel Guard	Repeater Disable and Monitor	Repeater Disable	Channel Guard Receive	Monitor (Noise Squelch)	Transmit

<sup>\*</sup>Jumper from H13 to H14 on H. V. Board 19D416592 must be moved to between H13 and H15. 5K resistor R35 must be adjusted for 6 mA.

<sup>\*\* 1</sup>K resistor R37 must be adjusted for 15 mA.

#### Connections

All connections to the MASTR Controller except the power connections are made at the screw terminals on TB1101. For proper operation of the DC control circuits, the polarity of the telephone pair carrying the control currents must be the same at both the MASTR Controller and the station remote control panel. To identify the wires at each end of the telephone line, temporarily short one wire of the control pair (disconnected from the equipment) to a good earth ground at the station remote control panel and measure the resistance between each of the two wires and a good earth ground at the MASTR Controller. The ungrounded wire will appear as an open circuit. The grounded wire will show a resistance which will depend upon the size and length of the pair used.

Label each end of the wire and remove the ground. Remove the short. Be sure that both of the telephone wires which carry the control currents are connected to corresponding terminals on the MASTR Controller and the remote control panel.

# Single Frequency Transmit and Single Frequency Receive

The single frequency transmit and single frequency receive DC control function requires the use of High Voltage Module 19C320169 connected to J1104 on the MASTR Controller system board. The high voltage from the controller power supply is applied to pins 7 and 8 and connected to current regulator Q1 and VR1. When zero current is applied to the control pair at pins 2 and 13, the control circuit is in the receive mode. When the TRANSMIT bar is pressed, PTT ground is applied to the 250 kHz oscillator Q3, initiating oscillator operation. The 250 kHz signal serves as a bias circuit for the current regulator, current selection, and provides isolation for the control pair.

The 250 kHz signal is coupled through transformer T1 and turns on regulator switch Q2. This switch allows Q1 to conduct and the current through Q1 is regulated by VR1. The +6 mA is adjusted by potentiometer R2. The regulated control current is applied to the control pair at pins 2 and 13 to key the transmitter at the remote station.

#### Multi-Frequency Switching

Switching more than one transmit or receive frequency requires the application of High Voltage Module 19D416592 connected to J1103 and J1104 on the systems board. Refer to the Schematic Diagram (See Table of Contents) for the function switch legends and jumper connections on the 19D416592 Board.

The selection function applies a ground to the appropriate terminal at P3. For example, selecting XMIT #2 transfers ground from terminal P3-9 to P3-8. CR23 is for-ward biased, preventing Q2 from conducting. Since ground is removed from P3-9. CR27 is back biased. Q1 and Q3 are normally conducting, holding Q2 and Q4 off. the PTT lead is grounded, CR24 and CR25 are forward biased. This turns off Q1 and Q3. Since CR27 is back biased, Q4 is now allowed to conduct. Conduction of Q4 forward biases CR10 and CR11. This allows the 250 kHz oscillator (Q12) output to flow through the primary of T4 and T5. Transformer T4 serves as the bias coupler for the 11 mA selector transistor Q15. Q15 conducts and the 11 mA control current is applied to the line. The 11 mA current is adjusted by R37.

The oscillator output is also allowed to flow through the primary of T5. This current is applied to the SCR bridge (CR42 - CR48) to provide a positive 11 mA at the control pair connected to P4-2 and P4-13. Similarly, T6 provides a negative polarity for the selected control current; T2 and Q13 provide a control current of 2.5 mA adjusted by R35, and T3 and Q14 provide a control current of 6 mA adjusted by R36.

#### Channel Guard Control

In standard Channel Guard applications, Channel Guard microphone 19B209459Pl is provided. A CG MONITOR switch is located on the microphone. When the microphone is unkeyed and the MONITOR switch is not depressed, no control current is applied to the control pair. This selects Channel Guard operation at the base station for Receive - Fl. In applications with 2-Frequency Receive, when the REC F2 function is selected the -6 mA control current is applied to the line. In either of these cases, Channel Guard operation is selected at the base station, and only those transmissions coded by the proper Channel Guard tone will be heard at the MASTR Controller.

Pressing the MONITOR switch on the microphone applies ground to the Channel Guard latch flip-flop (Q17 - Q18), turning on Q17 and turning off Q18. Turning off Q18 turns on Q19, applying a negative potential to operate the Channel Guard Monitor Lamp and turning off Q5. Q6 conducts, connecting -2.5 mA to the control pair. This disables the station Channel Guard so that all transmissions on the receiver frequency selected can be heard. Pressing the PTT switch applies either +6 mA (TX-F1) or +11 mA (TX-F2) to the control pair to key the desired transmitter. If negative currents other than -2.5 mA are used, parallel operation of the MASTR Controllers is not recommended.

For momentary operation of Channel Guard control refer to the Wiring Diagram of High Voltage Module 19D416592 (see Table of Contents).

#### Remote/Repeater Control

In remote/repeater applications, the station transmitter may be keyed by either an incoming RF signal (repeater operation) or by a control current from the MASTR Controller. Two methods may be employed to give the dispatcher priority over repeater operations.

#### 1. Without Repeater Disable:

When the Repeater Disable option is not employed, keying the microphone applied +6 or +11 mA to the control pair. This opens the ground return of the COS at the repeater station. The station will then operate as a remote only as long as the microphone remains keyed.

#### 2. Repeater Disable:

With the Repeater Disable option, pressing in the REPEAT DISABLE switch applies -6 mA to the control pair. This opens the ground return to the COS at the repeater station, and the station will operate as a remote as long as the REPEAT DISABLE switch remains depressed.

#### Repeater Disable and Channel Guard Monitor

With the microphone unkeyed and the CG MON switch not depressed, Channel Guard is energized and no control current is applied to the control pair. This permits normal Channel Guard and repeater operation. Pressing the MONITOR switch on the microphone or the Controller applies -2.5 mA to the control pair. This disables the station Channel Guard so that all transmissions on the receiver frequency can be heard. The station will still operate as a repeater whenever a properly tone-coded message is received.

With the MONITOR switch not depressed, pressing the REPEAT DISABLE switch applies -6 mA to the control pair. This removes the ground to the Carrier Operated Switch (COS) on the repeater control panel so that the station will operate as a remote as long as the REPEAT DISABLE switch is depressed.

Depressing both the MONITOR and REPEAT DISABLE switches applies -11 mA to the control pair. This provides Channel Guard monitoring and disables the COS so that the station operates as a remote.

Keying the microphone at the Controller applies +6 mA to the control pair and removes the -11 mA from the control pair, disabling the repeater function and keying the station transmitter.

# Simultaneous Monitor of Two Receivers of 2-Frequency PSLM of One Receiver

Refer to the Schematic Diagram (See Table of Contents) for the extensive circuit changes required for this function. Two 19D416628G2 Switch Kits are provided to allow individual selection of the receiver frequencies or simultaneous selection of both receiver frequencies.

With no receive selector switch depressed, no current is applied to the control pair. This allows receiving either of the receiver frequencies selected by PSLM. Depressing the REC 1 switch applies -6 mA to the control pair, disabling the PSLM function and allowing the RX-F1 signal to be monitored. Depressing the REC 2 switch applies -11 mA to the control pair, disabling the PSLM function and allowing the RX-F2 signal to be monitored.

#### Supervisory Control (Option 8537)

According to FCC regulations, if more than one controller is connected in parallel in a system and their number and location are not specified on the station license, the dispatcher must be able to cut any conversation off the air that he judges unfit for transmission.

Pressing the SUPV CONT switch places a short across the control pair, terminating the transmission. The dispatcher can use the intercom (if present) to prevent a recurrence of the unauthorized transmission before releasing the short on the control pair.

#### Tone Alert (Option 8528)

The Tone Alert Oscillator accessory is used by the dispatcher to transmit an alerting tone to call attention to messages of more than usual importance. The accessory consists of a tone oscillator and indicator light mounted in the selector switch.

Depressing the ALERT TONE switch applies ground to the tone transmit output to key the transmitter and turns on the Tone Alert LED. The nominal 1000 Hz output of the tone oscillator is connected to the audio board where the external tone switch is turned off, feeding the tone signal to the audio pair at TB1101-7 and -10 and then transmitted by the station. The tone output is adjusted by R5 on the tone board for 2 Volts RMS at the audio pair.

#### Intercom Switch Kit (Option 8536)

The Intercom Switch Kit permits communication between paralleled MASTR Controllers without keying the transmitter. It also permits intercommunication between the controller and the base station when the remote control panel has been equipped with the intercom accessory.

Depressing the INTCM switch transfer PTT ground to the audio PTT path. This opens the transmit control current path and disables the transmit light.

#### VU Meter Kit (Option 8529)

The VU Meter enables the operator to check the line level of the MASTR Controller in the transmit, intercome or receive mode. The VU Meter provides a relative indication of the audio levels applied to and received from the audio pair. Audio from the compressor or the line is coupled through potentiometer R3 to the amplifier. The output of the amplifier drives the meter.

The meter is normally shipped from the factory adjusted to indicate frequent peaks in the -1 to +3 VU range when the operator is talking into the microphone at a normal voice level. For this type of operation, the LINE OUTPUT control is set for +11 dBm. If desired, the meter may be set for -1 to +3 VU peaks at lower operating levels.

#### Clocks (Options 8534, 8535, 8568, 8569)

Optional 12-hour clocks (Option 8534, 60 Hz and Option 8568, 50 Hz) or 24-hour clocks (Option 8535, 60 Hz and 8569, 50 Hz) are available for mounting on the MASTR Controller. The clocks are connected so that they operate with the power switch in the ON or OFF position. In the event of a power failure, the clocks can be reset by removing the clock window and turning the indicator wheels in either direction until the correct time shows in the window.

#### Partial Speaker Mute (Option 8533)

The speaker muting option permits the dispatcher to temporarily reduce the volume of incoming calls to a low level for business discussions, telephone calls, etc.

Pressing in the SPKR MUTE switch connects a 20,000 ohm resistor into the volume control high lead, reducing the speaker output approximately 20  $\mbox{dB}_{\bullet}$ 

#### Parallel Transmit Indicator (Option 8527)

The parallel transmit option is used in systems with parallel controllers to provide a visual indication when any console is in the transmit condition.

Keying the transmitter at any controller applies a positive voltage to the control pair. This voltage is dropped through voltage dividers R4 and R5 and applied to the base of Q2, turning Q2 on. Conduction of Q2 forward biases CR2, allowing the 250 kHz oscillator (Q3) output through to transformer T1. This turns Q1 on. When Q1 is conducting, its collector voltage drops to ground potential. This completes the ground path for the transmit indicator, turning it on.

In Channel Guard systems where a higher keying voltage is required, the jumper by-passing zener diode VR1 is removed. The diode now prevents Q2 from turning on when a lower voltage is applied to the control pair.

#### Line Compensation (Option 8532)

The line compensation option compensates for high frequency telephone-line losses in the 1000 to 3000 Hz range. The option consists of a parallel L-G circuit in series with a potentiometer, and should be used when the high-frequency attenuation in the 2500 to 3000 Hz range is more than 10 dB below the 400 to 600 Hz level. Complete instructions for setting the line compensation option after the MASTR Controller has been installed are contained in the Adjustment Procedure (see Table of Contents).

#### DC Control Battery Standby (Option 8526)

This option allows the 539 Series MASTR Controller to be operated on a 12-Volt battery (customer furnished) in the event the AC power source fails. The dispatcher depresses the BATT STBY switch to transfer the controller to the battery supply. The controller will remain on DC power until the switch is pushed again. An LED on the BATT STBY switch remains illuminated to remind the dispatcher that he is operating on standby power.

#### E&M Signaling Control (Option 8530)

This option provides a means of keying the M lead of an E&M signaling facility. With E&M signaling, the MASTR Controller becomes a push-to-talk control for single frequency transmit and receive and operates full duplex. Either -48 VDC (60 mA max.) or -24 (10 mA max.) will be available on the M lead.

Applying PTT ground at P4-11 turns off Q2 and turns on Q3. Conduction of Q3 allows Q1 to conduct and the 48 VDC applied to P4-7 and -8 is regulated by Q1 and VR1 and VR2 in series. For 24 VDC operation, VR1 is removed from the regulator circuit and Q4 is added. The resultant regulated 48 VDC (or 24 VDC) is applied to the M lead connected to P4-2 via TB1101-6.

The Four Wire Audio Kit (Option 8553) is required for separate transmit and receive audio lines.

#### Four Wire Audio Kit (Option 8553)

This kit consists of an additional 600 ohm line transformer for received audio. The purpose of the option is to allow separate audio connections for the received audio and for the transmit audio.

When this option is installed at the factory, the Controller will operate in the simplex mode with the received audio switched off during PTT periods and with the transmit audio switched off during receive periods. To operate the Controller simultaneous duplex: clip out diode CR3 on the 19D416629G1 Audio Board, remove the jumper between H1 and H2, and add the 620 ohm resistor between H3 and H4 on the Audio Board.

#### TONE CONTROL CIRCUIT ANALYSIS

(Refer to Tone Control System Diagram)

#### Control Functions

The MASTR Controller can perform a maximum of 12 different tone control functions. This is accomplished by applying two or three tones in sequence at the prescribed level to the transmission medium for detection at the remote base station. All of the tones are generated at the MASTR Controller by one oscillator whose frequency is selected by resistors activated by a combination of switch selection and logic circuitry. The control tone frequencies required to select each function in the "T" series MASTR Professional Remote and Repeater Stations are listed in Table 3.

TABLE 3
TONE CONTROL FREQUENCY AND FUNCTION

FUNCTION	TONE FREQUENCY	TONE DURATION
RX Channel Guard Disable (Reset by PTT)	2050 Hertz	40 milliseconds
TX-Freq. No. 1*	1950 Hertz	40 milliseconds
TX-Freq. No. 2	1850 Hertz	40 milliseconds
RX-Freq. No. 1 or Receiver No. 1	1750 Hertz	40 milliseconds
RX-Freq. No. 2 or Receiver No. 2	1650 Hertz	40 milliseconds
Channel Guard Enable or Minimum Squelch or Repeater Enable	1550 Hertz	40 milliseconds
Channel Guard Disable or Maximum Squelch or Repeater Disable	1450 Hertz	40 milliseconds
Aux. Function 1 ON	1350 Hertz	40 milliseconds
Aux. Function 1 OFF	1250 Hertz	40 milliseconds
Aux. Function 2 ON	1150 Hertz	40 milliseconds
Aux. Function 2 OFF or PSLM or Sim. Monitor	1050 Hertz	40 milliseconds
TX Hold **	2175 Hertz	

#### -NOTES-

- \* All functions but Transmit Fl and Transmit Hold are optional.
- \*\* Transmit Hold is transmitted at 30 dB below the Secur-it tone level as long as PTT switch is depressed.

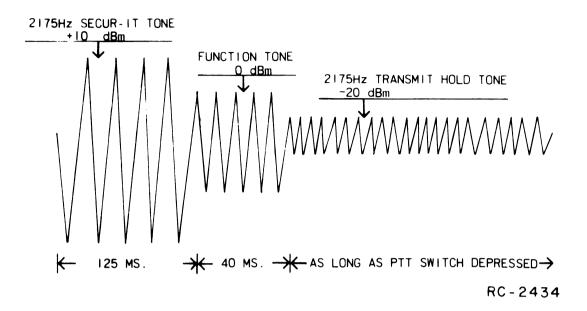


Figure 4 - Tone Control Sequence

When a non-transmit function is selected, the Secur-it tone frequency of 2175 Hz is transmitted for a period of 125 milliseconds at a level equal to normal voice peaks. In the case of a 0 VU line level, the Secur-it tone is transmitted at a level of +10 dBm. At the end of this 125 milliseconds, the oscillator output frequency is changed to that of the function selected. This tone is transmitted for a period of 40 milliseconds at a level 10 dB below the Secur-it tone burst. Upon completion of this sequence, all encoder circuits are returned to normal. See Figure 4.

When a transmit function is selected the Secur-it tone is transmitted as in the sequence described above, followed by a 40 ms burst of the F1 or F2 transmit function tone. At the end of this tone period, the Secur-it tone is turned on again and transmitted at a level 30 dB below its initial burst level, as shown in Figure 4. The Secur-it tone remains on at this level in the presence of voice as long as the PTT switch is depressed.

#### Connections

All Connections to the MASTR Controller except the power connections are made at the screw terminals on TB1101. Any transmission circuit capable of handling audio frequencies in the 300 to 3000 Hz range can be used for tone control. It is not necessary to observe polarity in wire line connections for tone control applications.

- 1. Connect Telephone pair or metallic pair to TB1101-1 and TB1101-2.
- Connect jumper between TB1101-3 and TB1101-4.

#### Tone Control Board 19D416597

In early versions of the MASTR Controller, Tone Control Board 19D416597Gl was used. In later versions Tone Control Board 19D416597G2 is used. The G2 Board has an IC regulator (U8) for better control of the 5.0 VDC logic supply.

The 19D416597 Tone Control Board provides the necessary logic required for selecting the individual functions. The tone oscillator is located on this board. The Oscillator consists of integrated circuit Ul and the associated frequency-determining circuits. Variable resistor R54 provides a means of adjusting the oscillator to its center frequency. By the logical selection of frequency-determining resistors, the oscillator's nominal frequency can be changed as required.

Depressing the desired function selector switch applies in low to U2A pin 1, 2 or 3 on the Tone Control Board. This low is inverted by NOR gate U2A and inverted again by U4A. The resultant low at pin 2 of U4A discharges C12 and operates the Secur-it

Tone One Shot U3A-U4B. The low output at pin 4 of U4B turns off Q7. The high at the collector of Q7 is inverted by U4C and the low output at U4C-6 (TP8) is applied to NOR gate U2B (Tone Inhabit). The high output at U2B-8 (TP10) is inverted at U6E and the resultant low turns off Tone Gate Q3. sistor Q9 is normally conducting, connecting R28 into the frequency-determining network of the tone oscillator. Turning off Tone Gate Q3 thus allows the 2175 Hertz Secur-it tone through to the tone amplifiers Q4-Q5. The Amplified tone is connected through TONE LEVEL ADJUST potentiometer R18 to the tone output terminal P4-14. The low output of U4C is also inverted by U3D and again by U6D. The resultant low turns off 30-dB attenuator Q2.

The Secur-it tone One Shot remains in the on condition for a period of 125 mil-liseconds, determined by the RC time constant of R22 and C13. When the one shot returns to its normal state, the high at pin 4 of U4B turns Q7 on. The low at the collector of Q7 is inverted by U4C and inverted again by U4D. Capacitor C14 is discharged, turning on the Function Tone One Shot U3B-U4E. The low output at U4E-10 turns off Q8 and the high at the collector of Q8 is inverted by U4F, turning off Q9. The low at U4F-12 (TP2) is applied to U2B-9, keeping the Tone Gate (Q3) open. This same low is applied to the base of Q19.

Enable switch Q19 is normally conducting, disabling the Tone Control Function Modules. When the Function Tone One Shot is turned on, Q19 is turned off. This enables the Tone Control Function Modules. The function tone selected is determined by the enable voltage at P3-13, the 200 millisecond one shot selected, and the function selector switch position. The high output of U3B is connected to the base of Q1 (10 dB attenuator), turning the transistor on. Thus the selected function tone is transmitted at a level 10 dB below the Secur-it tone level.

The high output of U3D (when either of the tone control one shots is active) is applied to the AUDIO INHIBIT lead P4-1, preventing the mike output on the Audio Board from operating during tone transmission. The output of U3D also continues to hold the 30 dB attenuator off and operates the VU Meter level switch Q12.

The high output of U2B is applied to the INHIBIT lead at P3-14, preventing the non-selected 200 ms one shots on the Tone Control Function Modules as well as the Channel Guard Monitor One Shot from operating. This same high turns on Q16, enabling the Audio Board to transmit the tones.

#### Channel Guard Monitor

Depressing the MONITOR bar on the

Channel Guard microphone applies a ground to P3-6 on the Tone Control Board. The 200 ms Channel Guard Monitor One Shot U5A-U5C is operated. This same ground is applied to pin 2 of U2A, operating the 125 ms one shot and, in turn, the 40 ms one shot. The high output of U5A is NANDed with the high from U3B to provide a low to U6A. The resultant high at the output of U6A operates Q10, connecting R35 into the frequency-determining network of the tone oscillator. Thus the Channel Guard monitor of 2050 Hz is transmitted with the Function Tone One Shot is active. When this tone is transmitted, the Channel Guard function at the base station is disabled, allowing the dispatcher to monitor received audio.

#### Transmit F1 and F2

When the transmit function switch is in the Fl position (not depressed) ground is connected to the XMIT F1 terminal P3-9 on the Tone Control Board. Operating the PTT switch applies ground to P4-11. Q14 is turned off and Q15 is turned on. The low at the collector of Q15 (TP7) is inverted at U6C, turning on PTT latch transistor Q17. This transistor remains on during the period that the 125 ms and 40 ms one shots are active. Q14-Q15 senses the level of the PTT line above ground and maintains the level within 0.6 Volts to insure proper audio inhibit. The low at the collector of Q15 is also applied to U7A-2, U2B-12 and U6C-5. The resultant high output of U6C is applied to U7B-5. The high output of U3B is applied to U7B-3. The high on P3-8 (XMIT F2) is applied to U7B-4. The resultant low output of U7B-6 is inverted by U6F, turning on Q13 and connecting R29 into the frequency-determining network of the tone oscillator. Thus the TX F1 tone of 1950 Hz is transmitted.

The ground at XMIT Fl is applied to NAND gate U7C. The resultant high output of U7C is inverted by U3C, preventing Q18 from conducting. As long as the PTT switch is depressed, a ground is maintained at terminal 12 of Tone Inhibit gate U2B, keeping the Tone Gate open (Q3 turned off). At that end of the 40 ms function tone period, a high is applied to U3D at pin 12. The low output of U3D is inverted by U6D and the resultant high turns the 30-dB attenuator (Q2) back on. Q9 is also turned back on, transmitting the 2175 Hz tone at a level 30 dB below its Secur-it tone level as long as the PTT switch is depressed. This keeps the base station transmitter keyed while the message is being sent.

If the transmit function switch is depressed for F2, ground is applied via the XMIT F2 lead to U7B, preventing TXF1 transistor Q13 from conducting. Thus Q18 conducts during the function tone one shot period, connecting R50 into the frequency

TABLE 4

TONE CONTROL FUNCTION MODULE APPLICATION

FUNCTION	MODEL NUMBER	TONE FREQUENCY
RX-Freq. No. 1 or Receiver 1	19C320182G1	1750 Hz
RX-Freq. No. 2 or Receiver 2	19C320182G1	1650 Hz
Channel Guard Enable or Minimum Squelch or Repeater Enable	19C320182G2	1550 Hz
Channel Guard Disable or Maximum Squelch or Repeater Disable	19C320182G2	1450 Hz
Aux. Function No. 1 ON Aux. Function No. 1 OFF	19C320182G3	1350 Hz 1250 Hz
Aux. Function No. 2 ON Aux. Function No. 2 OFF or PSLM or		1150 Hz
Simultaneous Monitor	19C320182G4	1050 Hz

determining network of the oscillator and transmitting the TXF2 tone of 1850 Hertz for 40 ms.

#### Tone Control Function Modules 19C320182G1-G4

Four Tone Control Function Modules are available for the various tone control functions provided for the MASTR Controller. Table 4 lists the function, the module required for the function, and the tone control frequency used.

As long as the function tone one shot on the Tone Control Board is inactive, a "high" is applied to the inhibit lead P7-12 on the Tone Control Function Module. This prevents the 200 ms one shot (UIA and UIB) from being activated. When the function tone one shot is activated, the inhibit lead is grounded and enable transistor Q19 on the Tone Control Board removes ground from the enable lead at P7-11, enabling the frequency-determining switches Q1-Q2 and Q3-Q4.

Grounding one of the switch contacts at P7-7 or P7-8 activates the 200 ms one shot. Q5 is turned off supplying a low to the initiate lead at P7-13. This low initiates the Secur-it tone and function control tone one shots on the Tone Control Board to begin the function tone sequence.

#### Receive F1 and F2

With the receive function switch in

the REC Fl position, ground is applied to P7-7. This prevents Q3 on the 19C320182G1 Tone Control Function Module from conducting. When the 200 ms one shot is activated. Q1 is turned on because the RX-F2 lead (P7-8) is not grounded. Q1 turns on Q2, connecting the frequency-determining resistor R17 into the oscillator circuit. Thus REC F1 tone 1750 Hz is transmitted. Depressing the receive function switch to the REC F2 position grounds P7-8 and prevents Q1 from conducting. The RX F1 lead at P7-7 is no longer grounded, allowing Q3 and Q4 to conduct and insert R18 into the frequency-determining network of the oscillator. Thus the RX F2 tone frequency of 1650 Hertz is transmitted. The other Tone Control Function Modules operate in the same manner as described to select the functions outlined in Table 4.

#### Take Over Control (Option 8538)

When a number of MASTR Controllers are connected in parallel on the same control pair, this option allows all paralleled units to be completely disabled and the main dispatcher to assume full control of the system.

Depressing the 19D416628G9 TAKE OVER function switch grounds the +24 Volt line, disconnects the + line DC and audio line from the - Supervisory Control line, and disconnects the - line DC and audio line from the + supervisory control line. The telephone pair at the controlled remote unit is connected to TB1101-9 (+ SUPV CONTROL) and TB1101-12 (- SUPV CONTROL).

#### Alert Tone (Option 8528)

The Tone Alert Oscillator accessory is used by the dispatcher to transmit an alerting tone to call attention to messages of more than usual importance. The accessory consists of a tone oscillator and indicator light mounted in the selector switch.

Depressing the ALERT TONE switch applies 13.8 VDC to the tone oscillator (Q1), applies ground to the tone transmit output to key the transmitter and turns on the Tone Alert LED. The nominal 1000 Hz output of the tone oscillator is connected to the Audio Board where the external tone switch is turned off, feeding the tone signal to the audio pair at TB1101-7 and -10 and then transmitted by the station. The tone output is adjusted by R5 on the tone board for 1 Volt RMS at the audio pair.

#### Intercom Switch Kit (Option 8536)

The Intercom Switch Kit permits communication between paralleled MASTR Controllers without keying the transmitter. It also permits intercommunication between the dispatcher and the base station when the remote control panel has been equipped with the intercom accessory.

Depressing the INTCM switch transfers PTT ground to the audio PTT path. This opens the transmit control path and disables the transmit light.

#### VU Meter Kit (Option 8529)

The VU Meter enables the operator to check the line level of the MASTR Controller in the transmit, intercom or receive mode. The VU Meter provides a relative indication of the audio levels applied to and received from the audio pair. Audio from the compressor amplifier or the line is coupled through potentiometer R3 to the amplifier. The output of the amplifier drives the meter.

The meter is normally shipped from the factory adjusted to indicate frequent peaks in the -1 to +3 VU range when the operator is talking into the microphone at a normal voice level. For this type of operation, the LINE OUTPUT control is set for +11 dBm. If desired, the meter may be set for -1 to +3 VU at lower operating levels.

#### Clocks (Options 8534, 8535, 8568, 8569)

Optional 12-hour clocks (Option 8534, 60 Hz and Option 8568, 50 Hz) or 24-hour clocks (Option 8535, 60 Hz and 8569, 50 Hz) are available for mounting on the MASTR Controller. The clocks are connected so that they operate with the power switch in the ON or OFF position. In the event of a power failure, the clocks can be reset by removing the clock window and turning the indicator wheels in either direction until the correct time shows in the window.

#### Partial Speaker Mute (Option 8533)

The speaker muting option permits the dispatcher to temporarily reduce the volume of incoming calls to a low level for business discussions, telephone calls, etc.

Depressing the SPKR MUTE switch connects a 20,000 ohm resistor into the volume control high lead, reducing the speaker output approximately 20 dB.

#### Battery Standby

Battery standby is provided with the Series 549 MASTR Controller as a standard item. A diode is connected across terminals 18 and 19 of J1111. This diode is normally back-biased by the supply voltage. If the supply voltage fails, the diode becomes forward biased and connects an auxiliary battery (customer furnished) into the supply circuit. When the supply voltage is restored, the diode is again reverse-biased, automatically disconnecting the battery.

# Battery Standby Light Flasher Kit (Option 8545)

The POWER ON indicator is connected to P6-14 on the Light Flasher Kit when this option is used. As long as the power supply voltage is present, CRl is forward biased and Q2 is conducting. Ql is turned off. If the supply voltage fails, and the standby battery is switched into the circuit, CRl is back biased and Q2 is turned off. This turns the POWER ON indicator off but also turns Ql on. Conduction of Ql turns on the POWER ON indicator. This process continues to flash the POWER ON indicator until the supply voltage is restored.

#### Notch Filter (Option 8555)

In systems with several MASTR Controllers connected in parallel, where positive indication of the transmit condition is not required, the Notch Filter Option (8555) may be used to remove the 2175 Hz transmit hold tone when another controller is transmitting.

The notch filter consists of pinetwork L1-C3, L2-C4, and L3-C1. The filter is tuned to the 2175 Hertz tone frequency, trapping the tone and passing it to ground. The speech audio is amplified by Q1 and Q2 and passed to the audio circuits.

# Parallel Transmit Indicator and Notch Filter (Option 8554)

Option 8554 provides a notch filter for removing the 2175 Hertz transmit hold tone at the MASTR Controller whenever another controller connected in parallel is transmitting. Also provided is a tone detector circuit for operating the XMIT

LIGHT to indicate to the dispatcher that another controller is transmitting a message.

The notch filter consists of pinetwork L1-C15, L2-C16, and L3-C17. The filter is tuned to the 2175 Hertz tone frequency, trapping the tone and passing it to ground. The speech audio is amplified by Q14 and Q15 and passed to the audio circuits.

The audio input at P5-6 is also connected to the active RC filter composed of C2-C6 and R1-R3. Variable resistor R3 allows adjustment of this filter to the 2175 Hertz tone frequency. The 2175 Hertz tone is amplified by high-gain amplifier Q1-Q4, with a feedback path from the emitter of Q5 to provide stability.

The 2175 Hertz output is buffered by Q6, amplified at Q7 and passed to the tone detector CR1 and CR2. Q8 is normally conducting, clamping the amplifier output to prevent noise pulses from operating the XMIT LIGHT. When the 2175 Hertz tone is present, it is rectified and turns off Q9. Q10 is also turned off. Q11 is turned on. Conduction of Q11 turns off the attenuator Q8 and also turns off Q12. Q13 is now turned on, operating the XMIT LIGHT.

#### **AUDIO SYSTEM**

The MASTR Controller Audio System consists of the audio board (19D424084) and the speaker PA circuit located on the System Board Allol.

#### Audio Board 19D424084G1 & G2

The Audio Board consists of the microphone compressor amplifier, the line compressor amplifier, the line preamplifier and the various switching and level control circuitry required for proper operation of the control system. The 19D424084G1 board is used in DC control systems. The 19D424084G2 board is used in tone control systems and includes a 2175 Hz notch filter in the audio path to prevent falsing of the transmit function.

Operating the PTT switch applies ground to the receive audio switch Q8, turning the switch on. When Q8 is conducting, the feedback loop through R23 and CR4 increases the conduction of gain control stage Q1, shorting the AC onput to ground. This cuts off the line input to the line compressor amplifier. With Q8 turned on, Q7 conducts. This grounds the VOLUME HI lead, preventing any received audio from reaching the speaker PA.

Audio from the microphone is coupled to the MIKE IN ADJUST control R28 where the proper level is set for the compressor amplifier. The adjusted audio is coupled by C38 to preamplifier Q21. The output of

Q21 is applied to the Line Compressor Amplifier. The Line Compressor Amplifier circuit consists of gain control stage Q10, high-gain audio amplifiers Q11 through Q14, and DC amplifier Q15.

When audio is applied to the compressor amplifier, R29 and the AC impedance of Q10 act as a voltage divider for the AC input signal. The output of Q10 is amplified by a four-stage, direct-coupled amplifier (Q11 through Q14). Both AC and DC feedback in the amplifier circuit provides for extremely stable operation.

A portion of the amplified output is fed through LINE OUT ADJUST Control R54 to the output line amplifier (Q17-Q18) and to the line transformer T1. The remaining portion of the audio output is rectified by detector CR9, filtered by C24 and amplified by DC current amplifier Q15. This DC output is fed back to the base of gain control transistor Q10.

The amount of DC feedback to the gain control stage determines the AC impedance of Q10. An increase in feedback reduces the AC impedance of Q10 which decreases the audio voltage to the AC amplifier, keeping the amplifier output constant. When the audio input decreases, the output of the AC amplifier starts to decrease, reducing the feedback to Q10. This raises the AC impedance of Q10 and increases the audio voltage to the AC amplifier, keeping the amplified output constant.

In tone control systems, the 19D424084G2 Audio Board is used. This board has a 2175 Hz notch filter inserted in the audio path between H5 and H6. This filter consists of C36, C37, L1 and R70. The filter consists of C36, C37, L1 and R70. The filter prevents falsing of the transmit function by the 2175 Hz tone.

In the receive mode of operation, a positive voltage is applied to the base of transmit audio switch Q20, turning the transistor on. Conduction of Q20 grounds the output of the mike compressor AC amplifier, preventing any audio from the mike input from passing to the line amplifier. With no ground applied through the PTT lead, Q8 is turned off and the gain control stage Q1 is allowed to function. Q7 also is turned off, allowing the speaker PA to function. Audio from the line is coupled to the LINE IN ADJUST control R1 which, in turn, connects the received audio to the line compressor amplifier. This amplifier functions in the same manner as described for the mike compressor amplifier. Q2 through Q5 serve as the AC amplifiers; Q6 is the DC amplifier; Q1 is the gain control stage.

The output of the line compressor amplifier is coupled through VOLUME control R1 and passed to the speaker PA.

#### Speaker PA

The Speaker PA is located on the Allol System Board. This amplifier consists of audio polarity switches Q7 and Q8, phase inverters Q5 and Q6, and the quasi-complementary output Q2 and Q3. The positive half-cycle of the audio is switched by Q7 to Q5 and Q2. The negative half-cycle of the audio is switched by Q8 to Q6 and Q3. The audio output of the PA is capacitively coupled by C5 to TB1101-24 and to the MASTR Controller Speaker LS1.

#### Four Wire Audio Operation

When Option 8553 (Four Wire Audio Kit) is installed in the controller, a separate line transformer is connected across TB1101-13 and -16. Diode CR3 on the Audio Board is removed, disabling the speaker mute function. The controller may then be operated full duplex by connecting a separate wire pair to terminals 13 and 16 of TB1101.

#### **POWER SUPPLY**

Turning OFF-ON switch S1101 to the ON position applies 117 Volts AC to the primary of power transformer T1101. The primary is fused by F1101. The power supply contains two rectifier circuits in the secondary of T1101 to provide the control and operating voltages for the MASTR Controller.

Full wave bridge rectifiers CR1 through CR4 supply the control high voltage. R16 is a bleeder resistor for filter capacitor C10.

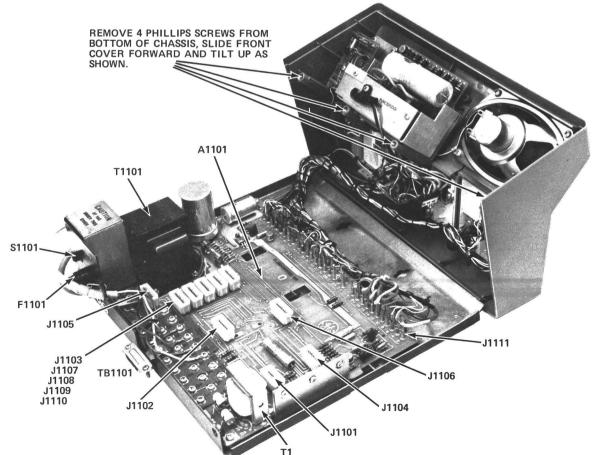
Full wave rectifiers CR5 through CR8 supply 24 Volts for operating the speaker PA stage and for application to the pushbutton switch kits. The output of this rectifier circuit is also connected to the 13.8 VDC regulator circuit composed of Q1, Q4 and zener diode CR1. The regulated 13.8 VDC supplies the amplifier circuits in the DC and Tone Control Boards, the Parallel Transmit Indicator options, the Tone Alert option as well as the POWER ON and TRANSMIT LED.

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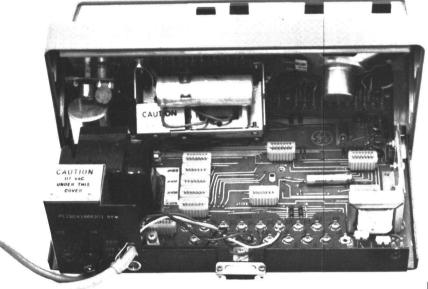
# **REMOVING FRONT AND REAR COVERS**

# REAR COVER 19C320210G1 LOOSEN CAPTIVE THUMBSCREWS ON REAR COVER OF UNIT, SLIDE COVER BACK UNTIL IT DISENGAGES FROM FRONT COVER. REMOVE 4 PHILLIPS SCREWS FROM BOTTOM OF CHASSIS, SLIDE FRONT COVER FORWARD AND TILT UP AS SHOWN.

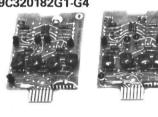


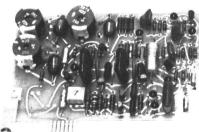
# **DISASSEMBLY INSTRUCTIONS**

#### **CONTROL BOARD LOCATIONS**

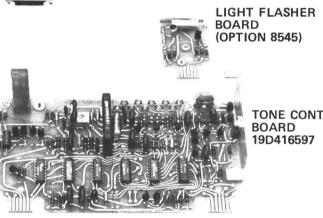


TONE CONTROL FUNCTION MODULES 19C320182G1-G4

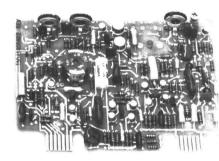




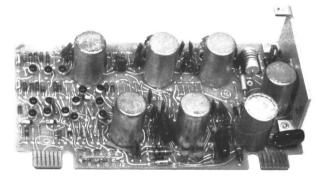
TONE CONTROL PARALLEL TRANSMIT INDICATOR (OPTION 8554)



TONE CONTROL BOARD 19D416597



AUDIO BOARD 19D424084G1



DC CONTROL BOARD 19D416592

#### **DISASSEMBLY PROCEDURE**

# **SYSTEM TEST, ADJUSTMENT & CONNECTIONS**

#### **DESK MICROPHONE CONNECTIONS**

- A. Connect Standard Desk Microphone 19209458P1 leads as follows:
  - a. White lead to TB1101-23 (MIKE HI) b. Blue lead to TB1101-22 (MIKE LO)
  - c. Red lead to TB1101-21 (PTT)
    d. Black lead to TB1101-17 (GRD)
- B. Connect Channel Guard Desk Microphone
- a. White lead to TB1101-23 (MIKE HI)
- b. Blue lead to TB1101-22 (MIKE LO)
  c. Red lead to TB1101-21 (PTT)
- d. Black lead to TB1101-21 (PTT)
- e. Green lead to TB1101-17 (GRD)

#### **OPTION CONNECTIONS**

Refer to the individual option Installation Instructions for special connections. See the Table of Contents.

#### TEST FIXTURE

Two Test Fixtures (19B219710G1) are recommended for servicing the boards out of the unit while maintaining circuit connections



**TEST FIXTURE** 

19B219710G1

#### **AUDIO ADJUSTMENT PROCEDURE**

Before adjusting the MASTR Controller, make sure that all AC power lines, phone lines, and ground connections have been completed at the Controller and the Base Station.

#### LINE OUTPUT

The MASTR Controller's line output is adjustable up to a maximum of +11 dBm. When the unit is connected to a commercial phone line, the line output should be set to the maximum permissible test tone level which the local phone company will allow. If a short run of wire (less than 1000 feet) is used to connect the Controller to the base station, the line output should be set to 0 dBm. Average voice will be sent 10 dB below the level at which you set the line output.

- Connect an AC-VTVM across the audio pair (TBl101-1 and TBl101-2). Use a 0.5 mfd capacitor in series with the meter if a DC control voltage is simplexed line-to-line.
- Turn MIKE GAIN control R28 on Audio Board to maximum (fully clockwise) disconnect the MIKE HI from TB1101-23.
- 3. Apply a 1000 Hertz signal to TB1101-22 (mic lo0 and TB1101-23 (MIC HI) at a level of 40 millivolts (Desk Mike or Boom Mike), or 120 millivolts (Handset). Use a 100 mfd capacitor in signal generator lead with (+) side of capacitor to TB1101-23.
- Operate PTT switch S1 on Controller and adjust LINE OUTPUT control R54 on Audio Board for desired Line Output Level.

#### LKE GAIN

The Mike Gain control sets threshold of compression on the Mike Compressor.

This setting will vary depending on the dispatcher's voice and operating habits. The following level given should be used in most cases. If you want more compression use a lower input to the mike jack, if you want less compression use a higher input to the mike jack. Before making the mike gain adjustment you must perform the Line Output adjustment above.

- Reduce the 1000 Hz signal at the mike jack to 25 millivolts (desk mike) or 80 millivolts (Handset).
- 2. On TONE UNITS, connect a jumper from TP10 to ground on the Tone Control Board.
- . Operate the PTT switch Sl on the Controller and adjust MIKE GAIN Control R28 until the line output level is reduced l dB from the output level set in step 4 above

#### SECUR-IT TONE OUTPUT (TONE UNITS ONLY)

The Line Output and Mike gain Adjustments should be made before setting the Secur-it Tone Output.

- Disconnect Mike Hi lead from TB1101-23. Connect an AC-VTVM to TB1101-1 and TB1101-2. Set Tone Level Adjust R18 on the Tone Control Board to minimum.
- To enable Secur-it Tone connect a jumper from TP8 to ground on the Tone Control Board.
- Operate the PTT switch S1. Slowly increase the Tone Level Adjust R18 on the Tone Control Board until the AC-YTVM reaches the same level as you set the line output to in step 4 under LINE OUTPUT.

#### LINE INPUT

The Line Input control R1 sets Threshold of Compression on the Receive Compressor. Threshold of Compression is adjustable with line inputs as low as -20 dBm. Setting the control for excessive compression will accent background and line noise during pauses in transmission. The Line Output adjustment at the Base Station should be made before setting the Line Input on the Controller.

- Connect a signal generator to the Base Station Receiver, adjust to the receiver frequency and modulated 3 kHz deviation by a 1000 Hz signal.
- 2. Adjust Line Input Control R1 on the audio board full clockwise (maximum).
- 3. Connect the + lead of an AC-VTVM to TB1101-24 and the lead to TB1101-17. While receiving the 1000 Hz signal adjust the volume control on the Controller to a reference level on the AC-VTVM.
- Reduce the Line Input Control R1 until the reading on the AC-VTVM is reduced 1 dB from the reference level set to in step 3.

Converting dBm to RMS Volts

dBm	Volts RMS
+10	2,45
0	.776
-10	.245
-20	.0776
-30	.0245
-40	.00776
-50	.00245

#### DC CONTROL CURRENT TESTS

## One-Frequency Transmit and One-Frequency Receive

- 1. With High-Voltage Board 19C320169G1 plugged into J1104 on the System Board, connect a DC milliammeter in series with the control line (positive lead of meter to TB1101-5).
- Push in the TX-F1 switch. Operate the TRANSMIT switch and set CONTROL CURRENT potentiometer R2 on the H.V. Board for a reading of +6.0 mA at the milliammeter.

# One-Frequency Transmit and One-Frequency Receive with Channel Guard

- 1. With High-Voltage Board 19C320592G2 plugged into J1103-J1104 on the System Board, connect a DC milliammeter in series with the control line (negative lead of meter to TB1101-5).
- Push in the C.G. MON switch. Adjust R35 on the H.V. Board for a reading of -2.5 mA at the milliammeter. Release the C.G. MON switch.
- Reverse the milliammeter connections (positive lead to TB1101-5). Push in the TRANSMIT Switch and adjust R36 on the H.V. Board for a reading of +6 mA at the milliammeter.

# Two-Frequency Transmit, Two-Frequency Receive with Channel Guard

- With High Voltage Board 19D416592G1 plugged into J1103-J1104 on System Board, connect a DC milliammeter in series with the control line (negative lead of meter to TB1101-5).
- Select REC Fl on the switch panel and push in the C.G. MON switch. Adjust R35 on the H.V. Board for a reading of -2.5 mA on the milliammeter.
- Select REC F2 on the switch panel.
   Adjust R36 on the H.V. Board for a reading of -6.0 mA on the milliammeter.
- Select REC F2 on the switch panel and push in the C.G. MON switch. Adjust R37 on the H.V. Board for a reading of -11.0 mA on the milliammeter.
- Reverse the milliammeter connections (positive lead to TB1101-5) and select XMIT F1 and push in TRANSMIT switch. Reading should be +6.0 mA on the milliammeter.
- Select XMIT F2 and push in the TRANSMIT switch. Reading should be +11.0 mA on the milliammeter.

#### TONE CONTROL TEST

#### MASTER CONTROLLER FUNCTION SELECTED LIGHT INDICATION PTT Transmit ON XMIT F1 ON XMIT F1 XMIT F2 ON Transmit ON MONITOR Transmit ON REC F1 REC F1 ON REC F2 ON REC F2 PSLM (Both REC F1 & REC F2 ON REC F1 & REC F2 PSLM (Both REC F1 & REC F2 REC F1 & REC F2 OFF OFF) RPTR OFF RPTR ON RPTR ON CG OFF CG OFF CG ON CG ON SQUELCH MAX SQUELCH MAX ON SQUELCH MIN ON SQUELCH MIN AUX. 1 ON AUX. 1 ON AUX. 1 OFF AUX. 1 OFF

AUX. 2 ON

AUX. 2 OFF

AUX. 2 ON

AUX. 2 OFF

#### OPTION ADJUSTMENTS

#### Tone Alert Kit (Option 8528)

- 1. Connect an AC-VTVM across the audio pair TB1101-1 and TB1101-2.
- Hold in the ALERT TONE switch and adjust R5 on the Tone Alert Board for a meter reading of 1,0 Volt RMS (or less when required by local regulations).

#### Line Compensation Kit (Option 8532)

The Line Compensation Kit is shipped from the factory disconnected to prevent interference with normal adjustment of the MASTR Controller. The White wire is connected to J1 of the Audio Board.

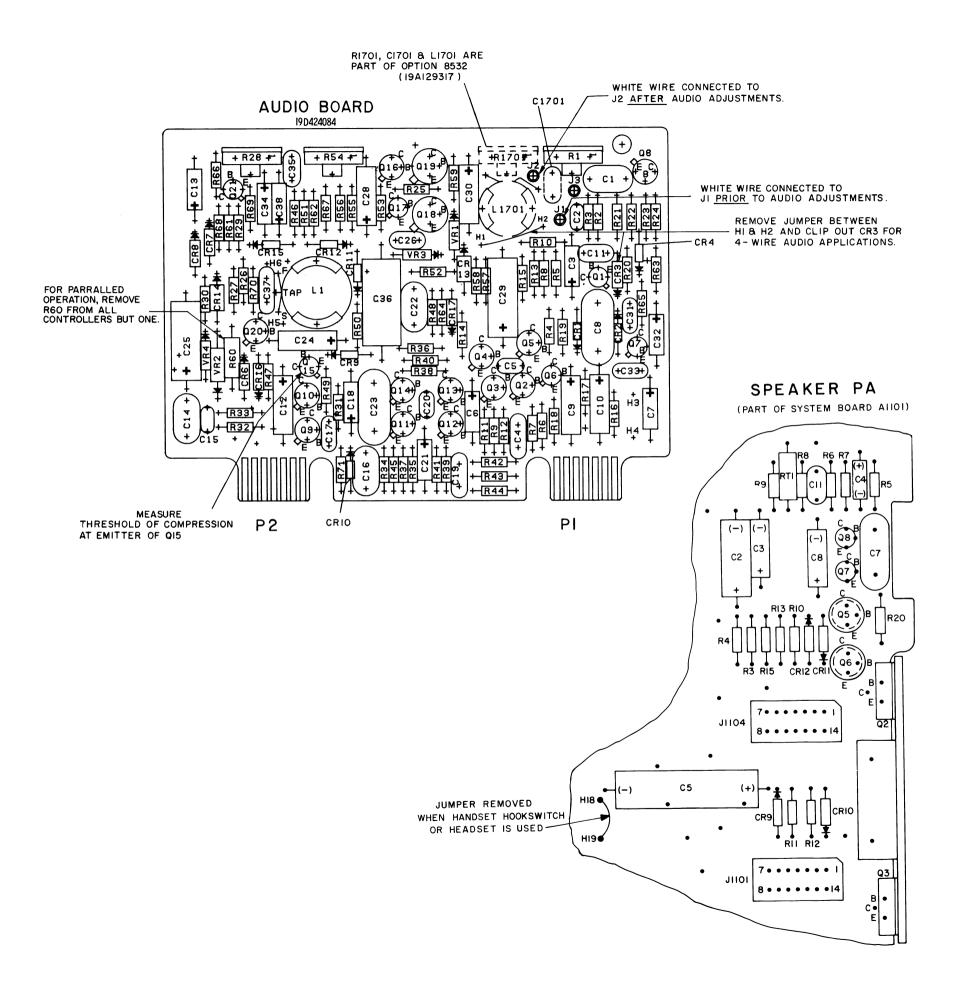
- Complete all the normal adjustments as outlined in the AUDIO ADJUSTMENT PROCEDURE section.
- Move the White wire from J1 to J2 of the Audio Board.
- 3. Feed a 3000 Hz signal to the audio pair from the Base Station at the highest permissible level.
- Adjust R1 on the Audio Board for a reading of 0.4 VDC as measured at the emitter of Q6 on the Audio Board.
- 5. Change the 3000 Hz signal to 600 Hz at the same level.
- Adjust R1701 to as near a reading as possible of 0.4 VDC as measured at Q6-E.

#### VU Meter (Option 8529)

The VU Meter was set at the factory to indicate 0 VU at a +11 dBm line output. If the line output is set for other than +11 dBm, it will be necessary to re-adjust R3 on the VU meter to obtain 0 VU readings at threshold of compression.

- Connect an AC-VTVM across the audio pair (TB1101-1 and TB1101-2). Use a 0.5 mfd capacitor in series with the meter if a DC voltage is simplexed line-to-line.
- 2. Apply a 1000 Hz signal to TB1101-22 (MIC LO) and TB1101-23 (MIC HI) through a 0.22 µf capacitor with + side of capacitor connected to TB1101-23. Set the audio oscillator to the level used in the MIC GAIN setting.
- 3. Reduce the signal until the line output level has been reduced 10 dB.
- Adjust R3 on the VU Meter until a reading of 0 VU is obtained on the VU Meter.
- 5. The VU Meter should now indicate frequent peaks in the -1 to +3 VU range when talking into the microphone in a normal tone of voice.

#### SYSTEM TEST, ADJUSTMENT & CONNECTIONS



#### TROUBLESHOOTING PROCEDURE

TROUBLESHOOTING TROUBURE				
SYMPTOM	PROCEDURE			
NO AUDIO FROM THE SPEAKER.	<ol> <li>CHECK THE AUDIO INPUT AT PI-I AND 14 WITH AN AC-VTVM.</li> <li>MAKE SURE THAT VOLUME CONTROL IS NOT SET AT MINI- MUM (FULLY COUNTERCLOCKWISE).</li> </ol>			
	<ol> <li>CHECK TO SEE THAT THE CONTROLLER IS NOT IN THE TRANSMIT MODE (TRANSMIT LIGHT ON). IF THE LIGHT IS ON, CHECK FOR A SHORT IN THE PUSH-TO-TALK CIRCUIT.</li> </ol>			
	4. CHECK THE SETTING OF LINE OUTPUT CONTROL R54 (REFER TO THE AUDIO ADJUSTMENT PROCEDURE).			
	5. CHECK SUPPLY VOLTAGE AT P2-5. SHOULD BE 13.8 VDC.			
	<ol> <li>CHECK THE DC VOLTAGES ON QI-Q8 (REFER TO SCHEMATIC DIAGRAM). CHECK DC VOLTAGES ON SYSTEM BOARD PA (REFER TO SYSTEM DIAGRAM).</li> </ol>			
NO AUDIO ON THE LINE.	I. CHECK MICROPHONE AUDIO LEADS AT P2-I AND -14.			
	CHECK THE SETTING OF MIKE IN CONTROL R28 (REFER TO THE AUDIO ADJUSTMENT PROCEDURE).			
	KEY THE MICROPHONE AND CHECK THE DC VOLTAGES     ON Q9-Q18 AND Q20-Q21 (REFER TO SCHEMATIC DIAGRAM)			
LINE COMPENSATION (OPTION 8532).	THE HIGH-FREQUENCY COMPENSATION SHOULD BE ADJUSTED AFTER ALL AUDIO ADJUSTMENTS HAVE BEEN COMPLETED. REFER TO AUDIO ADJUSTMENT PROCEDURE.			
	2. THE MASTR CONTROLLER IS SHIPPED FROM THE FACTORY WITH THE WHITE WIRE CONNECTED TO JI ON THE AUDIO BOARD. AFTER ALL AUDIO ADJUSTMENTS HAVE BEEN COMPLETED, MOVE THE WHITE WIRE TO J2.			

RC-2452A

#### TROUBLESHOOTING PROCEDURE

AUDIO SYSTEM

Issue 2 21

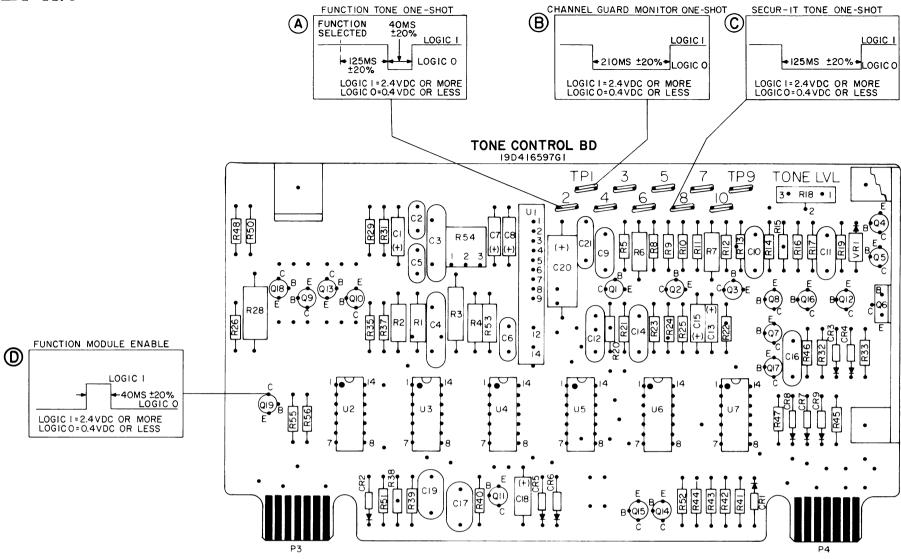


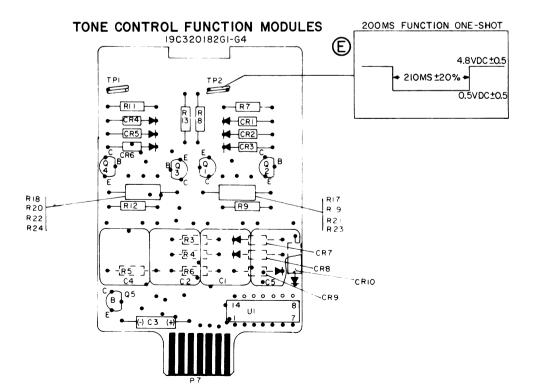
TROUBLESHOOTING PROCEDURE

Issue 2

TONE CONTROL SYSTEM

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#### TROUBLESHOOTING PROCEDURE

TONE CONTROL BOARD 19D416597G1

- TEST EQUIPMENT REQUIRED

  1. COUNTER, ELDORADO 1650C OR EQUIVALENT.

  2. SCOPE, LECTROTECH TO -50 OR EQUIVALENT.

  3. VTVM, HEWLETT-PACKARD 400D OR EQUIVALENT.

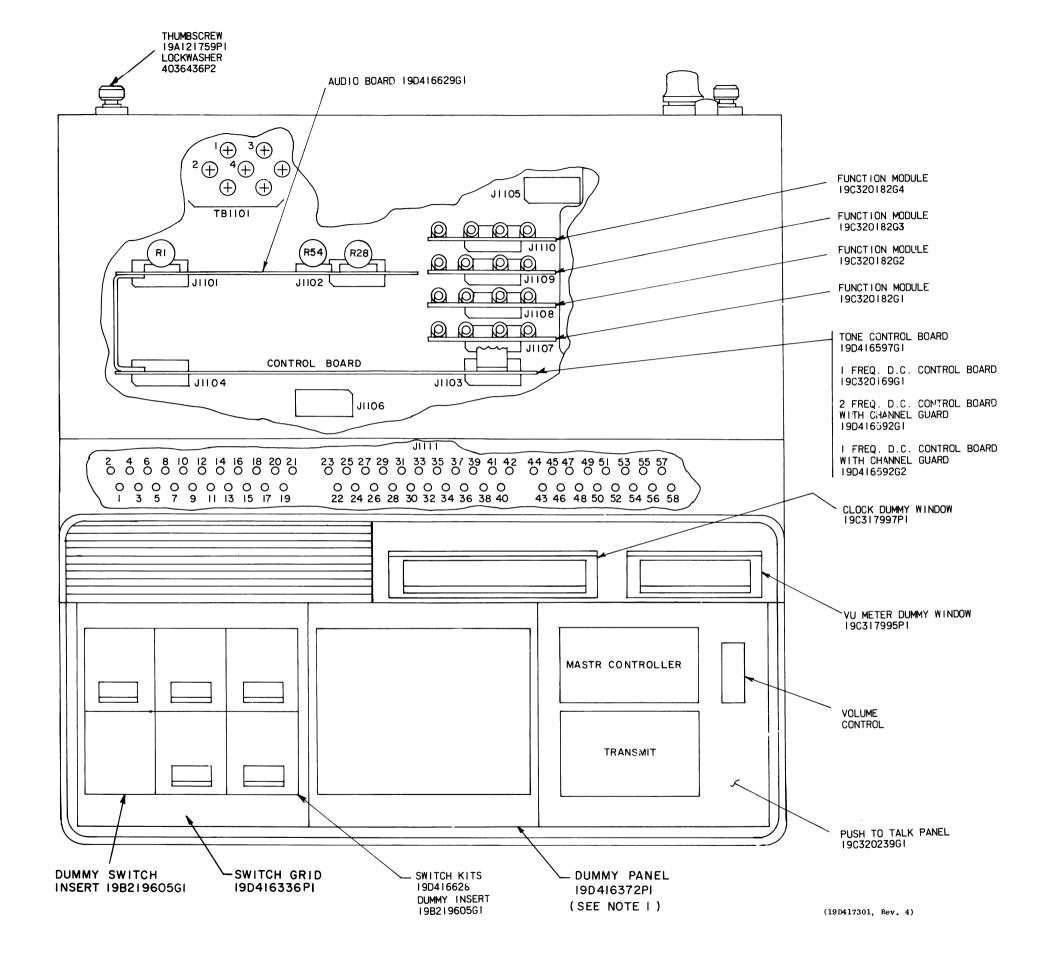
  4. EXTENDER BOARDS(OPTION 8544)ARE RECOMMENDED FOR IN-CIRCUIT TESTING OF THESE BOARDS.

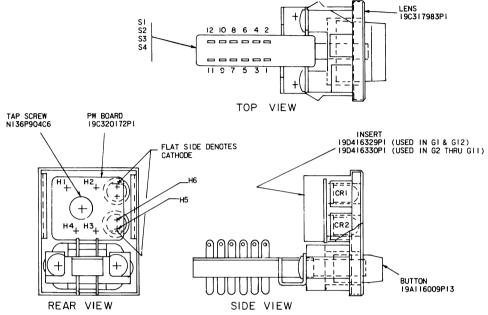
SYMPTOM	PROCEDURE
NO TONE OUTPUT FOR ANY FUNCTION SELECTED.	I. CONNECT COUNTER TO TP4. OSCILLATOR SHOULD BE IDLING AT 2175 Hz AT A LEVEL BETWEEN 150 TO 200 MV. IF NOT CHECK OSCILLATOR CIRCUIT.  2. CONNECT SCOPE TO TP5. SELECT PTT FUNCTION. WAVE FORM SHOULD BE AS SHOWN IN FIGURE I IN TONE CONTROL FUNCTION DESCRIPTION. IF NOT, CHECK TONE GATING CIRCUITS.
NO SECUR-IT TONE BURST.	I. CONNECT SCOPE TO TPB. WAVE FORM SHOULD BE AS SHOWN IN () WHEN FUNCTION IS SELECTED. IF NOT, CHECK SECUR-IT TONE ONE-SHOT AND ASSOCIATED GATES.
NO FUNCTION TONE BURST.	CONNECT SCOPE TO TP2. WAVE FORM SHOULD BE AS SHOWN IN (A) WHEN FUNCTION IS SELECTED. IF NOT, CHECK FUNCTION-TONE ONE-SHOT AND ASSOCIATED GATES.     SELECT FUNCTION TO BE CHECKED. GROUND TP2. CONNECT SCOPE OR COUNTER TO TP5 AND OBSERVE FUNCTION TONE, REFER TO TABLE 3 FOR CORRECT FUNCTION TONE FREQUENCY.
NO 2050 H2 TONE WHEN CHANNEL GUARD MONITOR SELECTED.	I. CONNECT SCOPE TO TPI. WAVE FORM SHOULD BE AS SHOWN IN (B). IF NOT, CHECK CHANNEL GUARD MONITOR ONE-SHOT AND ITS ASSOCIATED GATES.

#### TONE CONTROL FUNCTION MODULES 19C320182G1-G4

SYMPTOM	PROCEDURE			
NO TONES AVAILABLE WHEN FUNCTION MODULES SELECTED. G1-1750-1650 Hz G2-1550-1450 Hz G3-1350-1250 Hz G4-1150-1050 Hz	I. CONNECT SCOPE TO QI9-C ON TONE CONTROL BOARD. WAVE FORM SHOULD BE AS SHOWN IN ①. IF NOT, CHECK FUNCTION MODULE ENABLE CIRCUIT.			
PARTICULAR GROUP OF TONES NOT AVAILABLE FROM FUNCTION MCDULE.	SUBSTITUTE ANOTHER MODULE OF THE SAME GROUP.     OR     CONNECT SCOPE TO TP2 ON FUNCTION MODULE.     WAVE FORM SHOULD BE AS SHOWN IN (E). IF NOT,     CHECK 200ms FUNCTION ONE-SHOT AND ITS ASSOCIATED     GATES.			

RC -2442A





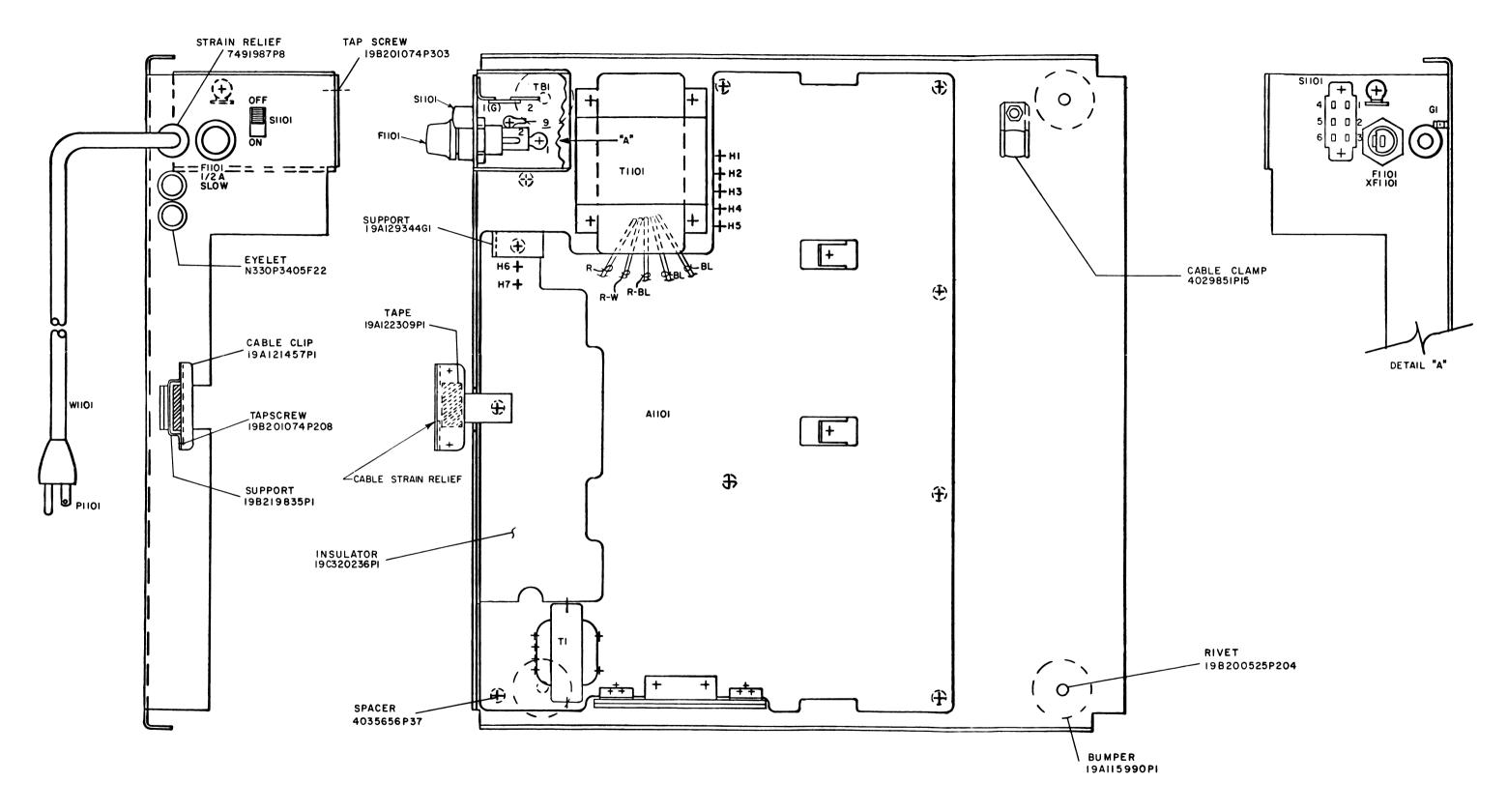
#### NOTE:

I. SWITCH GRID OPTION 8558 IS REQUIRED IF ANY ONE OR MORE OF THE FOLLOWING OPTIONS ARE USED: 8526, 8528, 8533, 8539, 8540, 8541. ONLY ONE SWITCH GRID OPTION IS REQUIRED FOR EACH MASTR CONTROLLER.

DETAILS OF SWITCH KIT 19D416628GI-GI2

#### **OUTLINE DIAGRAM**

MASTR CONTROLLER SERIES 539 & 549 19D416689G1



### **OUTLINE DIAGRAM**

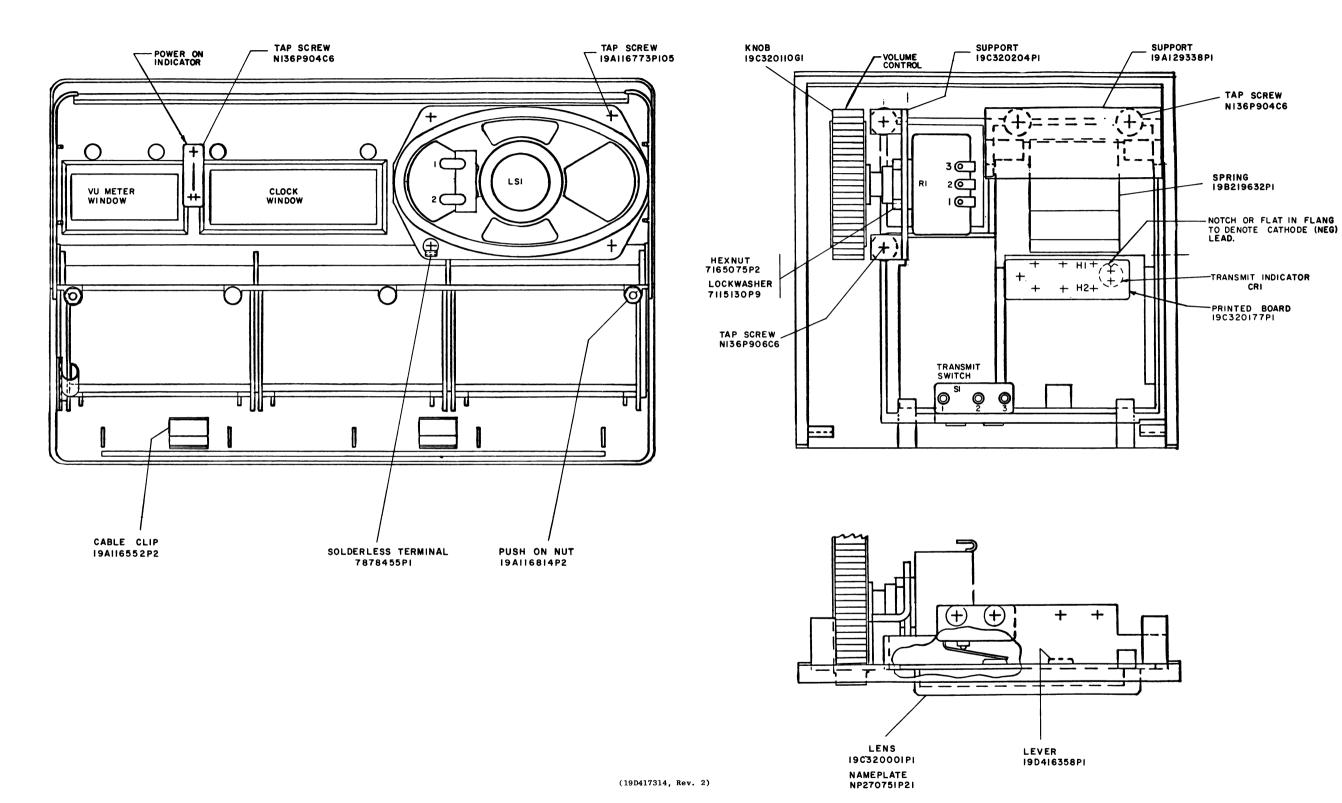
(19D417318, Rev. 1)

MASTR CONTROLLER BASE PLATE 19D416663G1

24

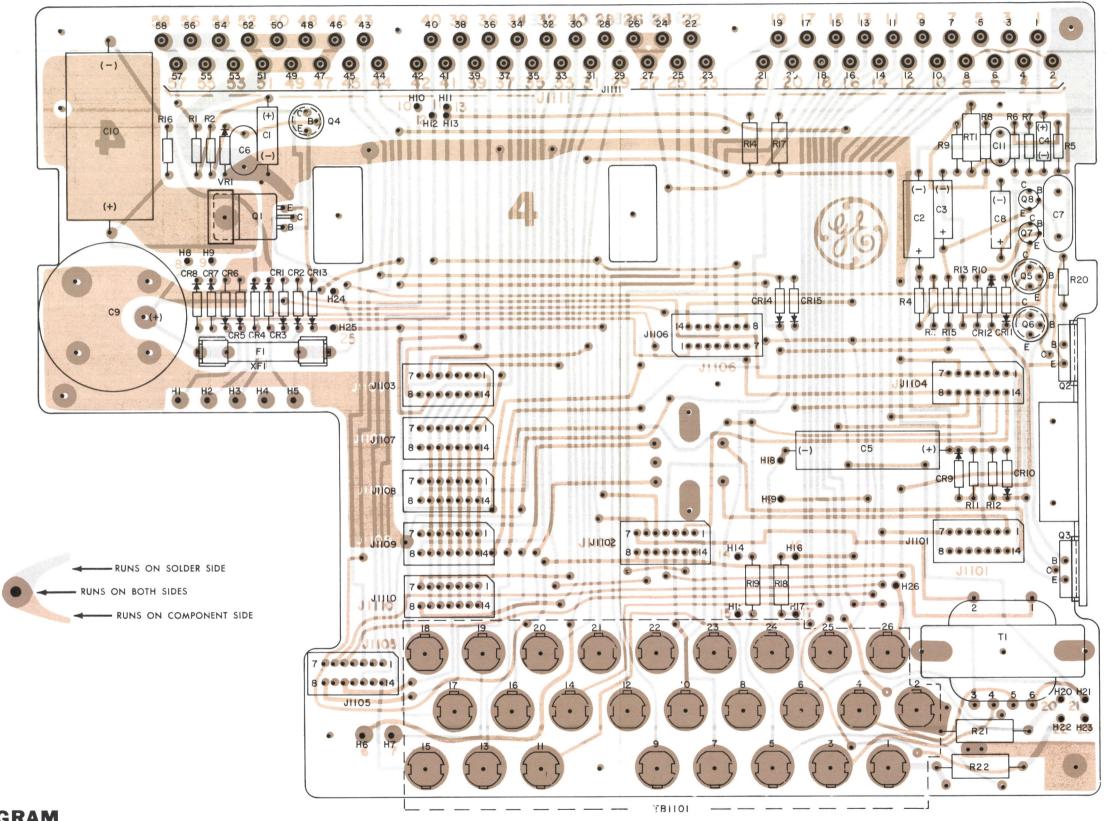
Issue 2

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#### **OUTLINE DIAGRAM**

FRONT COVER AND PTT PANEL 19D416669G1 & 19C320239G1



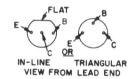
LEAD IDENTIFICATION FOR Q4,Q5 & Q6



TRIANGULAR VIEW FROM LEAD END

NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

LEAD IDENTIFICATION FOR Q7 8 Q8



NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

**OUTLINE DIAGRAM** 

SYSTEM BOARD A1101 19D416655G1 (19D417319, Rev. 2) (19D416617, Sh. 2, Rev. 4) (19D416617, Sh. 3, Rev. 4)

Issue 6

(19R640927, Rev. 12)

DF-4094

#### LBI-4478

**2**8

#### PARTS LIST

# LBI-4467D

#### MASTR CONTROLLER UNIT 19D416689G1

SYMBOL	GE PART NO.	DESCRIPTION
		FRONT COVER ASSEMBLY 19D416669G1
		DIODES AND RECTIFIERS
CR1	19A134146P4	Diode, optoelectronic: red; sim to Opcoa LSM-6
LS1	19C307094P1	Permanent magnet: 3.2 ohms ±10% voice coil imp 3 x 5 inch speaker; sim to Oaktron S7473.
P1	4036634P1	Contact, electrical; sim to AMP 42428-2.
		BASE PLATE ASSEMBLY 19D416663G1
A1101		SYSTEM BOARD 19D416655G1
C1*	5496267P19	Tantalum: 22 µf ±20%, 35 VDCW; sim to Sprague Type 150D.
		Earlier than REV A:
	5496267P10	Tantalum: 22 µf ±20%, 15 VDCW; sim to Sprague Type 150D.
C2	5496267P11	Tantalum: 68 µf ±20%, 15 VDCW; sim to Sprague Type 150D.
СЗ	5496267P2	Tantalum: 47 µf ±20%, 6 VDCW; sim to Sprague Type 150D.
C4	5496267P1	Tantalum: 6.8 µf ±20%, 6 VDCW; sim to Sprague Type 150D.
C5	19A115680P10	Electrolytic: 200 µf +150% -10%, 18 VDCW; sim to Mallory Type TTX.
C6	19A116080P7	Polyester: 0.1 µf ±20%, 50 VDCW.
C7	7147203P16	Silver mica: 2200 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-20.
С8	5496267P2	Tantalum: 47 µf ±20%, 6 VDCW; sim to Sprague Type 150D.
C9	19A116640P1	Electrolytic: 1600 µf +150% -10%, 50 VDCW; sin to GE 87F818BAB8.
C10	7774786P24	Electrolytic: 20 μf +100% -10%, 250 VDCW; sim Mallory Type TC.
C11	19A116080P104	Polyester: 0.033 µf ±10%, 50 VDCW.
C12*	19A116655P19	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. Added by REV C.
		DIODES AND RECTIFIERS
CR1 thru CR8	4037822P2	Silicon.
CR9 thru	4037822P1	Silicon.
CR11		
CR12 CR13	19A115250P1 4037822P1	Silicon.
CR14 and	19A115250P1	Silicon.
CR15		
Fl	1R16P5	Quick blowing, cartridge: 2 amp 250 v; sim
Fl	1R16P5	Quick blowing, cartridge: 2 amp 250 v; sim to Littelfuse 312002 or Bussmann AGC-2.

SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO
		JACKS AND RECEPTACLES		
J1101 thru J1110	19A116446P5	Connector, printed wiring, one-part.	T1101	19A116743P1
J1111		(Part of printed wiring board).		
		TRANSISTORS		_
Q1 thru Q3	19A116742P1	Silicon, NPN.	W1101	19A116740P2
Q4 and Q5	19A115300P2	Silicon, NPN; sim to Type 2N3053.	XF1101	19B209005P1
Q6	19A115976P1	Silicon, PNP; sim to Type 2N4356.		
Q7 and Q8	19A115889P1	Silicon, NPN.		
		RESISTORS	CR1	19A134146P4
R1 abd R2	3R152P512J	Composition: 5100 ohms ±5%, 1/4 w.		15/11/11/17
R3	3R152P181J	Composition: 180 ohms ±5%, 1/4 w.	R1	5496870P11
R4	3R152P202J	Composition: 2000 ohms ±5%, 1/4 w.	]	
R5	3R152P153J	Composition: 15,000 ohms ±5%, 1/4 w.		
R6	3R152P392J	Composition: 3900 ohms ±5%, 1/4 w.	S1	19Al16676Pl
R7	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.		
R8	3R152P821J	Composition: 820 ohms ±5%, 1/4 w.	ĺ	
R9	3R152P222J	Composition: 2200 ohms ±5%, 1/4 w.	i i	
R10	3R152P101J	Composition: 100 ohms ±5%, 1/4 w.		
R11 and R12	3R152P510J	Composition: 51 ohms ±5%, 1/4 w.		
R13	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.		
R14	3R77P152J	Composition: 1500 ohms ±5%, 1/2 w.		
R15	3R152P131J	Composition: 130 ohms ±5%, 1/4 w.		
R16	3R152P224J	Composition: 0.22 megohm ±5%, 1/4 w.		
R17	3R77P152J	Composition: 1500 ohms ±5%, 1/2 w.		
R18 and R19	3R77P101J	Composition: 100 ohms ±5%, 1/2 w.		
R20	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.		
R21* and R22*	19A116310P5	Composition: 22 ohms ±5%, 1.0 w; sim to Allen- Bradley Type GB. Added by REV B.		
[				
RT1	19B209143P2	Rod: 4000 ohms ±10%; sim to Globar Type 789F-12.		
Tl	19A116736P1	Audio freq: 300 to 6000 Hz, Pri: 30 ohms ±15%, Sec 1: 15 ohms ±15%, Sec 2: 15 ohms ±15%.		
VR1	4036887P12	VOLTAGE REGULATORS		
l				
F1101	7487942P3	Slow blowing: 1/2 amp at 250 v; sim to Bussmann MDL-1/2.		
P1101		(Part of Wll01).		
		SWITCHES		
31101	19B209261P8	Slide: DPDT, 2 poles, 2 positions, .5 amp VDC or 3 amps at VAC; sim to Switchcraft 46206L.		

#### PARTS LIST

DESCRIPTION

- - - - - - - - TRANSFORMERS - - - - - -

- - - - - - - - - SOCKETS - - - - - - - - -

Fuseholder: 15 amps at 250 v; sim to Littelfuse 342012.

- - - - - - DIODES AND RECTIFIERS - - - - -

Diode, optoelectronic: red; sim to Opcoa LSM-6L. 

Variable, carbon film: 5000 ohms  $\pm 20\%$ ; sim to Mallory LC(5K).

Sensitive: SPDT, 5 amp at 24 VDC or 5 amp at 250 VRMS; sim to Microswitch 111SM1-T2.

AUDIO BOARD 19D416629G1 (Parts List for Audio Board is located on back of Audio Board schematic).

Power: 2 poles, 3 wire grounding, approx 8 feet long.

Power, step-down: Pri: 120 VRMS, 50/60 Hz, Sec 1: 150 VDC ±4% at 0.015 amps, Sec 2: 24 VDC ±4% at 1.0 amps.

#### LBI-4466B

SWITCH KIT (FUNCTION SELECTOR) 19D416628G1-G12

SYMBOL	GE PART NO.	DESCRIPTION
		DIODES AND RECTIFIERS
CR1 and CR2	19A134146P4	Diode, optoelectronic: red; sim to Opcoa LS
CR3	4037822P1	Silicon.
		RESISTORS
R1 and R2	3R77P222J	Composition: 2200 ohms ±5%, 1/2 w.
R3	3R152P203J	Composition: 20,000 ohms ±5%, 1/4 w.
R4	3R77P122J	Composition: 1200 ohms ±5%, 1/2 w.
R5 and R6	3R152P222J	Composition: 2200 ohms ±5%, 1/4 w.
		SWITCHES
S1	19B209580P12	Push: DPDT, 1 station, momentary action opening currents, (A) 100 MADC at 28 v or (B) 15 at 130 v; sim to Schadow Co. Series G.
S2	19B209580P13	Push: DPDT, 1 station, alternate action opening currents, (A) 100 MADC at 28 v or (B) 15 at 130 v; sim to Schadow Co. Series G.
S4	19B209580P15	Push: 4PDT, 1 station, alternate action oper ing currents, (A) 100 MADC at 28 v or (B) 15 at 130 v; sim to Schadow Co. Series G.
		VOLTAGE REGULATORS
VR1	4036887 <b>P</b> 6	Silicon, Zener.
		MISCELLANEOUS
	19C317983P1	Lens.
	19D423501P2	Knob, pushon.
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\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES \*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

#### PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

SYSTEM BOARD 19D416655G1
Rev. A - To increase voltage rating of capacitor. Changed Cl.

- REV. B To provide phone line surge resistors for lightning protection. Added R21 and R22.
- REV. C To eliminate possiblilty of oscillation in Audio Amplifier. Added C12.

(19R640908, Rev. 19)

TONE CONTROL SYSTEM DIAGRAM

Issue 7

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PARTS LIST	
LBI-4467D	
MASTR CONTROLLER UNIT 19D416689G1	

		MASTR CONTROLLER UNIT 19D416689G1	J1101 thru J1110	19A116446P5	Connector, printed wiring, one-part.
			J1111		(Part of printed wiring board).
CVMDOL	CE DART NO	DECODINE	1		
SYMBOL	GE PART NO.	DESCRIPTION	Q1 thru Q3	19A116742P1	Silicon, NPN.
		FRONT COVER ASSEMBLY 19D416669G1	Q4 and Q5	19A115300P2	Silicon, NPN; sim to Type 2N3053.
		DIODES AND RECTIFIERS	Q6	19A115976P1	Silicon, PNP; sim to Type 2N4356.
CR1	19A134146P4	Diode, optoelectronic: red; sim to Opcoa LSM-6L.	Q7 and Q8	19A115889P1	Silicon, NPN.
. 61	19C307094P1				RESISTORS
LS1	190307094P1	Permanent magnet: 3.2 ohms ±10% voice coil imp, 3 x 5 inch speaker; sim to Oaktron S7473.	R1 abd R2	3R152P512J	Composition: 5100 ohms ±5%, 1/4 w.
			R3	3R152P181J	Composition: 180 ohms ±5%, 1/4 w.
P1	4036634P1	Contact, electrical; sim to AMP 42428-2.	R4	3R152P202J	Composition: 2000 ohms ±5%, 1/4 w.
		BASE PLATE ASSEMBLY	R5	3R152P153J	Composition: 15,000 ohms ±5%, 1/4 w.
		19D416663G1	R6	3R152P392J	Composition: 3900 ohms ±5%, 1/4 w.
A1101		SYSTEM BOARD 19D416655G1	R7	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.
		GAP1677777	R8	3R152P821J	Composition: 820 ohms ±5%, 1/4 w.
C1*	5496267P19	Tantalum 22 of 420g 25 MDCW can to Sangue	R9	3R152P222J	Composition: 2200 ohms ±5%, 1/4 w.
(1*	5490207P19	Tantalum: 22 µf ±20%, 35 VDCW; sim to Sprague Type 150D.	R10	3R152P101J	Composition: 100 ohms ±5%, 1/4 w.
	5496267P10	Earlier than REV A: Tantalum: 22 µf ±20%, 15 VDCW; sim to Sprague	R11 and R12	3R152P510J	Composition: 51 ohms ±5%, 1/4 w.
		Type 150D.	R13	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.
C2	5496267P11	Tantalum: 68 μf ±20%, 15 VDCW; sim to Sprague Type 150D.	R14	3R77P152J	Composition: 1500 ohms ±5%, 1/2 w.
С3	5496267P2	Tantalum: 47 μf ±20%, 6 VDCW; sim to Sprague	R15	3R152P131J	Composition: 130 ohms ±5%, 1/4 w.
	£ 400005E3	Type 150D.	R16	3R152P224J	Composition: 0.22 megohm ±5%, 1/4 w.
C4	5496267P1	Tantalum: 6.8 μf ±20%, 6 VDCW; sim to Sprague Type 150D.	R17	3R77P152J	Composition: 1500 ohms ±5%, 1/2 w.
C5	19A115680P10	Electrolytic: 200 µf +150% -10%, 18 VDCW; sim to Mallory Type TTX.	R18 and R19	3R77P101J	Composition: 100 ohms $\pm 5\%$ , $1/2$ w.
C6	19A116080P7	Polyester: 0.1 μf ±20%, 50 VDCW.	R20	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.
C7	7147203P16	Silver mica: 2200 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-20.	R21*	19A116310P5	Composition: 22 ohms ±5%, 1.0 w; sim to Allen- Bradley Type GB. Added by REV B.
C8	5496267P2	Tantalum: 47 μf ±20%, 6 VDCW; sim to Sprague Type 150D.	R22*		
C9	19Al16640P1	Electrolytic: 1600 µf +150% -10%, 50 VDCW; sim to GE 87F818BAB8.	RT1	19B209143P2	Rod: 4000 ohms ±10%; sim to Globar Type 789F-12.
C10	7774786P24	Electrolytic: 20 µf +100% -10%, 250 VDCW; sim to Mallory Type TC.			
C11	19A116080P104	Polyester: 0.033 μf ±10%, 50 VDCW.	T1	19Al16736Pl	Audio freq: 300 to 6000 Hz,
C12*	19A116655P19	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. Added by REV C.			Pri: 30 ohms ±15%, Sec 1: 15 ohms ±15%, Sec 2: 15 ohms ±15%.
		DIODES AND RECTIFIERS			VOLTAGE REGULATORS
CR1 thru CR8	4037822P2	Silicon.	VR1	4036887P12	Silicon, Zener.
CR9 thru CR11	4037822Pl	Silicon.	F1101	7487942P3	
CR12	19All5250Pl	Silicon.			
CR13	4037822P1	Silicon.			
CR14	19A115250P1	Silicon.	P1101		(Part of W1101).
and CR15					
		FUSES	S1101	19B209261P8	Slide: DPDT, 2 poles, 2 positions, .5 amp VDC or 3 amps at VAC; sim to Switchcraft 46206L.
Fl	1R16P5	Quick blowing, cartridge: 2 amp 250 v; sim to Littelfuse 312002 or Bussmann AGC-2.			

SYMBOL GE PART NO.

		<del></del>	
DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
JACKS AND RECEPTACLES Connector, printed wiring, one-part.	T1101	19A116743P1	
(Part of printed wiring board).			Sec 2: 24 VDC ±4% at 1.0 amps.
	W1101	19A116740P2	Power: 2 poles, 3 wire grounding, approx 8 feet long.
Silicon, NPN; sim to Type 2N3053.	XF1101	19B209005P1	
Silicon, PNP; sim to Type 2N4356. Silicon, NPN.			PUSH TO TALK PANEL 19C320239G1
	CR1	19A134146P4	DIODES AND RECTIFIERS Diode, optoelectronic: red; sim to Opcoa LSM-6L.
Composition: 180 ohms ±5%, 1/4 w. Composition: 2000 ohms ±5%, 1/4 w.	Rl	5496870P11	Variable, carbon film: 5000 ohms ±20%; sim to Mallory LC(5K).
omposition: 15,000 ohms ±5%, 1/4 w.			SWITCHES
omposition: 3900 ohms ±5%, 1/4 w. omposition: 1000 ohms ±5%, 1/4 w.	S1	19A116676P1	Sensitive: SPDT, 5 amp at 24 VDC or 5 amp at 250 VRMS; sim to Microswitch 111SM1-T2.
mposition: 820 ohms ±5%, 1/4 w.			
mposition: 2200 ohms ±5%, 1/4 w. mposition: 100 ohms ±5%, 1/4 w.			
omposition: 51 ohms ±5%, 1/4 w.			AUDIO BOARD 19D416629G1 (Parts List for Audio Board is located on back of Audio Board schematic).
omposition: 1000 ohms ±5%, 1/4 w.			

#### PARTS LIST

LBI-4829

SYMBOL	GE PART NO.	DESCRIPTION
	19A129387G1	DIODES AND RECTIFIERS Diode Assembly, Includes diode (4037822P1) 2 contacts (4029840P1).
	19A129525G3 19A129914G1	

#### PARTS LIST

#### LB14466D

# SWITCH KIT (FUNCTION SELECTOR) 19D416628G1-G17

# PARTS LIST LBI-30439

# ROTARY SWITCH 3 AND 4 FREQUENCY SELECT 19C320717G3, G4

SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
C1	5496267Pl0	CAPACITORS Tantalum: 22 μf ±20%, 15 VDCw; sim to Sprague Type 150D.	Rl	3R152P332K	RESISTORS
		DIODES AND RECTIFIERS	S1	19A116195P2	Rotary: 1 section, 2 poles, (adj 2-5 position), non-shorting; sim to Grayhill 50MY23156-2-3N.
CR1 and CR2	19A134146P4	Diode, optoelectronic: red; sim to Opcoa LSM-6L.	S2	19A116195P3	Rotary: 1 section, 2 poles, (adj 2-5 position), non-shorting; sim to Grayhill 50MY23156-2-4N.
CR3	4037822P1	Silicon, 1000 mA, 400 PIV.			MISCELLANEOUS
		RESISTORS		19A129867G1	Insert.
R1 and	3R77P222J	Composition: 2.2K ohms ±5%, 1/2 w.		19A129866G1	Lens.
R2				19A127319P2	Nut: thd. size No. 1/4-28. (Secures S1, S2).
R3	3R152P203J	Composition: 20K ohms ±5%, 1/4 w.		N414P25C6	Lockwasher, internal tooth: No. 1/4. (Secures S1, S2).
R4	3R77P122J	Composition: 1.2K ohms ±5%, 1/2 w.		19B209527P1	Knob. (Used with Sl. S2).
R5 and	3R152P222J	Composition: 2.2K ohms ±5%, 1/4 w.		NP276388	Nameplate.
Rô				4029840P2	Contact, electrical: sim to Amp 42827-2. (Used
				102001012	with S1-1, S1-2, S1-3, S2-1, S2-2, S2-3, S2-4).
Sl	19B209580P12	Push: DPDT, 1 station, momentary action; sim to Schadow Co. Series "G". (Used in G3, G7 & G13).		4033348Pl	Contact, electrical: sim to Bead Chain Ml25-34. (Used with Sl-10, S2-10).
\$2	19B209580P13	Push: DPDT, 1 station, alternate action; sim to Schadow Co. Series "G". (Used in G1, G2, G4, G5, G12, G14, G16 & G17).			
S4	19B209580P15	Push: 4PDT, 1 station, alternate action; sim to Schadow Co. Series "G". (Used in G6, G8, G9, G10 5 G11).			
S5	19B209580P14	Push: 4PDT, 1 station, momentary action; sim to Schadow Co. Series "G". (Used in G15).			
VRl	4036887P6	Silicon, Zener: 500 mw, 6.5 v. nominal.			
		MISCELLANEOUS			
-	19C317983P1	Lens.			
	19D423501P2	Knob, pushon.			
	19D416329P1	Insert. (Used in G2-G11, G13-G17).			
	19D416330P1	Insert. (Used in Gl, Gl2).			
	19C320172P1	Printed board.			
	4029840P2	Contact, electrical: sim to Amp 42827-2. (Hung in wiring).			
	4033348Pl	Contact, electrical: sim to Bead Chain M125-34.			

#### PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

- SYSTEM BOARD 19D416655G1
  Rev. A To increase voltage rating of capacitor. Changed Cl.
- REV. B To provide phone line surge resistors for lightning protection. Added R21 and R22.

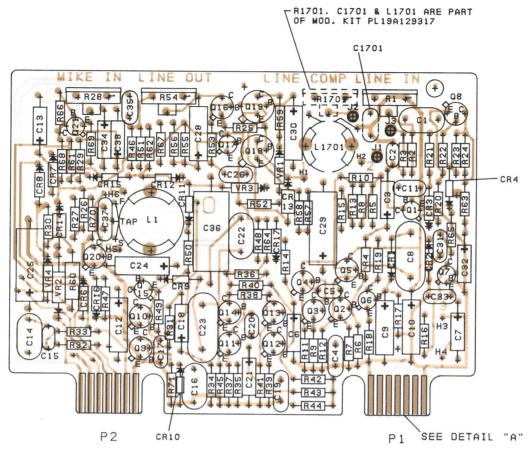
- REV. C To eliminate possiblilty of oscillation in Audio Amplifier. Added Cl2.

Contact, electrical: sim to Bead Chain M125-34. (Used in G4- Hung in wiring at S2-3).

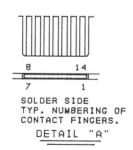
Tap screw, phillips head: No. 4-24 x 1/4. (Secures switches and inserts).

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

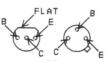
\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES



	CONNE	CTIONS CHA	RT
FROM	TO	WIRE	REMARKS
H1	H2	DA	
H5	H6	DA	GR 1 ONLY

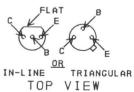


LEAD IDENTIFICATION FOR Q1-Q5, Q7-Q14, Q16, Q20



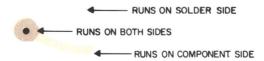
IN-LINE TRIANCULAR

NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION. LEAD IDENTIFICATION FOR Q6, Q15, Q17-Q19, Q21



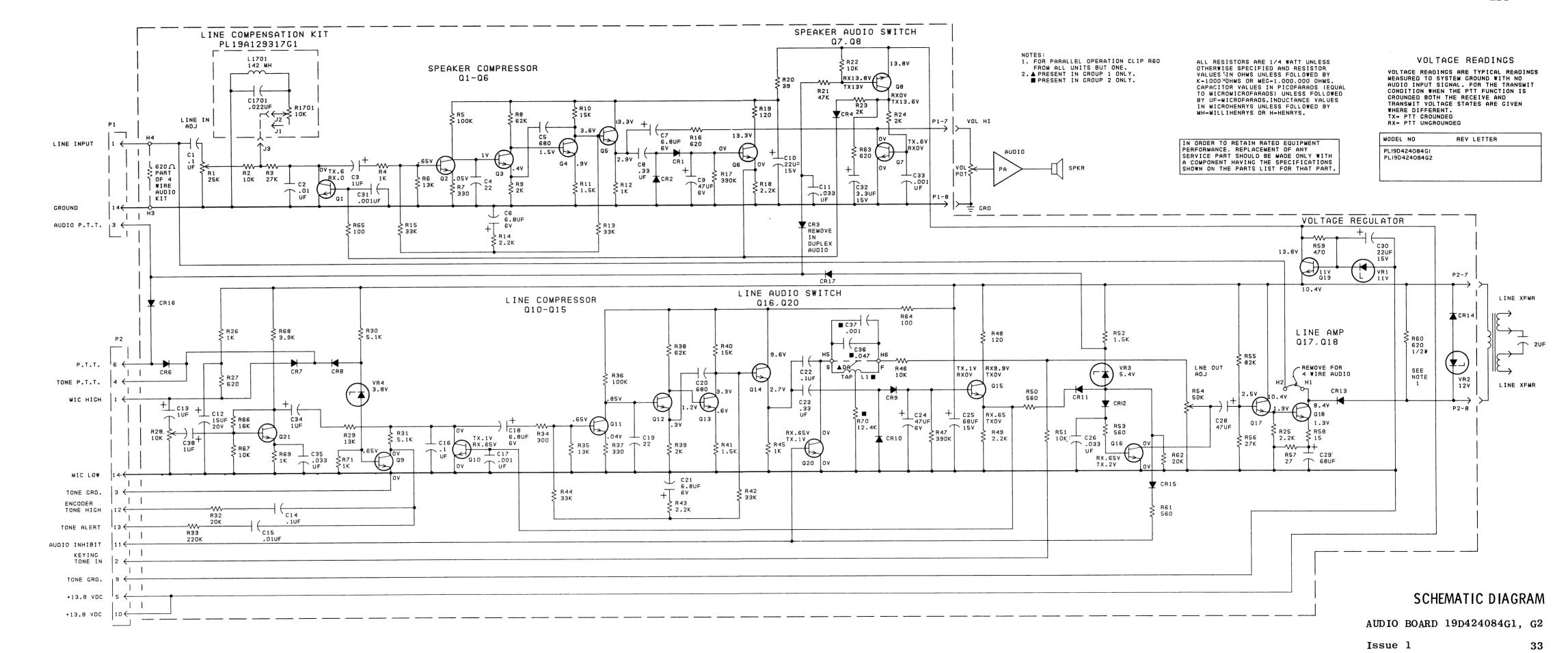
NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

(19D424085, Rev. 1) (19B227491, Sh. 1, Rev. 0) (19B227491, Sh. 2, Rev. 0)



## **OUTLINE DIAGRAM**

AUDIO BOARD 19D424084G1, G2



LBI-4478

PARTS LIST

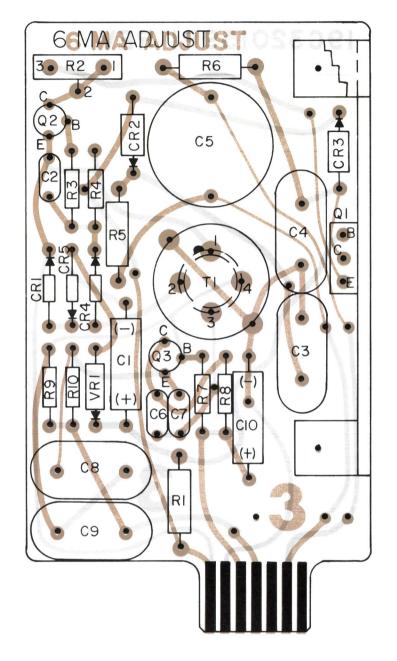
LBI-30272

SYMBOL	GE PART NO.	DESCRIPTION
	10411600000	
C1	19A116080P7	Polyester: 0.1 µf ±20%, 50 VDCW.
C2	19A116080P101 5496267P17	Polyester: 0.01 µf ±10%, 50 VDCW.
C3	5496267P17	Tantalum: 1.0 $\mu$ f $\pm 20\%$ , 35 VDCW; sim to Sprague Type 150D.
C4	7489162P11	Silver mica: 22 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C5	5494481P109	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C6 and C7	5496267P1	Tantalum: 6.8 $\mu f$ $\pm 20\%$ , 6 VDCW; sim to Sprague Type 150D.
C8	19A116080P10	Polyester: 0.33 µf ±20%, 50 VDCW.
C9	5496267P2	Tantalum: 47 $\mu$ f $\pm 20\%$ , 6 VDCW; sim to Sprague Type 150D.
C10	5496267P10	Tantalum: 22 µf ±20%, 15 VDCW; sim to Sprague Type 150D.
C11	19A116080P4	Polyester: 0.033 µf ±20%, 50 VDCW.
C12	5496267P14	Tantalum: 15 $\mu$ f $\pm 20\%$ , 20 VDCW; sim to Sprague Type 150D.
C13	5496267P17	Tantalum: 1.0 µf ±20%, 35 VDCW; sim to Sprague Type 150D.
C14	19A116080P7	Polyester: 0.1 μf ±20%, 50 VDCW.
C15	19A116080P101	Polyester: 0.01 µf ±10%, 50 VDCW.
C16	19A116080P7	Polyester: 0.1 µf ±20%, 50 VDCW.
C17	5494481P111	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C18	5496267P1	Tantalum: 6.8 µf ±20%, 6 VDCW; sim to Sprague Type 150D.
C19	7489162P11	Silver mica: 22 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C20	5494481P109	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C21	5496267P1	Tantalum: 6.8 $\mu$ f $\pm 20\%$ , 6 VDCW; sim to Sprague Type 150D.
C22	19A116080P7	Polyester: 0.1 μf ±20%, 50 VDCW.
C23	19A116080P10	Polyester: 0.33 μf ±20%, 50 VDCW.
C24	5496267P2	Tantalum: 47 $\mu$ f $\pm 20\%$ , 6 VDCW; sim to Sprague Type 150D.
C25	5496267P11	Tantalum: 68 $\mu f$ $\pm 20\%$ , 15 VDCW; sim to Sprague Type 150D.
C26	19A116080P4	Polyester: 0.033 µf ±20%, 50 VDCW.
C28	5496267P2	Tantalum: 47 $\mu$ f $\pm 20\%$ , 6 VDCW; sim to Sprague Type 150D.
C29	5496267P11	Tantalum: 68 $\mu$ f $\pm 20\%$ , 15 VDCW; sim to Sprague Type 150D.
C30	5496267P10	Tantalum: 22 $\mu f$ ±20%, 15 VDCW; sim to Sprague Type 150D.
C31	5494481P111	Ceramic disc: 1000 pf $\pm 20\%$ , 1000 VDCW; sim to RMC Type JF Discap.
C32	5496267P9	Tantalum: 3.3 $\mu f$ $\pm 20\%$ , 15 VDCW; sim to Spragu Type 150D.
C33	5494481P111	Ceramic disc: 1000 pf $\pm 20\%$ , 1000 VDCW; sim to RMC Type JF Discap.
C34	5496267P17	Tantalum: 1.0 $\mu f$ ±20%, 35 VDCW; sim to Spragutype 150D.
C35	19A116080P204	Polyester: 0.033 µf ±5%, 50 VDCW.

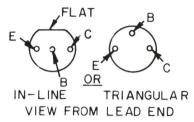
GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
19C307114P4702G	Polystyrene: 47,000 pf ±2%, 100 VDCW, temp coef	R6	3R152P133J	Composition: 13,000 ohms ±5%, 1/4 w.
	-120±30 PPM/°C.	R7	3R152P331J	Composition: 330 ohms ±5%, 1/4 w.
5496203P481	Ceramic disc: 1000 pf ±5%, 500 VDCW, temp coef -5600 PPM.	R8	3R152P623J	Composition: 62,000 ohms ±5%, 1/4 w.
5496267P17	Tantalum: 1.0 μf ±20%, 35 VDCW; sim to Sprague	R9	3R152P202J	Composition: 2000 ohms ±5%, 1/4 w.
	Type 150D.	R10	3R152P153J	Composition: 15,000 ohms $\pm 5\%$ , 1/4 w.
	DIODES AND RECTIFIERS	R11	3R152P152J	Composition: 1500 ohms ±5%, 1/4 w.
19A115250P1	Silicon.	R12	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.
		R13	3R152P333J	Composition: 33,000 ohms ±5%, 1/4 w.
19A115100P2	Silicon; sim to Type 1N459A.	R14	3R152P222J	Composition: 2200 ohms ±5%, 1/4 w.
19A115250P1	Silicon.	R15	3R152P333J	Composition: 33,000 ohms ±5%, 1/4 w.
19A115100P2	Silicon; sim to Type lN459A.	R16	3R152P621J	Composition: 620 ohms ±5%, 1/4 w.
		R17	3R152P394J	Composition: 0.39 megohm ±5%, 1/4 w.
19Al15250Pl	Silicon.	R18	3R152P222J	Composition: 2200 ohms ±5%, 1/4 w.
		R19	3R152P121J	Composition: 120 ohms ±5%, 1/4 w.
4037822P7	Silicon.	R20	3R152P390J	Composition: 39 ohms ±5%, 1/4 w.
		R21	3R152P473J	Composition: 47,000 ohms ±5%, 1/4 w.
19A115250P1	Silicon.	R22	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.
19A115100P2	Silicon; sim to Type lN459A.	R23	3R152P202J	Composition: 2000 ohms $\pm 5\%$ , $1/4$ w.
		and R24	1	,
		R25	3R152P222J	Composition: 2200 ohms ±5%, 1/4 w.
	JACKS AND RECEPTACLES	R26	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.
4033513P4	Contact, electrical: sim to Bead Chain L93-3.	R27	3R152P621J	Composition: 620 ohms ±5%, 1/4 w.
		R28	19B209358P106	Variable, carbon film: approx 300 to
				±10%, 0.25 w; sim to CTS Type X-201.
19B205354G8	Coil.	R29	3R152P133J	Composition: 13,000 ohms $\pm 5\%$ , 1/4 w.
		R30 and	3R152P512J	Composition: 5100 ohms ±5%, 1/4 w.
	(Part of printed board 19D424083P1).	R31		
	(Fart of printed board 190424003P1).	R32	3R152P203J	Composition: 20,000 ohms ±5%, 1/4 w.
	TRANSISTORS	R33	3R152P224J	Composition: 0.22 megohm ±5%, 1/4 w.
19A115552P1	Silicon, NPN; sim to Type 2N2714.	R34	3R152P301J	Composition: 300 ohms ±5%, 1/4 w.
19A115889P1	Silicon, NPN.	R35	3R152P133J	Composition: 13,000 ohms ±5%, 1/4 w.
15/11/000511	officon, NPK.	R36	3R152P104J	Composition: 0.10 megohm ±5%, 1/4 w.
19A116774P1	Silicon, NPN; sim to Type 2N5210.	R37	3R152P331J	Composition: 330 ohms ±5%, 1/4 w.
19A115552P1	Silicon, NPN; sim to Type 2N3210.	R38	3R152P623J	Composition: 62,000 ohms ±5%, 1/4 w.
	l ' ' ' ' ' ' ' ' ' ' ' ' ' ' ' ' ' ' '	R39	3R152P202J	Composition: 2000 ohms ±5%, 1/4 w.
19A115779P1	Silicon, PNP; sim to Type 2N3251.	R40	3R152P153J	Composition: 15,000 ohms $\pm 5\%$ , $1/4$ w.
19A115720P1	Silicon, NPN; sim to Type 2N2222.	R41	3R152P152J	Composition: 1500 ohms ±5%, 1/4 w.
19A129184P1 19A115889P1	Silicon, NPN. Silicon, NPN.	R42	3R152P333J	Composition: 33,000 ohms ±5%, 1/4 w.
12411200251	ollion, afa.	R43	3R152P222J	Composition: 2200 ohms ±5%, 1/4 w.
194116774D1	Silicon NDN. sim to Type 985910	R44	3R152P333J	Composition: 33,000 ohms ±5%, 1/4 w.
19A116774P1	Silicon, NPN; sim to Type 2N5210.	R45	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.
19A115720P1	Silicon, NPN; sim to Type 2N2222.	R46	3R152P103J	Composition: 10,000 ohms $\pm 5\%$ , 1/4 w.
19A116774P1	Silicon, NPN; sim to Type 2N5210.	R47	3R152P394J	Composition: 0.39 megohm ±5%, 1/4 w.
19A115300P4	Silicon, NPN.	R48	3R152P121J	Composition: 120 ohms ±5%, 1/4 w.
10419010481	Silicon NDN	R49	3R152P222J	Composition: 2200 ohms ±5%, 1/4 w.
19A129184P1	Silicon, NPN.	R50	3R152P561J	Composition: 560 ohms ±5%, 1/4 w.
19A116774P1	Silicon, NPN; sim to Type 2N5210.	R51	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.
	RESISTORS	R52	3R152P152J	Composition: 1500 ohms ±5%, 1/4 w.
19B209358P107	Variable, carbon film: approx 800 to 25,000 ohms	R53	3R152P561J	Composition: 560 ohms ±5%, 1/4 w.
	±10%, 0.25 w; sim to CTS Type X-201.	R54	19B209358P108	Variable, carbon film: approx 2000 to
3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.		an1500000	ohms ±10%, 0.25 w; sim to CTS Type X-2
3R152P273J	Composition: 27,000 ohms ±5%, 1/4 w.	R55	3R152P823J	Composition: 82,000 ohms ±5%, 1/4 w.
3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.	R56	3R152P273J	Composition: 27,000 ohms ±5%, 1/4 w.
3R152P104J	Composition: 0.10 megohm ±5%, 1/4 w.	R57	3R152P270J	Composition: 27 ohms ±5%, 1/4 w.
	1			ļ.

	SYMBOL	GE PART NO.	DESCRIPTION
	R58	3R152P150J	Composition: 15 ohms ±5%, 1/4 w.
	R59	3R152P471J	Composition: 470 ohms $\pm 5\%$ , $1/4$ w.
	R60	3R77P621J	Composition: 620 ohms ±5%, 1/2 w.
	R61	3R152P561J	Composition: 560 ohms ±5%, 1/4 w.
	R62	3R152P203J	Composition: 20,000 ohms ±5%, 1/4 w.
	R63	3R152P621J	Composition: 620 ohms ±5%, 1/4 w.
	R64 and R65	3R152P101J	Composition: 100 ohms $\pm 5\%$ , $1/4$ w.
	R66	3R152P163J	Composition: 16,000 ohms ±5%, 1/4 w.
	R67	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.
- 1	R68	3R152P392J	Composition: 3900 ohms ±5%, 1/4 w.
	R69	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.
- 1	R70	19C314256P21242	Metal film: 12,400 ohms ±1%, 1/4 w.
	R71	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.
	VR1	4036887P8	VOLTAGE REGULATORS
	VR2	19A116325P4	Silicon, Zener; sim to 1N5349.
	VR3	4036887P5	Silicon, Zener.
	VR4	4036887P3	Silicon, Zener.
1			
			MISCELLANEOUS
		4035656P70	Spacer, threaded.
ohms		4036555P1	Insulator, washer: nylon. (Used with Q18 and Q19).
		4034048P4	Machine screw, pan head, 6-32 x 9/16 with .340 cutaway.

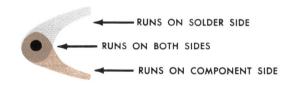
\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES



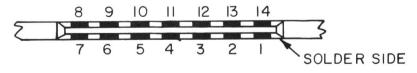
LEAD IDENTIFICATION FOR Q2 & Q3



NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.



TYPICAL CONTACT FINGER NUMBERING

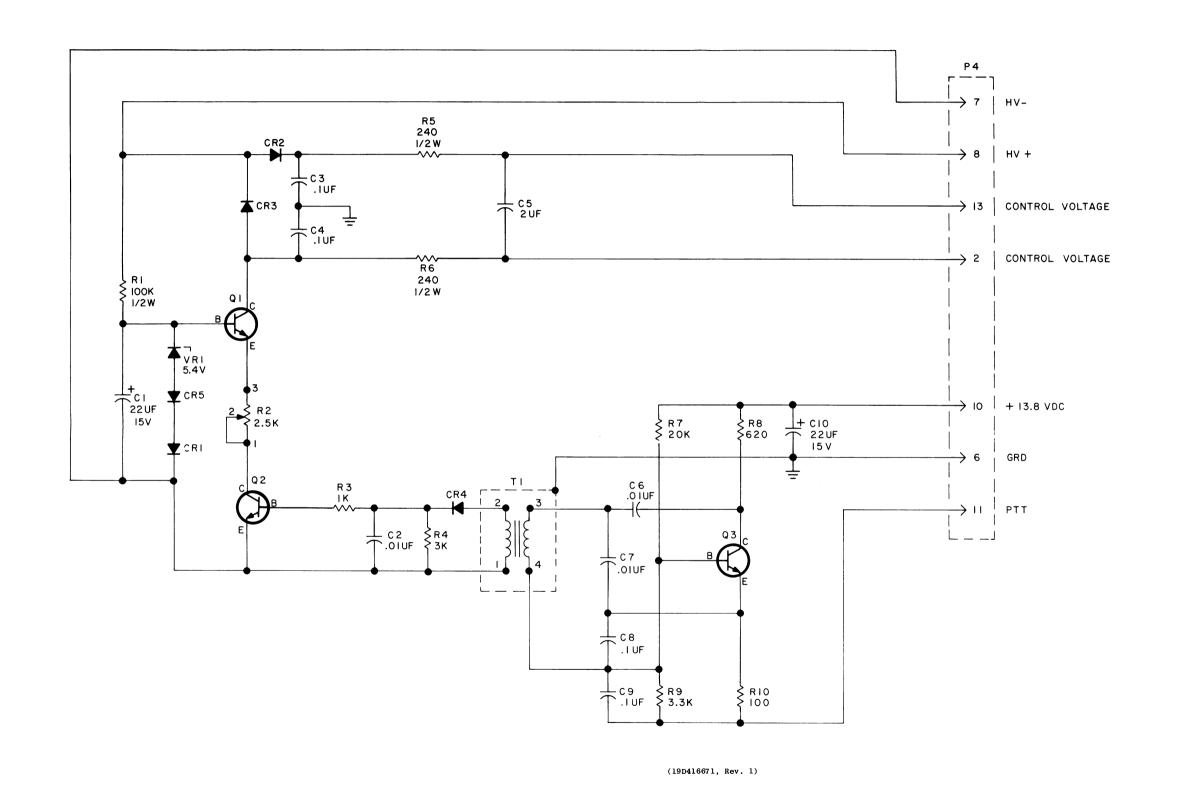


(19C320710, Rev. 0) (19C320159, Sh. 2, Rev. 3) (19C320159, Sh. 3, Rev. 3)

#### **OUTLINE DIAGRAM**

SINGLE FREQUENCY HIGH VOLTAGE BOARD 19C320169G1

Issue 2 35



SERVICE PART SHOULD BE MADE ONLY WITH A COMPONENT HAVING THE SPECIFICATIONS SHOWN ON THE PARTS LIST FOR THAT PART

IN ORDER TO RETAIN RATED EQUIPMENT PERFORMANCE, REPLACEMENT OF ANY

ALL RESISTORS ARE 1/4 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K=1000 OHMS OR MEG=1,000,000 OHMS CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED BY UF= MICROFARADS, INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH= MILLIHENRYS OR H=HENRYS.

SEE APPLICABLE PRODUCTION CHANGE SHEETS IN INSTRUCTION BOOK SECTION DEALING WITH THIS UNIT FOR DESCRIPTION OF CHANGES UNDER EACH REVISION LETTER

THIS ELEM DIAG APPLIES TO

MICEL NO REVISITER

PL19C320169GI

## **SCHEMATIC DIAGRAM**

DC CONTROL HIGH VOLTAGE MODULE (SINGLE FREQUENCY) 19C320169G1

#### PARTS LIST

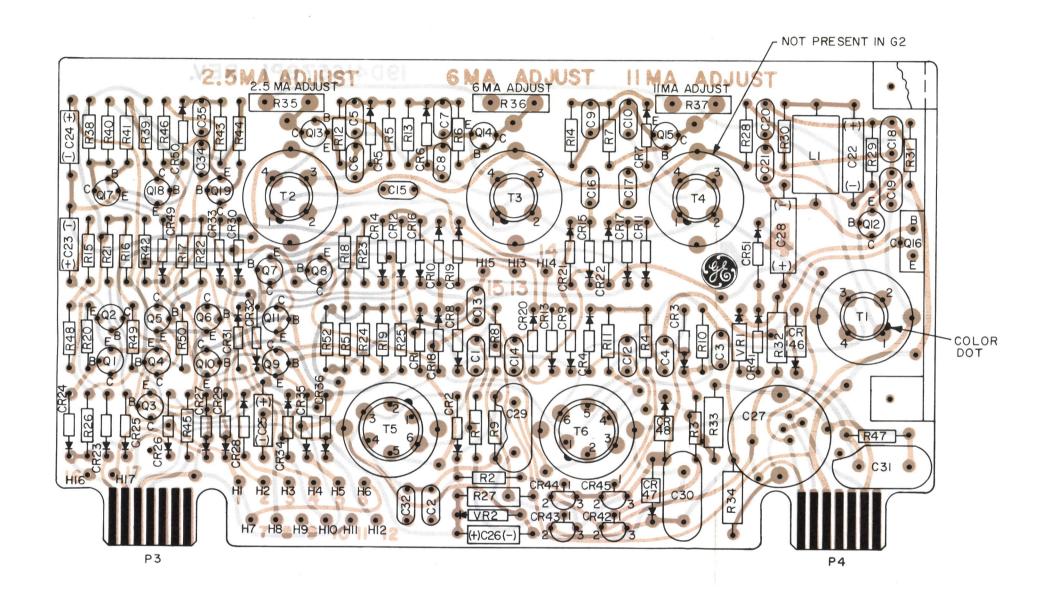
LBI-4456

## SINGLE FREQ HIGH VOLTAGE BOARD 19C320169G1

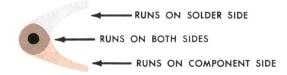
SYMBOL	GE PART NO.	DESCRIPTION
		QUINCY-075
C1	5496267P10	
C2	19A116080P1	Polyester: 0.01 μf ±20%, 50 VDCW.
C3 and C4	19A115028P514	Polyester: 0.1 μf ±5%, 200 VDCW.
C5	7486445P6	Electrolytic, non polarized: 2 μf +100% -10%, 200 VDCW.
C6 and C7	19A116080P1	Polyester: 0.01 µf ±20%, 50 VDCW.
C8 and C9	19A115028P514	Polyester: 0.1 µf ±5%, 200 VDCW.
C10	5496267P10	Tantalum: 22 $\mu f$ ±20%, 15 VDCW; sim to Sprague Type 150D.
		DIODES AND RECTIFIERS
CR1	19A115250P1	Silicon.
CR2 and CR3	4037822P2	Silicon.
CR4 and CR5	19A115250P1	Silicon.
P4		(Part of printed wiring board 19C320159P1).
	1041601005	TRANSISTORS
Q1	19A129183P1	Silicon, NPN.
Q2 and Q3	19A116774P1	Silicon, NPN; sim to Type 2N5210.
"	287781041	Composition: 0.1 merchy +5% 1/2 w
R1 R2	3R77P104J 19B209358P104	Composition: 0.1 megohm ±5%, 1/2 w.  Variable, carbon film: approx 50 to 2500 ohms
""		$\pm 10\%$ , 0.2 w; sim to CTS Type X-201.
R3	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.
R4	3R152P302J	Composition: 3000 ohms ±5%, 1/4 w.
R5 and R6	3R77P241J	Composition: 240 ohms ±5%, 1/2 w.
R7	3R152P203J	Composition: 20,000 ohms ±5%, 1/4 w.
R8	3R152P621J	Composition: 620 ohms ±5%, 1/4 w.
R9 R10	3R152P332J 3R152P101J	Composition: 3300 ohms ±5%, 1/4 w.  Composition: 100 ohms ±5%, 1/4 w.
, RIU	3R132P1UIJ	Composition: 100 ohms ±5%, 1/4 w.
Tl	19B219563G1	Coil.
VRl	4036887P5	Silicon, Zener.
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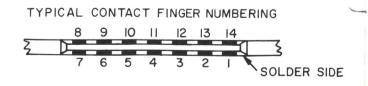
\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

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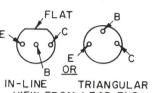


(19D417307, Rev. 0) (19D416578, Sh. 2, Rev. 4) (19D416578, Sh. 3, Rev. 4)





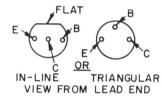
LEAD IDENTIFICATION FOR Q12, Q13, Q14, Q15



VIEW FROM LEAD END

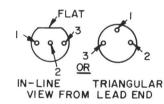
NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

LEAD IDENTIFICATION FOR QI-QII, QI7, QI8,QI9



NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

LEAD IDENTIFICATION FOR CR42 THRU CR45



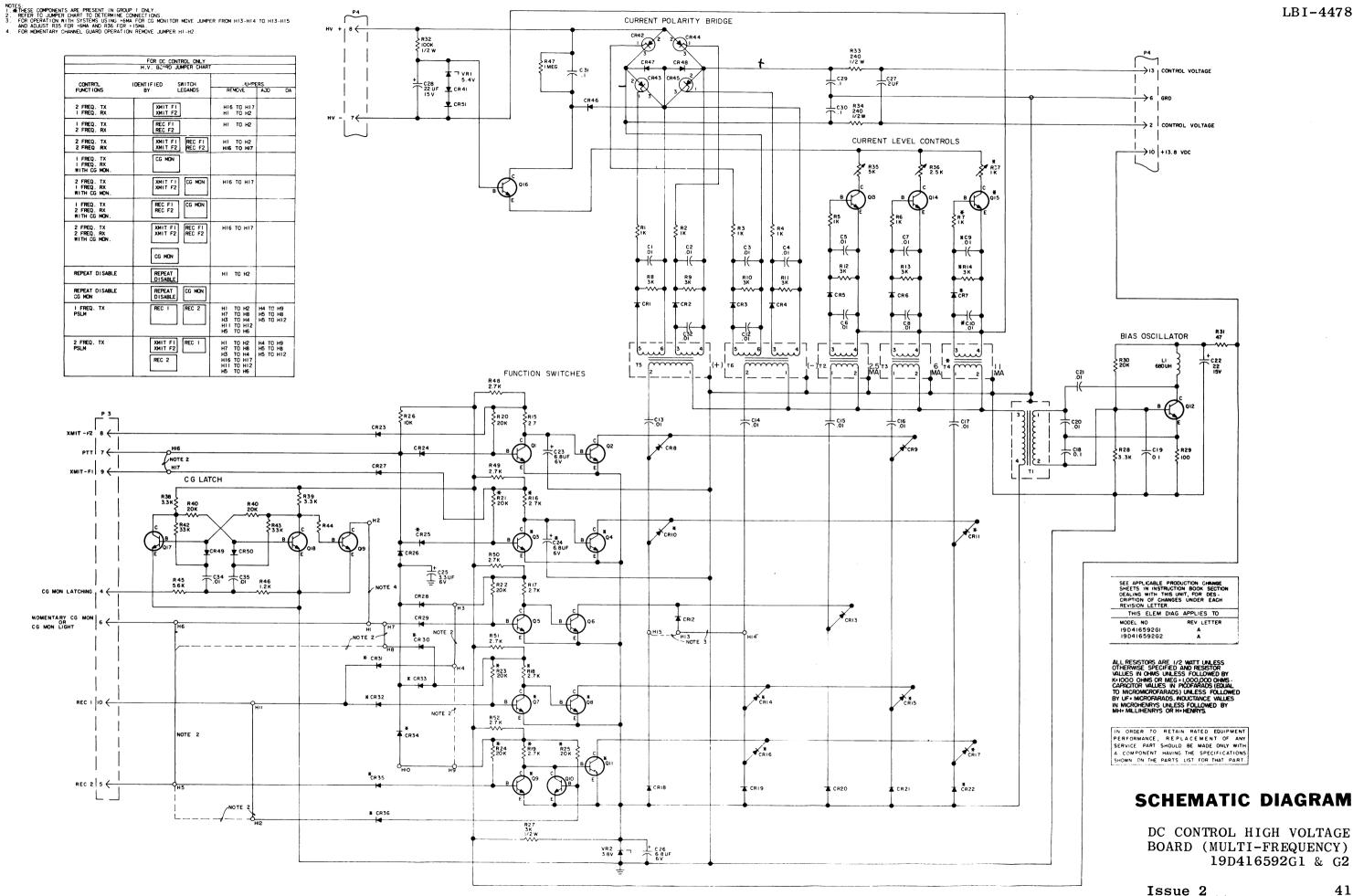
NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

## **OUTLINE DIAGRAM**

DC CONTROL HIGH VOLTAGE BOARD (MULTI-FREQUENCY) 19D416592G1 & G2

Issue 3

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LBI-4478

#### PARTS LIST

LBI-4465A

MULTI-FREQ HIGH VOLTAGE BOARD 19D416592G1 2 FREQ WITH CG 19D416592G2 1 FREQ WITH CG

C11 thru C12	SYMBOL	GE PART NO.	DESCRIPTION
194116080P1   Polyester: 0.01 \( \mu \)   120%, 50 VDCW.			CAPACITORS
19A116080F1   Polyester: 0.01 µf ±20%, 50 VDCW.	hru	19A116080P1	Polyester: 0.01 µf ±20%, 50 VDCW.
C18 and c19	C12 thru	19All6080Pl	Polyester: 0.01 µf ±20%, 50 VDCW.
19A116080P1   Polyester: 0.01 μf ±20%, 50 VDCW.	218 ind	19A11608 <del>0P</del> 7	Polyester: 0.1 µf ±20%, 50 VDCW.
S496267P10   Tantalum: 22 μf ±20%, 15 VDCW; sim to Sprague Type 150D.	220 and	19Al16080Pl	Polyester: 0.01 µf ±20%, 50 VDCW.
Type 150D.  Tantalum: 3.3 µf ±20%, 15 VDCW; sim to Sprague Type 150D.  Tantalum: 6.8 µf ±20%, 6 VDCW; sim to Sprague Type 150D.  Tantalum: 6.8 µf ±20%, 6 VDCW; sim to Sprague Type 150D.  Tantalum: 22 µf ±20%, 15 VDCW; sim to Sprague Type 150D.  C28 5496267P10		5496267P10	
Type 150D.  Type 150D.  Tantalum: 6.8 μf ±20%, 6 VDCW; sim to Sprague Type 150D.  Tantalum: 6.8 μf ±20%, 6 VDCW; sim to Sprague Type 150D.  Tantalum: 22 μf ±20%, 15 VDCW; sim to Sprague Type 150D.  Tantalum: 22 μf ±20%, 15 VDCW; sim to Sprague Type 150D.  Tantalum: 22 μf ±20%, 15 VDCW; sim to Sprague Type 150D.  Type 150D.  Tantalum: 22 μf ±20%, 15 VDCW; sim to Sprague Type 150D.  Type 150D.  Tantalum: 6.8 μf ±20%, 6 VDCW; sim to Sprague Type 150D.  Tantalum: 6.8 μf ±20%, 15 VDCW; sim to Sprague Type 150D.  Tantalum: 6.8 μf ±20%, 6 VDCW; sim to Sprague Type 150D.  Tantalum: 6.8 μf ±20%, 6 VDCW; sim to Sprague Type 150D.  Tantalum: 6.8 μf ±20%, 6 VDCW; sim to Sprague Type 150D.  Tantalum: 6.8 μf ±20%, 6 VDCW; sim to Sprague Type 150D.  Tantalum: 6.8 μf ±20%, 6 VDCW; sim to Sprague Type 150D.  Tantalum: 6.8 μf ±20%, 6 VDCW; sim to Type 2N50W; sim to Type 2N	ınd	5496267P1	Tantalum: 6.8 µf ±20%, 6 VDCW; sim to Sprague Type 150D.
Type 150D.  Type 150D.  Type 150D.  Electrolytic, non polarized: 2 µf +100% -10%, 200 VDCW.  Tantalum: 22 µf ±20%, 15 VDCW; sim to Sprague Type 150D.  Polyester: 0.1 µf ±5%, 200 VDCW.  19A115025F414  Polyester: 0.01 µf ±20%, 50 VDCW.  19A116080P1  Polyester: 0.01 µf ±20%, 50 VDCW.  C34  and C35  CR1  19A115250F1  Silicon.  CR24  19A115250P1  Silicon.  CR44  19A115250P1  Silicon.  CR45  CR46  4037822P2  Silicon.  CR48  CR49  19A115250P1  Silicon.  CR48  CR49  19A115250P1  Silicon.  CR40  19A115250P1  Silicon.  CR41  19A115250P1  Silicon.  CR42  19A116642P1  Thyristor, silicon controlled: sim to Type 2N506  Thru CR48  CR49  19A115250P1  Silicon.  CR40  CR40  19A115250P1  Silicon.  CR41  7491382P106  Co11, RF: 680 µh ±10%, 12 ohms DC res max; sim to Delevan 3500 Series.	25	5496267 <b>P</b> 9	Tantalum: 3.3 μf ±20%, 15 VDCW; sim to Sprague Type 150D.
200 VDCW.   200 VDCW.   2 μf ±20%, 15 VDCW; sim to Sprague Type 150D.   Tantalum: 22 μf ±20%, 15 VDCW; sim to Sprague Type 150D.   Polyester: 0.1 μf ±5%, 200 VDCW.   C31   C32   19A116080P1   Polyester: 0.01 μf ±20%, 50 VDCW.   C34   and   C35   C84   C35   C84   C35   C84	26	5496267P1	Tantalum: 6.8 μf ±20%, 6 VDCW; sim to Sprague Type 150D.
Type 150D.  Type 150D.  Type 150D.  19A115028F414  Polyester: 0.1 \( \mu f \) ±5%, 200 VDCW.  19A116080P1  Polyester: 0.01 \( \mu f \) ±20%, 50 VDCW.  234  19A116080P1  Polyester: 0.01 \( \mu f \) ±20%, 50 VDCW.  235  CR1  thru  CR3  19A115250P1  Silicon.  CR4  19A115250P1  Silicon.  CR4  19A11644P1  Thyristor, silicon controlled: sim to Type 2N506  CR4  thru  CR46  thru  CR46  thru  CR48  19A115250P1  Silicon.  CR49  thru  CR49  thru  CR40  19A115250P1  Silicon.  CO11, RF: 680 \( \mu h \) ±10%, 12 ohms DC res max;  sim to Delevan 3500 Series.	27	7486445P6	Electrolytic, non polarized: 2 μf +100% -10%, 200 VDCW.
thru C31  C32  19A116080P1  Polyester: 0.01 µf ±20%, 50 VDCW.  Polyester: 0.01 µf ±20%, 50 VDCW.  Polyester: 0.01 µf ±20%, 50 VDCW.  CR1  thru CR35  CR41  19A115250F1  Silicon.  CR42  thru CR45  CR44  4037822P2  Silicon.  CR48  CR49  19A115250P1  Silicon.  CR49  19A115250P1  Silicon.  CR40  CR41  19A115250P1  Silicon.  CR41  19A115250P1  Silicon.  CR42  CR43  CR44  CR49  19A115250P1  Silicon.  CR45  CR49  19A115250P1  Silicon.  CR40  CR40  CR41  19A115250P1  Silicon.  CR41  CR41  19A115250P1  Silicon.  CR42  CR49  19A115250P1  Silicon.  CR41  CR41  Thru CR51  CR42  Silicon.  CR43  CR49  19A115250P1  Silicon.  CR44  CR49  19A115250P1  Silicon.  CR41  CR41  Silicon.  CR42  CR49  19A115250P1  Silicon.  CR41  CR41  Thru CR51  CR42  Silicon.  CR42  CR49  IPACTORS	C28	5496267P10	Tantalum: 22 μf ±20%, 15 VDCW; sim to Sprague Type 150D.
C34 and C35 Polyester: 0.01 µf ±20%, 50 VDCW.  CR1 thru CE36 Silicon.  CR41 19Al15250F1 Silicon.  CR42 19Al16642P1 Thyristor, silicon controlled: sim to Type 2N506 CR45 CR46 4037822P2 Silicon.  CR48 CR49 19Al15250P1 Silicon.  CR49 thru CR51 Coil, RF: 680 µh ±10%, 12 ohms DC res max; sim to Delevan 3500 Series.	thru	19A115028P414	Polyester: 0.1 μf ±5%, 200 VDCW.
CR1 thru CR35  CR41 19Al15250F1 Silicon.  CR42 19Al1642P1 Thyristor, silicon controlled: sim to Type 2N506  CR45 CR46 4037822P2 Silicon.  CR48 CR49 19Al15250P1 Silicon.  CR51	C32	19A116080P1	Polyester: 0.01 µf ±20%, 50 VDCW.
CR1 thru CR26	and	19A116080P1	Polyester: 0.01 µf ±20%, 50 VDCW.
thru         CR26           CR41         19Al15250Pl         Silicon.           CR42         19Al16642Pl         Thyristor, silicon controlled: sim to Type 2N506           CR45         4037822P2         Silicon.           CR46         4037822P2         Silicon.           CR49         19Al15250Pl         Silicon.           Ll         7491382Pl06         Coil, RF: 680 µh ±10%, 12 ohms DC res max; sim to Delevan 3500 Series.			DIODES AND RECTIFIERS
CR42 thru CR45	thru	19A115250F1	Silicon.
thru CR45 CR46 thru CR48 thru CR48  CR49 thru CR51  7491382P106  Coil, RF: 680 µh ±10%, 12 ohms DC res max; sim to Delevan 3500 Series.	CR41	19A115250P1	Silicon.
thru CR48 CR48 19Al15250Pl Silicon. INDUCTORS Ll 7491382Pl06 Coil, RF: 680 µh ±10%, 12 ohms DC res max; sim to Delevan 3500 Series.	thru	19A116642P1	Thyristor, silicon controlled: sim to Type 2N506
thru CR51  INDUCTORS	thru	4037822P2	Silicon.
Coil, RF: 680 µh ±10%, 12 ohms DC res max; sim to Delevan 3500 Series.	thru	19A115250P1	Silicon.
Coil, RF: 680 µh ±10%, 12 ohms DC res max; sim to Delevan 3500 Series.			
P3 and P4 (Part of printed wiring board).	.1	7491382P106	
and P4			
Q1 19A115889P1 Silicon, NPN; sim to Type 2N2712. Q12 19A116774P1 Silicon, NPN; sim to Type 2N5210. Q15	ind		(Part of printed wiring board).
thru ql1   19Al16774P1   Silicon, NPN; sim to Type 2N5210.			
thru Q15	thru	19A115889P1	Silicon, NPN; sim to Type 2N2712.
	thru	19A116774P1	Silicon, NPN; sim to Type 2N5210.
· · · · · · · · · · · · · · · · · · ·		19A129183P1	Silicon, NPN.

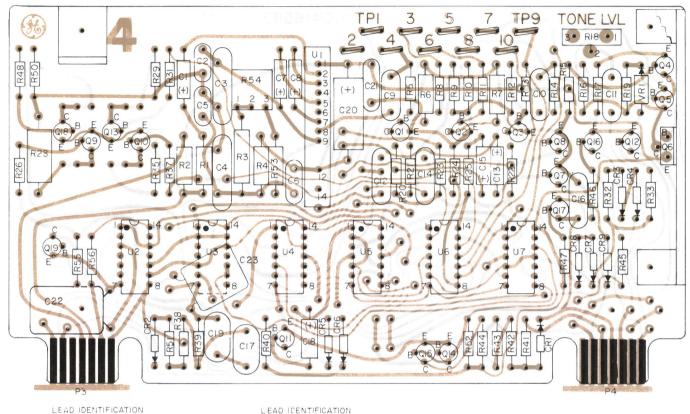
	SYMBOL	GE PART NO.	DESCRIPTION
	Q17 thru Q19	19A115889P1	Silicon, NPN; sim to Type 2N2712.
_	Rl thru R7	3R152P102J	RESISTORS
	R8 thru R14	3R152P302J	Composition: 3000 ohms ±5%, 1/4 w.
	R15 thru R19	3R152P272J	Composition: 2700 ohms ±5%, 1/4 w.
	R20 thru R25	3R152P203J	Composition: 20,000 ohms ±5%, 1/4 w.
۱	R26	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.
	R27	3R77P302J	Composition: 3000 ohms ±5%, 1/2 w.
	R28	3R152P332J	Composition: 3300 ohms ±5%, 1/4 w.
	R29	3R152P101J	Composition: 100 ohms ±5%, 1/4 w.
1	R30*	3R152P203J	Composition: 23,000 ohms ±5%, 1/4 w.
1			Earlier than REV A:
		3R152P273J	Composition: 27,000 ohms ±5%, 1/4 w.
	R31	3R152P470J	Composition: 47 ohms ±5%, 1/4 w.
	R32	3R77P104J	·
	R33 and R34	3R77P241J	Composition: 0.1 megohm ±5%, 1/2 w.  Composition: 240 ohms ±5%, 1/2 w.
	R35	19B209358P105	Variable, carbon film: approx 75 to 5000 chms ±10%, 0.25 w; sim to CTS Type X-201.
	R36	19B209358P104	Variable, carbon film: approx 50 to 2500 ohms ±10%, 0.2 w; sim to CTS Type X-201.
	R37	19B209358P103	Variable, carbon film: approx 25 to 1000 ohms ±10%, 0.2 w; sim to CTS Type X-201.
	R38 and R39	3R152P332J	Composition: 3300 ohms ±5%, 1/4 w.
	R40 and R41	3R152P203J	Composition: 20,000 ohms ±5%, 1/4 w.
_	R42 and R43	3R152P333J	Composition: 33,000 ohms ±5%, 1/4 w.
	R44	3R152P103J	Composition: 10,000 ohms $\pm 5\%$ , 1/4 w.
	R45	3R152P562J	Composition: 5600 ohms ±5%, 1/4 w.
	R46	3R152P122J	Composition: 1200 ohms ±5%, 1/4 w.
64.	R47	3R152P105J	Composition: 1 megohm ±5%, 1/4 w.
	R48 thru R52	3R152P272J	Composition: 2700 ohms ±5%, 1/4 w.
	T1	19B219562G1	Coil.
_	T2 thru T4	19B219563G1	Coil,
	T5 and T6	19B219564G1	Coil.
			VOLTAGE REGULATORS
	VRl	4036887P5	Silicon, Zener.
	VR2	4036887P3	Silicon, Zener.
		10001050	MISCELLANEOUS
		19B219561P1	Heat sink. (Used with Q16).
		19A116022P1	Insulator bushing. (Used with Q16).
		19A116023P1	Insulator, plate. (Used with Q16).

## \*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

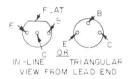
#### **PRODUCTION CHANGES**

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

Rev. A - To increase oscillator output. Changed R30.

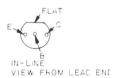


LEAD IDENTIFICATION FOR Q7 THRU Q19, Q4 & Q5

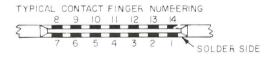


NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

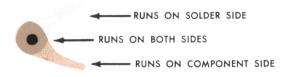
LEAD ICENTIFICATION FOR QI,Q2 & Q3



NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION

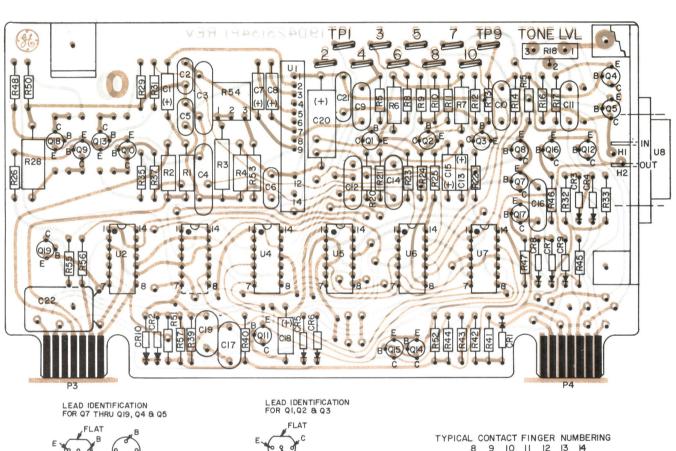


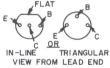
(19D417316, Rev. 2) (19D416583, Sh. 2, Rev. 4) (19D416583, Sh. 3, Rev. 4)



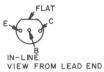
#### **OUTLINE DIAGRAM**

TONE CONTROL BOARD 19D416597G1





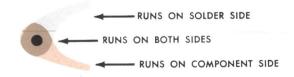
NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.



NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

(19D423135, Rev. 0) (19D423134, Sh. 2, Rev. 0) (19D423134, Sh. 3, Rev. 0)

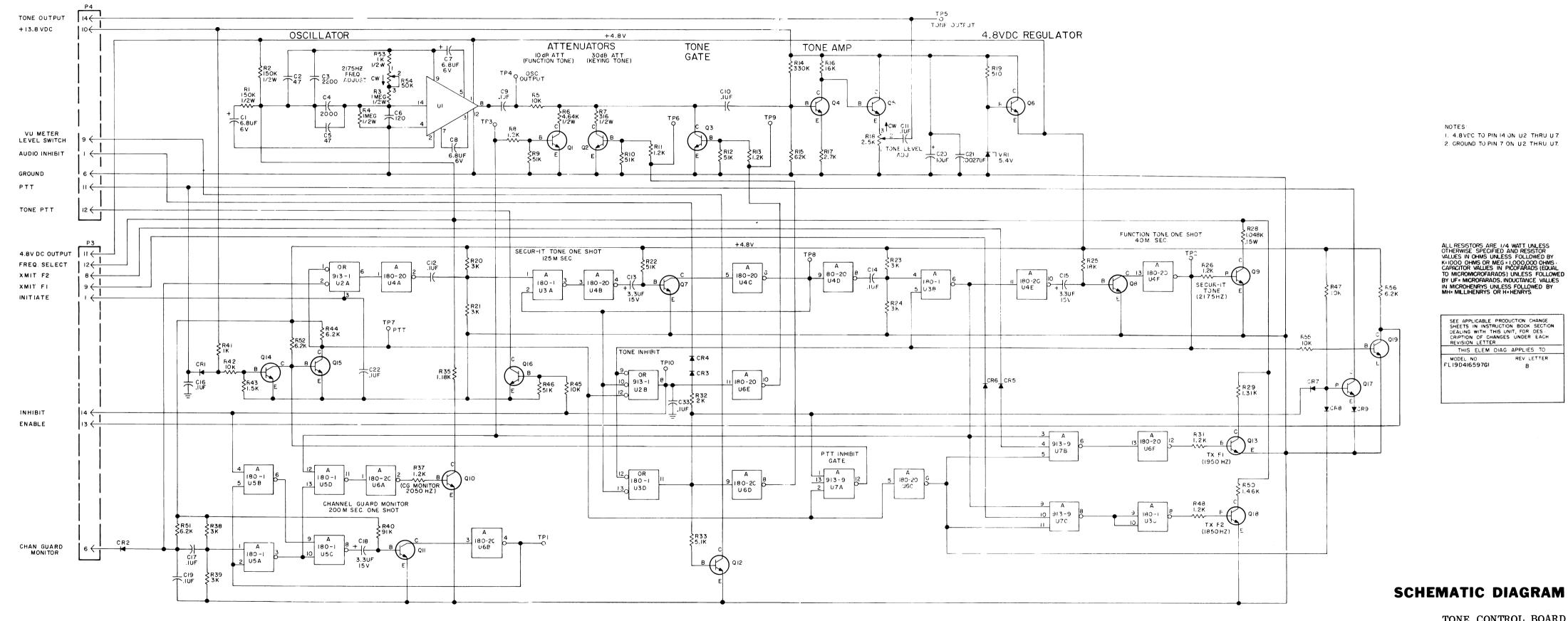




## **OUTLINE DIAGRAM**

TONE CONTROL BOARD 19D416597G2

44 Issue 1



TONE CONTROL BOARD 19D416597G1

LBI-4478

## PARTS LIST LBI-4464B TONE CONTROL BOARD 19D416597G1

SYMBOL	GE PART NO.	DESCRIPTION
C1	5496267P1	Tantalum: 6.8 µf ±20%, 6 VDCW; sim to Sprague Type 150D.
C2	5496219P855	Ceramic disc: 47 pf ±5%, 500 VDCW, temp coef -1500 PPM.
C3 and C4	5491871P2200E	Mica: 2200 pf ±1/2%, 300 VDCW; sim to Electro Motive Type DM-20.
C5	5496219P855	Ceramic disc: 47 pf ±5%, 500 VDCW, temp coef -1500 PPM.
C6	7489162P29	Silver mica: 120 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C7 and C8	5496267P1	Tantalum: 6.8 μf ±20%, 6 VDCW; sim to Sprague Type 150D.
C9 thru C12	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C13	5496267P409	Tantalum: 3.3 µf ±5%, 15 VDCW; sim to Sprague Type 150D.
C14	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C15	5496267P409	Tantalum: 3.3 µf ±5%, 15 VDCW; sim to Sprague Type 150D.
C16 and C17	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C18	5496267P409	Tantalum: 3.3 µf ±5%, 15 VDCW; sim to Sprague Type 150D.
C19	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C20	19A115680P8	Electrolytic: 10 µf +150% -10%, 25 VDCW; sim to Mallory Type TT.
C21	5494481P27	Ceramic disc: 2700 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C22*	19A116080P107	Polyester: .1 µf ±10%, 50 VDCW. Added by REV A.
C23*	19A116080P107	Polyester: .1 µf ±10%, 50 VDCW. Added by REV B.
		DIODES AND RECTIFIERS
CR1 thru CR9	19A115250P1	Silicon.
P3 and P4		(Part of printed wiring board).
		TRANSISTORS
Q1 thru Q3	19A115910P1	Silicon, NPN; sim to Type 2N3906.
Q4 and Q5	19A115889P1	Silicon, NPN; sim to Type 2N2712.
Q6	19Al16118P1	Silicon, NPN.
Q7 and Q8	19A115889P1	Silicon, NPN; sim to Type 2N2712.
Q9 and Q10	19A129207P1	Silicon, NPN.
Q11 and Q12	19All5889Pl	Silicon, NPN; sim to Type 2N2712.
<b>Q13</b>	19A129207P1	Silicon, NPN.

	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
	Q14 thru Q17	19A115889P1	Silicon, NPN; sim to Type 2N2712.	R53 R54	19A116278P201 19A116559P108	Metal film: 1000 ohms ±2%, 1/2 w. Variable, cermet: 50,000 ohms ±20%, .5 w; sim to
	Q18	19A129207P1	Silicon, NPN.	255	3R152P103J	CTS Series 360.  Composition: 10,000 ohms ±5%, 1/4 w.
	Q19	19All5889Pl	Silicon, NPN; sim to Type 2N2712.	R55 R56	3R152P1033 3R152P622J	Composition: 6200 ohms ±5%, 1/4 w.
$\neg$				RSO	3R132F0220	composition. O200 onmo 20%, 1/1 w.
		1041160500410				
긕	R1 and	19A116278P418	Metal film: 0.15 megohm ±2%, 1/2 w.	TP1 thru	19B211379P1	Spring (Test Point).
	R2	19A116624P1	Metal film: 1 megohm ±0.1%, 1/2 w.	TP10	,	
_	R3	19A116024P1 19A116278P501	Metal film: 1 megohm ±2%, 1/2 w.			INTEGRATED CIRCUITS
	R4 R5	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.	U1	19D416410G1	Audio Oscillator.
ı	R6	19A116278P265	Metal film: 4640 ohms ±2%, 1/2 w.	U2	19A115913P1	Digital, Dual 4-Input Gate; sim to Fairchild DTL 930.
	R7	19A116278P149	Metal film: 316 ohms ±2%, 1/2 w.	บ3	19A116180P1	Digital, Quad 2-Input Nand Gate; sim to Texas
	R8	3R152P122J	Composition: 1200 ohms ±5%, 1/4 w.			Instrument Type SN7400N.
	R9	3R152P513J	Composition: 51,000 ohms ±5%, 1/4 w.	U4	19A116180P20	Digital, Hex Inverter; sim to Texas Instrument Type SN7404N.
	and R10			<b>U</b> 5	19All6180Pl	Digital, Quad 2-Input Nand Gate; sim to Texas Instrument Type SN7400N.
	Rll	3R152P122J	Composition: 1200 ohms ±5%, 1/4 w.	U6	19A116180P20	Digital, Hex Inverter; sim to Texas Instrument
	R12	3R152P513J	Composition: 51,000 ohms ±5%, 1/4 w.	U7	19A115913P9	Type SN7404N.  Digital, Triple 3-Input Gate; sim to Fairchild
	R13	3R152P122J	Composition: 1200 ohms ±5%, 1/4 w.	"'	19411391349	DTL 962.
	R14	3R152P334J	Composition: 0.33 megohm ±5%, 1/4 w.	11		
	R15 R16	3R152P623J 3R152P163J	Composition: 62,000 ohms ±5%, 1/4 w.	VRl	4036887P5	Silicon, Zener.
	R17	3R152P163J 3R152P272J	Composition: 16,000 ohms ±5%, 1/4 w.			
	R18	19B209358P104	Composition: 2700 ohms ±5%, 1/4 w.  Variable, carbon film: approx 50 to 2500 ohms			MISCELLANEOUS
			±10%, 0.2 w; sim to CTS Type X-201.		19B219561P1	Heat sink. (Used with Q6).
- 1	R19	3R152P511J	Composition: 510 ohms $\pm 5\%$ , $1/4$ w.	1	19A116022P1	Insulator bushing. (Used with Q6).
	R20 and R21	3R152P302J	Composition: 3000 ohms ±5%, 1/4 w.		19A116023P1	Insulator, plate. (Used with Q6).
	R22	3R152P513J	Composition: $51,000$ ohms $\pm 5\%$ , $1/4$ w.	1		
	R23 and	3R152P302J	Composition: 3000 ohms ±5%, 1/4 w.			
- 1	R24			1 1		
. ]	R25	3R152P183J	Composition: 18,000 ohms $\pm 5\%$ , 1/4 w.			
	R26 R28	3R152P122J	Composition: 1200 ohms ±5%, 1/4 w.			
A.	1 120	19A116690P1048	Wirewound: $1048$ ohms $\pm 0.1\%$ , $0.15$ w; sim to Mills Type MR-100-2A.			
В.	R29	19C314256P21311	Metal film: 1311 ohms $\pm 1\%$ , $1/4$ w.	1		
-	R31	3R152P122J	Composition: 1200 ohms $\pm 5\%$ , 1/4 w.	i I		
	R32	3R152P202J	Composition: 2000 ohms $\pm 5\%$ , $1/4$ w.	11		
	R33	3R152P512J	Composition: 5100 ohms $\pm 5\%$ , $1/4$ w.	11		
-	R35	19C314256P21181	——————————————————————————————————————	11		
	R37	3R152P122J 3R152P302J	Composition: 1200 ohms ±5%, 1/4 w.	11		
	R38 and R39	3R152P302J	Composition: 3000 ohms ±5%, 1/4 w.			
	R40	3R152P913J	Composition: 91,000 ohms ±5%, 1/4 w.			
	R41	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.	11		
	R42	3R152P103J	Composition: 10,000 ohms $\pm 5\%$ , 1/4 w.	11		
1	R43	3R152P152J	Composition: 1500 ohms ±5%, 1/4 w.	11		'
	R44	3R152P622J	Composition: 6200 ohms ±5%, 1/4 w.			
	R45	3R152P103J	Composition: 10,000 ohms $\pm 5\%$ , 1/4 w.			
	R46	3R152P513J	Composition: 51,000 ohms ±5%, 1/4 w.			
	R47	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.			
	R48	3R152P122J	Composition: 1200 ohms ±5%, 1/4 w.			
	R50 R51	19C314256P21461				
	and R52	3R152P622J	Composition: 6200 ohms ±5%, 1/4 w.			
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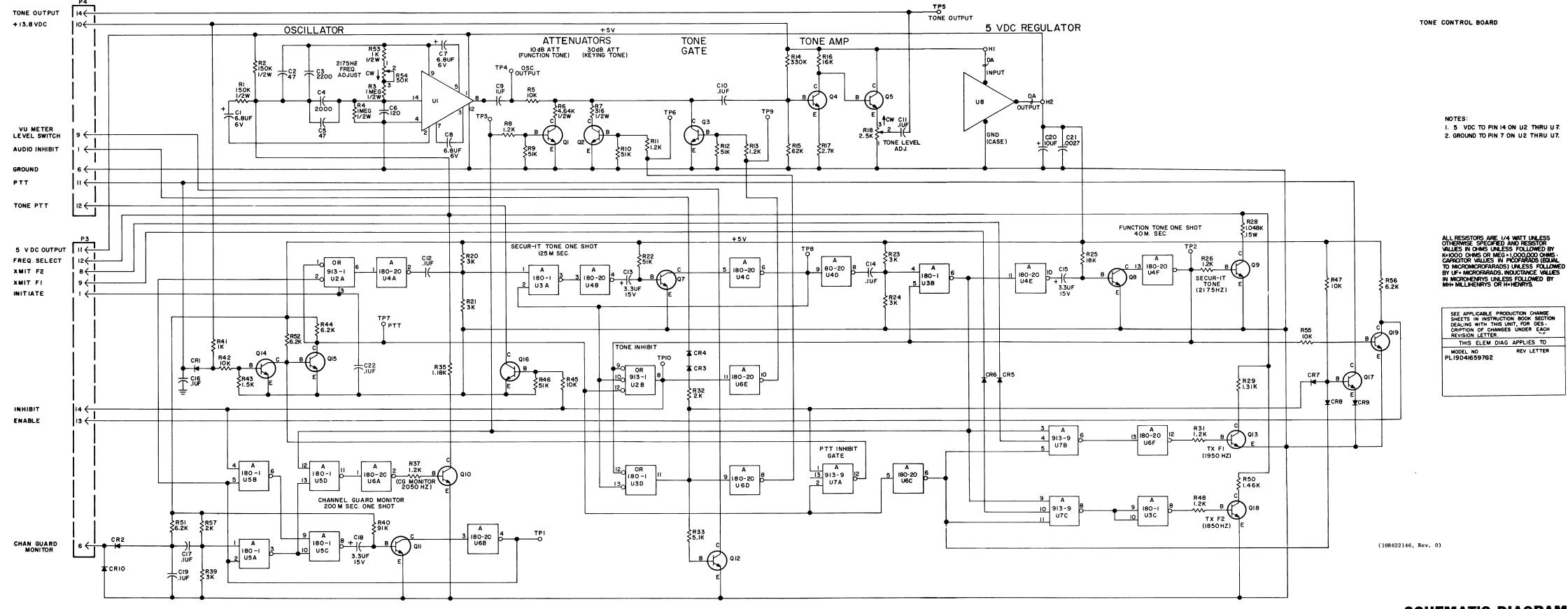
\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.

## **PRODUCTION CHANGES**

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

REV. A (19D416597G1) - To improve oscillation performance in the Tone Control System when the Tone Control Modules are mounted on the Extender Board. Added a by-pass capacitor (C22) between pin 3 of U2-A and ground (pin 7).

REV. B (19D416597G1) - To prevent Falsing of Tone Control function module. Added C23.

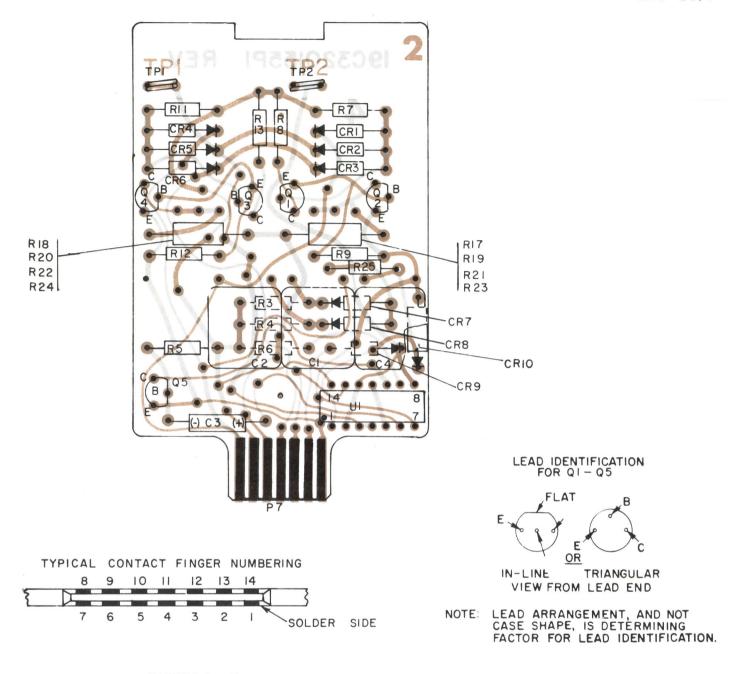


## SCHEMATIC DIAGRAM

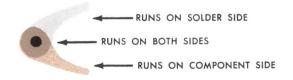
TONE CONTROL BOARD 19D416597G2

		LBI-4864					1	
		TONE CONTROL BOARD	Rl	19A116278P418	RESISTORS Metal film: 0.15 megohm ±2%, 1/2 w.	mp1	10001127001	TEST POINTS
		19D416597G2	and R2	1941102767416	metal IIIm: 0.13 megonm 12%, 1/2 w.	TP1 thru TP10	19B211379P1	Spring (Test Point).
			R3	19A116624P1	Metal film: 1 megohm $\pm 0.1\%$ , $1/2$ w.	1710		
	T		R4	19A116278P501	Metal film: 1 megohm $\pm 2\%$ , $1/2$ w.	Ul	19D416410G1	Audio Oscillator.
SYMBOL	GE PART NO.	DESCRIPTION	R5	3R152P103J	Composition: 10,000 ohms $\pm 5\%$ , 1/4 w.	U2	19A115913P1	Digital, Dual 4-Input Gate; sin
	<b>.</b>		R6	19A116278P265	Metal film: 4640 ohms $\pm 2\%$ , $1/2$ w.	,,,	1041161800	DTL 930.
			R7	19A116278P149	Metal film: 316 ohms $\pm 2\%$ , $1/2$ w.	U3	19A116180P1	Digital, Quad 2-Input Nand Gate Instrument Type SN7400N.
C1	5496267P1	Tantalum: 6.8 µf ±20%, 6 VDCW; sim to Sprague	R8	3R152P122J	Composition: 1200 ohms $\pm 5\%$ , 1/4 w.	U4	19A116180P20	Digital, Hex Inverter; sim to Type SN7404N.
C2	5496219P855	Type 150D.  Ceramic disc: 47 pf ±5%, 500 VDCW, temp coef	R9 and R10	3R152P513J	Composition: 51,000 ohms $\pm 5\%$ , $1/4$ w.	U5	19A116180P1	Digital, Quad 2-Input Nand Gate
		-1500 PPM.	R11	3R152P122J	Composition: 1200 ohms $\pm 5\%$ , $1/4$ w.	U6	19A116180P20	Instrument Type SN7400N.  Digital, Hex Inverter; sim to
c3 and c4	5491871P2200E	Mica: 2200 pf ±1/2%, 300 VDCW; sim to Electro Motive Type DM-20.	R12	3R152P513J	Composition: 51,000 ohms $\pm 5\%$ , $1/4$ w.			Type SN7404N.
C5	5496219P855	Ceramic disc: 47 pf ±5%, 500 VDCW, temp coef	R13	3R152P122J	Composition: 1200 ohms $\pm 5\%$ , $1/4$ w.	U7	19A115913P9	Digital, Triple 3-Input Gate; DTL 962.
		-1500 PPM.	R14	3R152P334J	Composition: 0.33 megohm $\pm 5\%$ , 1/4 w.	U8	19A116834P1	Linear: 5 Volt Regulator; sim
C6	7489162P29	Silver mica: 120 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.	R15	3R152P623J	Composition: $62,000$ ohms $\pm 5\%$ , $1/4$ w.			VOLTAGE REGULA
C7	5496267P1	Tantalum: 6.8 µf ±20%, 6 VDCW; sim to Sprague Type 150D.	R16	3R152P163J	Composition: 16,000 ohms ±5%, 1/4 w.	VR1	4036887P5	Silicon, Zener.
C8		Type 130D.	R17	3R152P272J 19B209358P104	Composition: 2700 ohms $\pm 5\%$ , $1/4$ w.  Variable, carbon film: approx 50 to 2500 ohms			
C9 thru	19A116080P107	Polyester: 0.1 μf ±10%, 50 VDCW.		1352030001101	±10%, 0.2 w; sim to CTS Type X-201.			
C12			R20 and	3R152P302J	Composition: 3000 ohms $\pm 5\%$ , $1/4$ w.			
C13	5496267P409	Tantalum: 3.3 μf ±5%, 15 VDCW; sim to Sprague Type 150D.	R21	0-150-510-	53 000 1 155 374			1
C14	19A116080P107	Polyester: 0.1 μf ±10%, 50 VDcw.	R22 R23	3R152P513J 3R152P302J	Composition: 51,000 ohms $\pm 5\%$ , $1/4$ w.  Composition: 3000 ohms $\pm 5\%$ , $1/4$ w.			
C15	5496267P409	Tantalum: 3.3 μf ±5%, 15 VDCW; sim to Sprague Type 150D.	and R24	3R132F3020	Composition. 3000 Olms 15%, 1/4 w.			
C16 and	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.	R25	3R152P183J	Composition: 18,000 ohms $\pm 5\%$ , $1/4$ w.			
C17			R26	3R152P122J	Composition: 1200 ohms $\pm 5\%$ , $1/4$ w.			
C18	5496267P409	Tantalum: 3.3 μf ±5%, 15 VDCW; sim to Sprague Type 150D.	R28	19A116690P1048	Wirewound: $1048$ ohms $\pm 0.1\%$ , $0.15$ w; sim to Mills Type MR-100-2A.			
C19	19A116080P107	Polyester: 0.1 μf ±10%, 50 VDcW.	R29	19C314256P21311	Metal film: 1311 ohms $\pm 1\%$ , $1/4$ w.			
C20	19A115680P8	Electrolytic: 10 µf +150% -10%, 25 VDCW; sim to Mallory Type TT.	R31	3R152P122J	Composition: 1200 ohms $\pm 5\%$ , $1/4$ w.			
C21	5494481P27	Ceramic disc: 2700 pf ±20%, 1000 VDCW; sim to	R32	3R152P202J	Composition: 2000 ohms $\pm 5\%$ , $1/4$ w.			
C22	19A116080P107	RMC Type JF Discap.	R33	3R152P512J	Composition: 5100 ohms ±5%, 1/4 w.			
"22	ISAITOGOPIO?	Polyester: .1 μf ±10%, 50 VDCW.	R35 R37	19C314256P21181 3R152P122J	Metal film: 1180 ohms ±1%, 1/4 w.  Composition: 1200 ohms ±5%, 1/4 w.			
		DIODES AND RECTIFIERS	R39	3R152P302J	Composition: 3000 ohms ±5%, 1/4 w.			
thru	19A115250P1	Silicon.	R40	3R152P913J	Composition: 91,000 ohms ±5%, 1/4 w.			
CR10			R41	3R152P102J	Composition: 1000 ohms $\pm 5\%$ , $1/4$ w.			
P4		(Part of printed wiring board 19D416583P1).	R42	3R152P103J	Composition: 10,000 ohms $\pm 5\%$ , $1/4$ w.			
		(table of princed and and abbrecher;	R43	3R152P152J	Composition: 1500 ohms $\pm 5\%$ , $1/4$ w.			
1			R44	3R152P622J	Composition: 6200 ohms $\pm 5\%$ , $1/4$ w.			
Q1 thru Q3	19A115910P1	Silicon, NPN; sim to Type 2N3906.	R45	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.			
94	19A115889P1	Silicon, NPN; sim to Type 2N2712.	R46 R47	3R152P513J 3R152P103J	Composition: 51,000 ohms ±5%, 1/4 w.  Composition: 10,000 ohms ±5%, 1/4 w.			
and Q5			R48	3R152P122J	Composition: 1200 ohms ±5%, 1/4 w.			
Q7	19A115889P1	Silicon, NPN; sim to Type 2N2712.	R50	19C314256P21461	Metal film: 1460 ohms ±1%, 1/4 w.			
and Q8			R51	3R152P622J	Composition: 6200 ohms $\pm 5\%$ , $1/4$ w.			}
Q9 and	19A129207P1	Silicon, NPN.	and R52					
Q10			R53	19A116278P201	Metal film: 1000 ohms $\pm 2\%$ , $1/2$ w.			
Q11 and Q12	19A115889P1	Silicon, NPN; sim to Type 2N2712.	R54	19A116559P108	Variable, cermet: 50,000 ohms $\pm 20\%$ , .5 w; sim t CTS Series 360.	<b> </b>		
Q12	19A129207P1	Silicon, NPN.	R55	3R152P103J	Composition: 10,000 ohms $\pm 5\%$ , 1/4 w.			
Q14	19A115889P1	Silicon, NPN; sim to Type 2N2712.	R56	3R152P622J	Composition: 6200 ohms $\pm 5\%$ , $1/4$ w.			
thru Q17			R57	3R152P202J	Composition: 2000 ohms $\pm 5\%$ , $1/4$ w.			
Q18	19A129207P1	Silicon, NPN.	1					
Q19	19A115889P1	Silicon, NPN; sim to Type 2N2712.						
1								
4	i	1		. 1			1	i

LBI-4478 GE PART NO. SYMBOL | GE PART NO. DESCRIPTION DESCRIPTION PARTS LIST NTS - - - - - - -RCUITS - - - - - sim to Fairchild Gate; sim to Texas to Texas Instrument Gate; sim to Texas to Texas Instrument te; sim to Fairchild sim to  $\mu A209K$ . GULATORS - - - - - -\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.

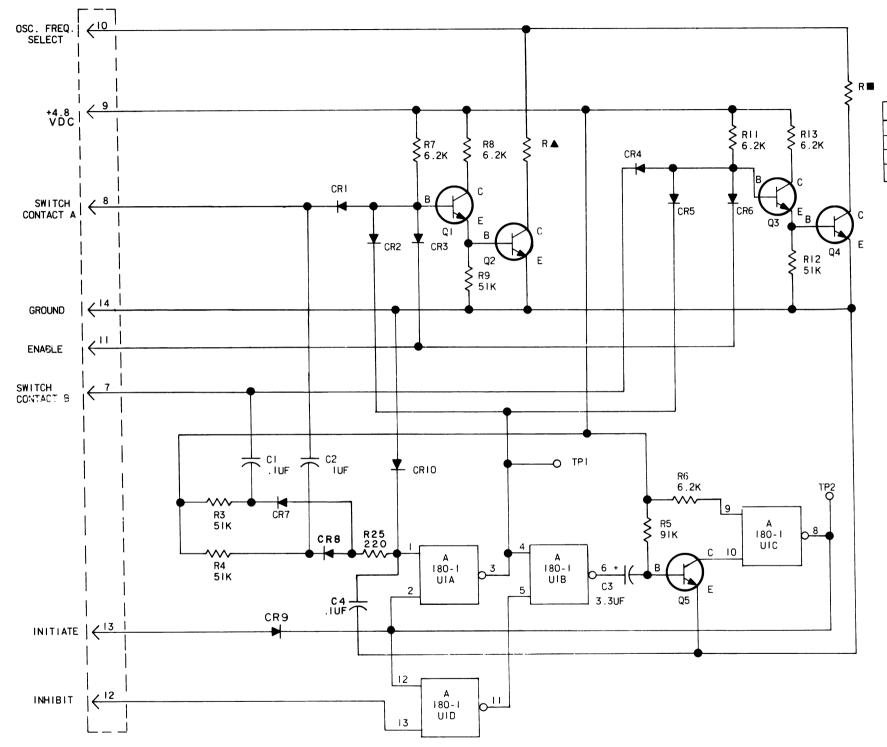


(19C320715, Rev. 1) (19C320155, Sh. 2, Rev. 4) (19C320155, Sh. 3, Rev. 2)



## **OUTLINE DIAGRAM**

TONE CONTROL FUNCTION BOARD 19C320182G1-G4



FREQHR.	R ▲	VALUE	R■	VALÜE
1750/1650	RI7	1630	RI8	1840
1550/1450	RI9	2100	R20	2410
1350/1250	R21	2790	R22	3290
1150/1050	R23	3910	R24	4740
	1750/1650 1550/1450 1350/1250	1750/1650 R17 1550/1450 R19 1350/1250 R21	1750/1650 R17 1630 1550/1450 R19 2100 1350/1250 R21 2790	1750/1650   R17   1630   R18   1550/1450   R19   2100   R20   1350/1250   R21   2790   R22

ALL RESISTORS ARE 1/4 WATT UNLESS
OTHERWISE SPECIFIED AND RESISTOR
VALUES IN OHMS UNLESS FOLLOWED BY
K=1000 OHMS OR MEG = 1,000,000 OHMS OCAPACITOR VALUES IN PICOFARADS (EQUAL
TO MICROMICROFARADS) UNLESS FOLLOWED
BY UF = MICROFARADS. INDUCTANCE VALUES
IN MICROHENRYS UNLESS FOLLOWED BY
MH= MILLIHENRYS OR H=HENRYS.

IN ORDER TO RETAIN RATED EQUIPMENT PERFORMANCE, REPLACEMENT OF ANY SERVICE PART SHOULD BE MADE ONLY WITH A COMPONENT HAVING THE SPECIFICATIONS SHOWN ON THE PARTS LIST FOR THAT PART.

SEE APPLICABLE PR SHEETS IN INSTRUC DEALING WITH THIS CRIPTION OF CHANG REVISION LETTER.	TION BOOK SECTION UNIT, FOR DES-
THIS ELEM DIA	G APPLIES TO
MODEL NO	REV LETTER
PL19C320182G1	Α
PL19C320182G2	Α
PL19C320182G3	A
PL19C320I82G4	Α

NOTE: PIN 7 ON U TO GND. PIN 14 ON U TO +4.8V

## SCHEMATIC DIAGRAM

TONE CONTROL FUNCTION MODULE 19C320182G1-G4

(19C320238, Rev. 5)

#### PARTS LIST

LBI-4459A

TONE FUNCTION MODULE 19C320182G1-G4

SYMBOL	GE PART NO.	DESCRIPTION
C1 and C2	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDcW.
C3	5496267P409	Tantalum: 3.3 μf '±5%, 15 VDCW; sim to Sprague Type 150D.
C4	19A116080P107	Polyester: 0.1 μf ±10%, 50 VDcW.
C5*	19A116080P107	Polyester: 0.1 $\mu f$ ±10%, 50 VDCW. Deleted by REV A.
CR1 thru CR9	19A115250P1	DIODES AND RECTIFIERS
CR10	4037822P1	Silicon.
1		
P7		(Part of printed wiring board 190320155P1).
Q1	19A115889P1	Silicon, NPN; sim to Type 2N2712.
Q2	19A129207P1	Silicon, NPN.
Q3	19A115889P1	Silicon, NPN; sim to Type 2N2712.
Q4	19A129207P1	Silicon, NPN.
Q5	19A115889P1	Silicon, NPN; sim to Type 2N2712.
R3 and R4	3R152P513J	Composition: 51,000 ohms $\pm 5\%$ , $1/4$ w.
R5	3R152P913J	Composition: 91,000 ohms ±5%, 1/4 w.
R6 thru R8	3R152P622J	Composition: 6200 ohms $\pm 5\%$ , $1/4$ w.
R9	3R152P513J	Composition: $51,000$ ohms $\pm 5\%$ , $1/4$ w.
R11	3R152P622J	Composition: 6200 ohms $\pm 5\%$ , $1/4$ w.
R12	3R152P513J	Composition: $51,000$ ohms $\pm 5\%$ , $1/4$ w.
R13	3R152P622J	Composition: 6200 ohms $\pm 5\%$ , $1/4$ w.
R17	19C314256P21631	Metal film: 1630 ohms $\pm 1\%$ , $1/4$ w.
R18	19C314256P21841	Metal film: 1840 ohms $\pm 1\%$ , $1/4$ w.
R19	19C314256P22101	Metal film: 2110 ohms $\pm 1\%$ , $1/4$ w.
R20	19C314256P22411	Metal film: 2410 ohms $\pm 1\%$ , $1/4$ w.
R21	19C314256P22791	Metal film: 2790 ohms $\pm 1\%$ , $1/4$ w.
R22	19C314256P23291	Metal film: 3290 ohms $\pm 1\%$ , $1/4$ w.
R23	19C314256P23911	Metal film: 3910 ohms $\pm 1\%$ , $1/4$ w.
R24 R25*	19C314256P24741 3R152P221J	Metal film: $4740$ ohms $\pm 1\%$ , $1/4$ w.  Composition: $220$ ohms $\pm 5\%$ , $1/4$ w. Added by REV A.
		TEST POINTS
TP1 and TP2	19B211379P1	Spring (Test Point).
נט	19A116180P1	INTEGRATED CIRCUITS Digital, Quad 2-Input Nand Gate; sim to Texas Instrument Type SN7400N.

**52** 

## **PRODUCTION CHANGES**

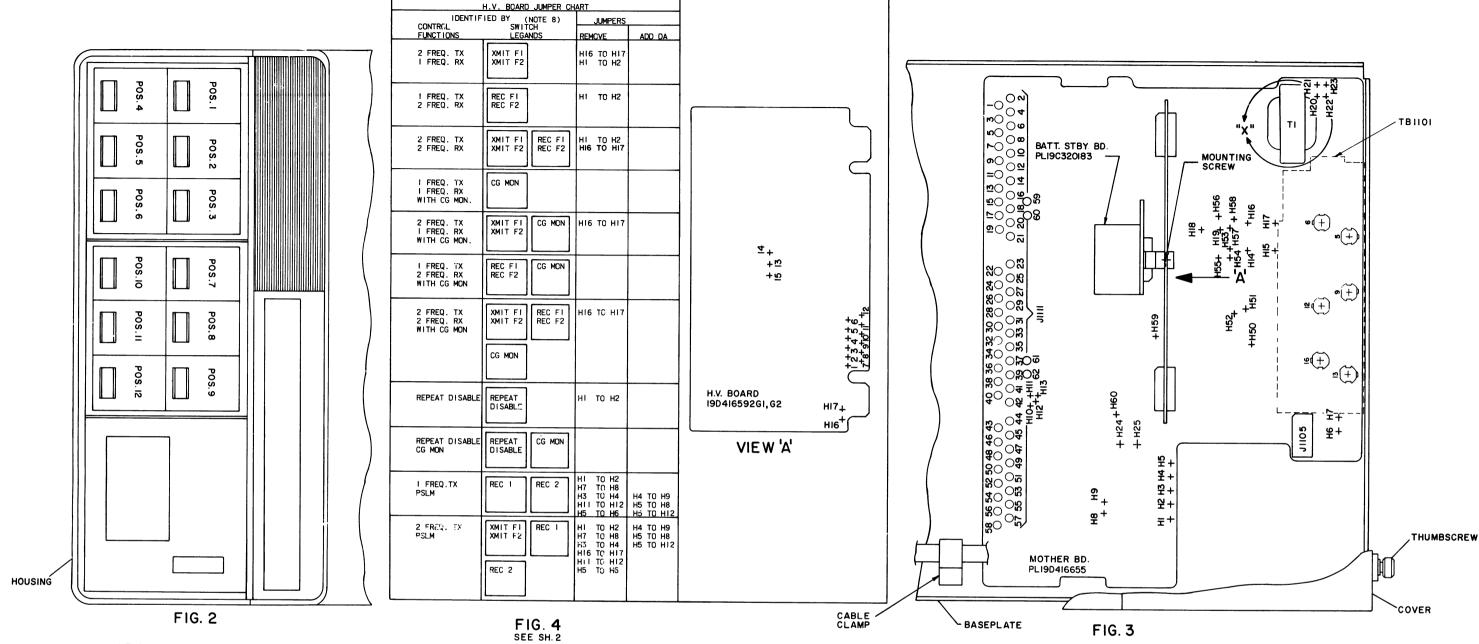
Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

Rev. A - To reduce the probablity of sending false tones due to switch bounce and other noise sources. Deleted C5 and added R25. Relocated C4.

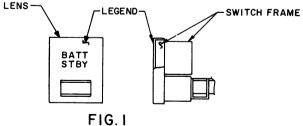
NOTE ---

Revision "A" of Tone Control Function Modules is compatible with Tone Control Board 19D41659761 or G2. Boards with no revision (before Rev. A) are not compatible with Tone Control Board 19D416597G2.

<sup>\*</sup>COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES



FOR DC CONTROL ONLY



INSTRUCTIONS(FOR FIG.1)

- 1. SNAP CFF (REMOVE) LENS FROM SWITCH FRAME.
  2. PLACE LEGEND ON SWITCH FRAME ORIENTED AS SHOWN.
- REPLACE LENS

#### INSTALLATION INSTRUCTIONS

- I. LOOSEN THUMBSCREWS ON REAR OF UNIT AND REMOVE COVER.
- REMOVE 4-#8 SCREWS FROM BASEPLATE AND REMOVE HOUSING FROM BASEPLATE.
- 3. INSTALL SWITCH LEGEND AS SHOWN IN TABULATION AND IN FIG. I (NOTE-COMBINATION OF SWITCH LEGEND AND SWITCH GR. NU., SEE TABULATION ON SH. #2, DETERMINES WIRING CONNECTIONS FOR SWITCH MODULE).
- 4. INSTALL SWITCH MODULE IN HOUSING AS SHOWN IN TABULATION AND FIG. 2. (REMOVE SWITCH DUMMY, IF PRESENT, AND RETURN TO STOCK)
- MAKE CONNECTIONS AS SHOWN IN TABULATION. ROUTE WIRES TO JIIII THRU CABLE CLAMPS SHOWN IN FIG. 2, AND IN HOUSING. SPOT TIE TO EXISTING WIRING.
- 6. MAKE OTHER MODIFICATIONS TO UNIT, IF REQUIRED, AS LISTED IN "P.W. BOARD MODIFICATIONS" COLUMN OF TABULATION.
- 7. REASSEMBLE UNIT.
- SELECT THE BLOCK OF SWITCH COMBINATIONS THAT MATCHES THE CUSTOMER UNIT. (ONLY ONE BLOCK PER UNIT SHOULD BE USED)

(19D416690, Sh. 1, Rev. 6)

THESE INSTRUCTIONS COVER THE INSTALLATION OF SWITCH ASSEMBLY PLI90416628, 190417189 AND PLI9C320717. LEGEND NP270751, NP276388 & NP280350. COMPONENT BOARD PLI9C320209, COMPONENT BOARD PLI9C320183 FOR MODIFYING MASTR CONTROLLER TO PROVIDE CONTROL FUNCTIONS AND TO PROVIDE ALERT TONE FUNCTION AND TO PROVIDE BATTERY STANDBY IN D.C. CONTROL SYSTEMS.

#### **INSTALLATION INSTRUCTIONS**

SWITCH KITS 19D416628G1-G12

#### LBI-4478

	LECEND	CWLTCU	CWITCH	CONNECTIONS	DW BOARD WOD
	SEE FIG. !	SWITCH	SWITCH LOCATION SEE FIG. 2	CONNECTIONS SEE FIG. 3	PW BOARD MOD INSTRUCTIONS
(/)	REPT. ON REPT. OFF	190416628G1	POS. 3	W TO JIIII-34 BL TO JIIII-35 WG TO JIIII-53-58 BK TO JIIII-46-52	SEE NOTE 2
_	NP270751P16	(TONE)		G. 10 01111 10 02	
2	OFF AUX 2 ON NP270751P18	(TONE)	P0S. 12	W TO JIIII-28 BL TO JIIII-31 WG TO JIIII-53-58 BK TO JIIII-46-52	
			P0S . 4	W TO 1111 74	
(3)	CG ON CG OFF	19D416628G1	FUS. 4	W TO Jill1-34 BL TO JIII1-35 WG TO JIII1-53-58 BK TO JIII1-46-52	
_	NP270751P14	(TONE)			
(4)	SQ MIN SQ MAX	19D416628G1	POS. 4	W TO JIIII-34 BL TO JIIII-35 WG TO JIIII-53-58 BK TO JIIII-46-52	
	NP270751P15	(TONE)			
(5)	OFF AUX I ON	19D416628G1	POS. 11	W TO JIIII-33 BL TO JIIII-32 WG TO JIIII-53-58 BK TO JIIII-46-52	
	NP270751P5	(TONE)			
6	REC F1 REC F2	19D416628G12	POS. 2	BL 10 JIIII-37 WG TO JIIII-53-58 BK TO JIIII-46-52	<b>†</b>
	NP270751P12	(DC CONTROL)			
(7)	XMIT FI XMIT F2	19041662861	POS. I	W TO JIIII-38 BL TO JIIII-39 WG TO JIIII-53-58 BK TO JIIII-46-52	
	NP270751P13	(DC & TONE)			
8	REC I	19D416628G2	POS. 2	BL TO JIIII-37 WG TO JIIII-53-58 BK TO JIIII-46-52	SEE FIG. 4 FOR MODIFICATIONS
_	NP270751P2	(DC)			TO H.V. BOARD PL19D416592G1 2
9	REC 2	19D416628G2	POS. 3	BL TO JIIII-36 WG TO JIIII-53-58 BK TO JIIII-46-52	
	NP270751P3	(DC)			
10	REPEAT DISABLE	19D416628G2	POS. 3	BL TO JIIII-37 WG TO JIIII-53-58 BK TO JIIII-46-52	
	NP270751P4	(DC)			
<i>(//</i> )	CG MON	19D416628G3	POS. 4	W TO JIIII-53-58 BL TO JIIII-46-52 WG TO JIIII-29 BK TO JIIII-30	
	NP270751P1	(DC)	POS O	# <del>7</del> 0 6	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1
(12)	SPKR MUTE	19D416628G4	POS. 9	W TO JIIII-6 WG TO JIIII-53-58 WR TO JIIII-I	NOVE BLACK WIRE   FROM JITTI-! O JITTI-5   SEE FIG. 3
	NP270751P8	(DC & TONE)		BR TO JIIII-46-52	3EE 110. 3
(13)	SUPV CONT	19041662865	POS. 5	8L TO JIIII-22 WG TO JIIII-53-58 BK TO JIIII-25 G TO JIIII-46-52	CONNECT JUBBLE R BETWEEN 131101-5 8 TBI101-9 AND CONNECT JUMPER BETWEEN TBI101-6 8 TBI101-12 ON MOTHER BD.
	NP270751P6	(DC)			SEE FIG. 3
(14)	REC F1 REC F2	19D416628G1	POS. 2	W TO JIIII-37 BL TO JIIII-36 WG TO JIIII-53-58 BK TO JIIII-46-52	
	NP270751P12	(TONE CONTROL)			

				_
INSTAL	ATION	INSTR	UCTIONS	S

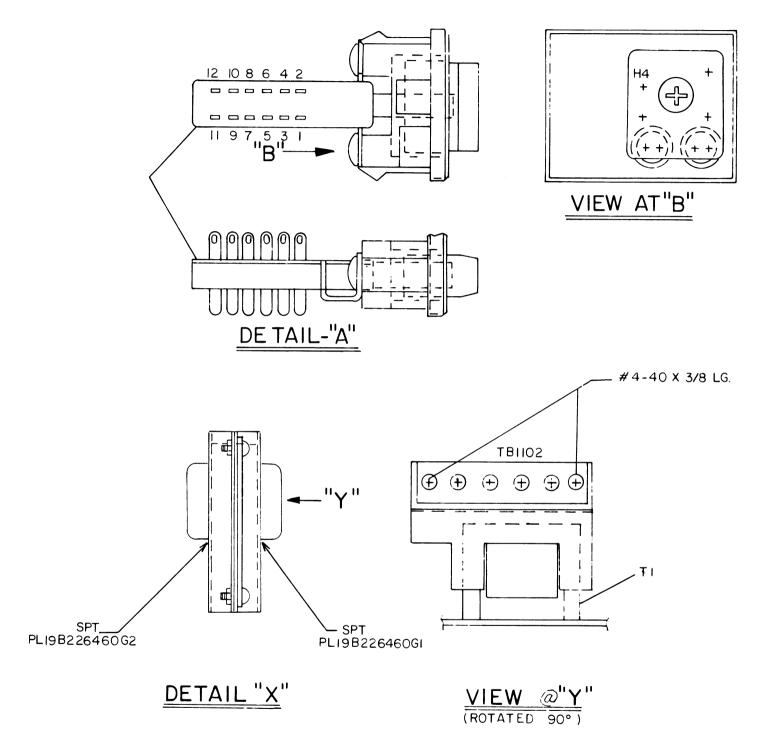
SWITCH KITS 19D416628G1-G12

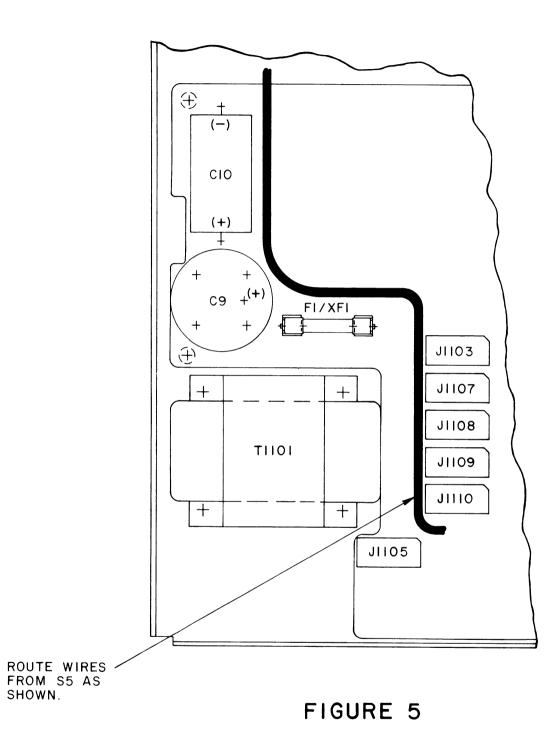
54 Issue 5

	LEGEND	SWITCH	SWITCH	CONNECTIONS	PW BOARD MOD
	SEE FIG. I		LOCATION SEE FIG. 2	SEE FIG. 3	INSTRUCTIONS
15	BATT STBY NF-270751P10	19D416628G6	P08. 10	BL TO JIIII-18 WG TO JIIII-46-52 BK TO JIIII-26 G TO JIIII-15 R TO JIIII-19 V TO JIIII-17	CLIP JUMPER BETWEEN H24&H25 REMOVE MTG. SCR. MOUNT BATT. STBY. BD. AS SHOWN. REPLACE SCR. THROUGH SPT. ON BATT. STBY. BD. (SEE FIG.3) CLIP JUMPER BETWEEN H8 & H9 ON MOTHER BD. SEE FIG. 3.
	INTCM	19041662867	POS. 6	W TO JIIII-41	CLIP JUMPER SETWEEN
(16)	NP270751P7	(DC & TONE)		BL TO JIIII-46-52 BK TO JIIII-40 G TO JIIII-53-58	HI2 & HI3 ON MOTHER BD. SEE FIG. 3.
17)	LINE 2	19D416628G8 (DC & TONE)	POS. 7	WG TO JIIII-53-58 WBK TO JIIII-46-52 W TO JIIII-14 BR TO JIIII-11 R TO JIIII-12 BL TO JIIII-9 O TO JIIII-13 R TO JIIII-16	CLIP JUMPER BETWEEN H2Q. & H2I AND BETWEEN H22 & H23 ON MOTHER BD. SEE FIG. 3.
18	TAKE OVER	19041662869	POS. 5	WG TO JIIII-53-58 G TO JIIII-46-52 OW TO JIIII-92 R TO JIIII-9 V TO JIIII-25 Y TO JIIII-12	
	NP270751P17	(DC & TONE)			
<i>(</i> 19)	REC   NP270751P2	19D416628G10 (TONE)	POS. 2	0 TO JIIII-36 Y TO JIIII-53-58	
20	REC 2	19D416628G11 (TONE)	POS. 3	BL TO JIIII-46-52 V TO JI-III-28 OW TO JIIII-37 WBL TO S4-5 R TO S4-7 WBK TO S4-1 BR TO S4-1 G TO S4-6 W TO S4-8 W TO S4-8 W TO S4-8 W TO S4-8 BL-G TO JIII-26	ALL CONNECT:ONS TO SWITCH ASM. LOCATED IN POS 2. SEE "DETAIL A" FOR TERMINAL LOCATIONS
21)	ALERT TONE NP270751P9	19C320209G1	POS. 8	G TO JIIII-46-52 WG TO JIIII-44 BK TO JIIII-23 W TO JIIII-27	
22)	LINE 2	(DC & TONE)	P0S. 7	WG TO JIIII-53-58 WBK TO JIIII-46-52 W TO JIIII-14 BR TO JIIII-11 R TO JIIII-12 EL TO JIIII-9 O TO JIIII-13 R TO JIIII-16 R TO TBII01-13 BL TO TBII01-16	CLIP JUMPER BETWEEN H20 & H21 AND BETWEEN H22 & H23 ON MOTHER BD. SEE FIG. 3. & DETAIL-X ROUTE WIRES AS SHOWN IN FIG. 5

NOTES:
1. IF THE NUMBER OF OPTIONS REQUIRING GROUND JACKS JIIII-46-52
EXCEEDS SEVEN, REMOVE THE 4029840PZ CONTACT TERMINATION ON
THE GROUND LEAD OF THE KIT AND INSTALL A 4033348PJ CONTACT
PROVIDED IN THE KIT. INSTALL THIS "PIGGYBACK" CONNECTION
ON JIIII-46-52.
2. IF BOTH CG, ON-OFF AND REPT. ON-OFF SWITCHES ARE PRESENT
CONNECT THE WHITE (W) AND BLUE (BL) WIRES OF THE REPT.
ON-OFF SWITCH TO JIIII-31 & 28 RESPECTIVELY.

(19D416690, Sh. 2, Rev. 8)





(19D416690, Sh. 3, Rev. 0)

## **INSTALLATION INSTRUCTIONS**

SWITCH KITS 19D416628G1-G12

Issue 1

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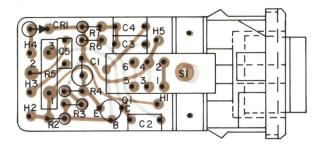
#### PARTS LIST

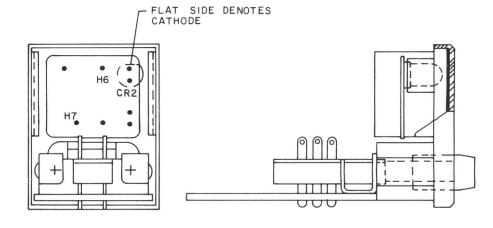
LBI-4468

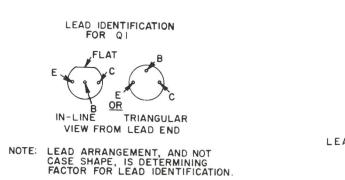
ALERT TONE KIT 19C320209G1

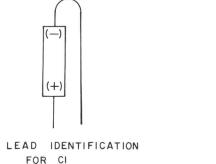
SYMBOL	GE PART NO.	DESCRIPTION
		GARAGINONS
C1	5496267P2	Tantalum: 47 µf ±20%, 6 VDCW; sim to Sprague Type 150D.
C2 thru C4	19Al16080Pl02	Polyester: 0.015 μf ±10%, 50 VDCW.
C5	19Al16080Pl01	Polyester: 0.01 µf ±10%, 50 VDCW.
		DIODES AND RECTIFIERS
CR1	4037822P1	Silicon.
CR2	19A129291P1	Diode, light emitting: red.
Q1	19A116774P1	Silicon, NPN; sim to Type 2N5210.
Cons		RESISTORS
R1	3R152P122J	Composition: 1200 ohms ±5%, 1/4 w.
R2	3R152P513J	Composition: 51,000 ohms $\pm 5\%$ , $1/4$ w.
R3	3R152P682J	Composition: 6800 ohms $\pm 5\%$ , $1/4$ w.
R4	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.
R5	19B209358P105	Variable, carbon film: approx 75 to 5000 ohms $\pm 10\%$ , 0.25 w; sim to CTS Type X-201.
R6 and R7	3R152P182J	Composition: 1800 ohms ±5%, 1/4 w.
S1	19All6009P14	Push: DPDT, 1 station, momentary action, operating currents, (A) 100 MADC at 28 v or (B) 15 MADC at 130 v.

## **OUTLINE DIAGRAM**

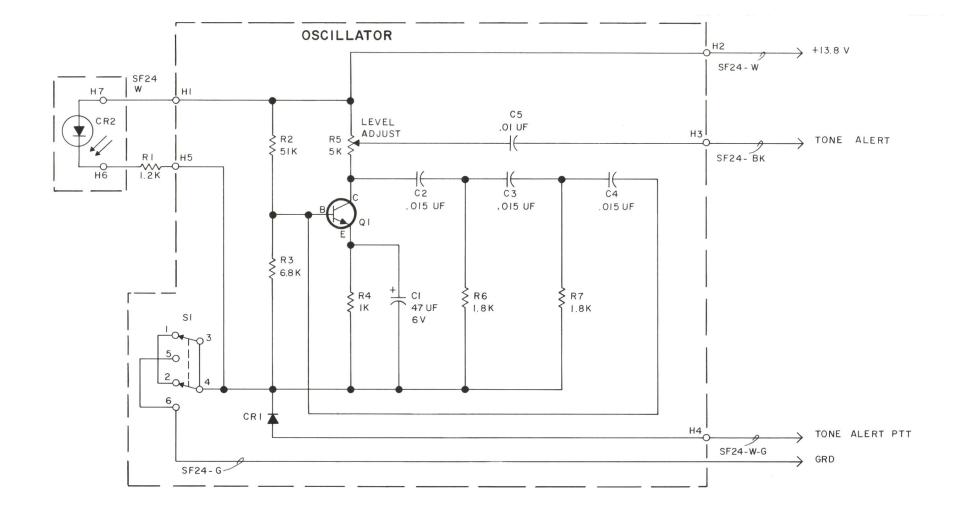








## SCHEMATIC DIAGRAM



SEE APPLICABLE PRODUCTION CHANGE SHEETS IN INSTRUCTION BOOK SECTION DEALING WITH THIS UNIT, FOR DES-CRIPTION OF CHANGES UNDER EACH REVISION LETTER. THIS ELEM DIAG APPLIES TO REV LETTER MODEL NO PL19C320209GI

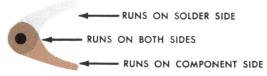
ALL RESISTORS ARE 1/4 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K=1000 OHMS OR MEG = 1,000,000 OHMS CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED BY UF = MICROFARADS. INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH= MILLIHENRYS OR H=HENRYS.

IN ORDER TO RETAIN RATED EQUIPMENT PERFORMANCE, REPLACEMENT OF ANY SERVICE PART SHOULD BE MADE ONLY WITH A COMPONENT HAVING THE SPECIFICATIONS SHOWN ON THE PARTS LIST FOR THAT PART.

I. TERMINATE ALL LET HANG WIRES WITH TERMINAL A4029840P2.

(19C320230, Rev. 1)

(19C320701, Rev. 0) (19B219569, Sh. 2, Rev. 0) (19B219569, Sh. 3, Rev. 0)



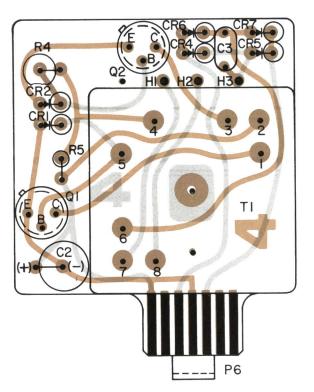
## **SERVICE SHEET**

ALERT TONE KIT (OPTION 8528)

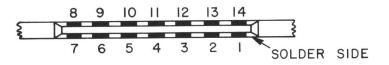
57 Issue 2

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

#### **OUTLINE DIAGRAM**



TYPICAL CONTACT FINGER NUMBERING



LEAD IDENTIFICATION FOR QI & Q2

CATION (19C320713, Rev. 2) (19C320163, Sh. 2, Rev. 4) (19C320163, Sh. 3, Rev. 4)

--- RUNS ON SOLDER SIDE

- RUNS ON COMPONENT SIDE

- RUNS ON BOTH SIDES



TRIANGULAR
VIEW FROM LEAD END

NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

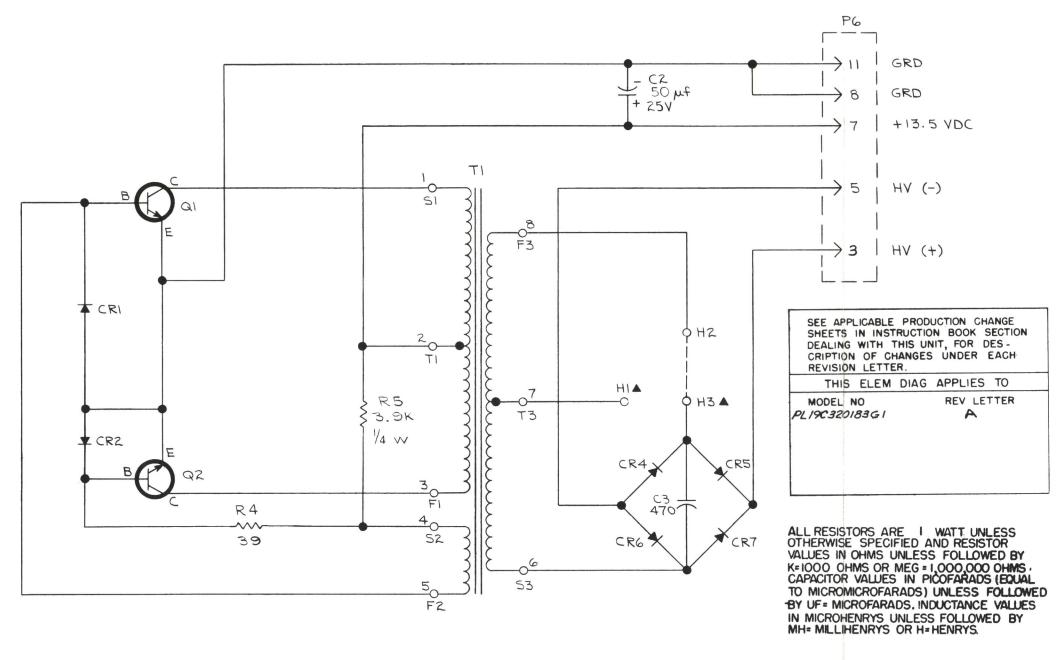
## **SERVICE SHEET**

DC CONTROL BATTERY STANDBY BOARD (OPTION 8526)

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Issue 3

## SCHEMATIC DIAGRAM



#### NOTE

AI. IF E &M SIGNALLING IS USED, MOVE JUMPER FROM BETWEEN H2 &H3 TO H3 &HI.

(19C320240, Rev. 3)

#### PARTS LIST

LBI-4460B

DC BATTERY STANDBY KIT 19C320183G1

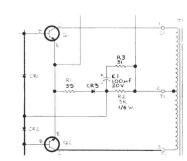
SYMBOL	GE PART NO.	DESCRIPTION
		CAPACITORS
C1*	5496267P16	Tantalum: 100 µf ±20%, 20 VDCW; sim to Sprague Type 150D. Deleted by REV A.
C2	19A115680P4	Electrolytic: 50 µf +150% -10%, 25 VDCW; sim to Mallory Type TT.
С3	5494481P107	Ceramic disc: 470 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
		DIODES AND RECTIFIERS
CR1 and CR2	4037822P2	Silicon.
CR3*	4037822P2	Silicon. Deleted by REV A.
CR4 thru CR7	4037822P2	Silicon.
P6		(Part of printed wiring board 190320163P1).
Q1* and	19A115300P4	Silicon, NPN.
Q2*		Earlier than REV A:
	19A115300P2	Silicon, NPN; sim to Type 2N3053.
R1 *	3R77P390K	Composition: 39 ohms $\pm 10\%$ , $1/2$ w. Deleted by REV A.
R2*	3R152P302J	Composition: 3000 ohms ±5%, 1/4 w. Deleted by REV A.
R3*	3R77P510J	Composition: 51 ohms $\pm 5\%$ , $1/2$ w. Deleted by REV A.
R4*	3R78P390K	Composition: 39 ohms $\pm 10\%$ , 1 w. Added by REV A.
R5*	3R152P392J	Composition: 3900 ohms $\pm 5\%$ , $1/4$ w. Added by REV A.
T1	19¢303894 <b>G</b> 3	Coil.
		MISCELLANEOUS
	4036555P1	Insulator, washer: nylon. (Used with Ql and Q2).

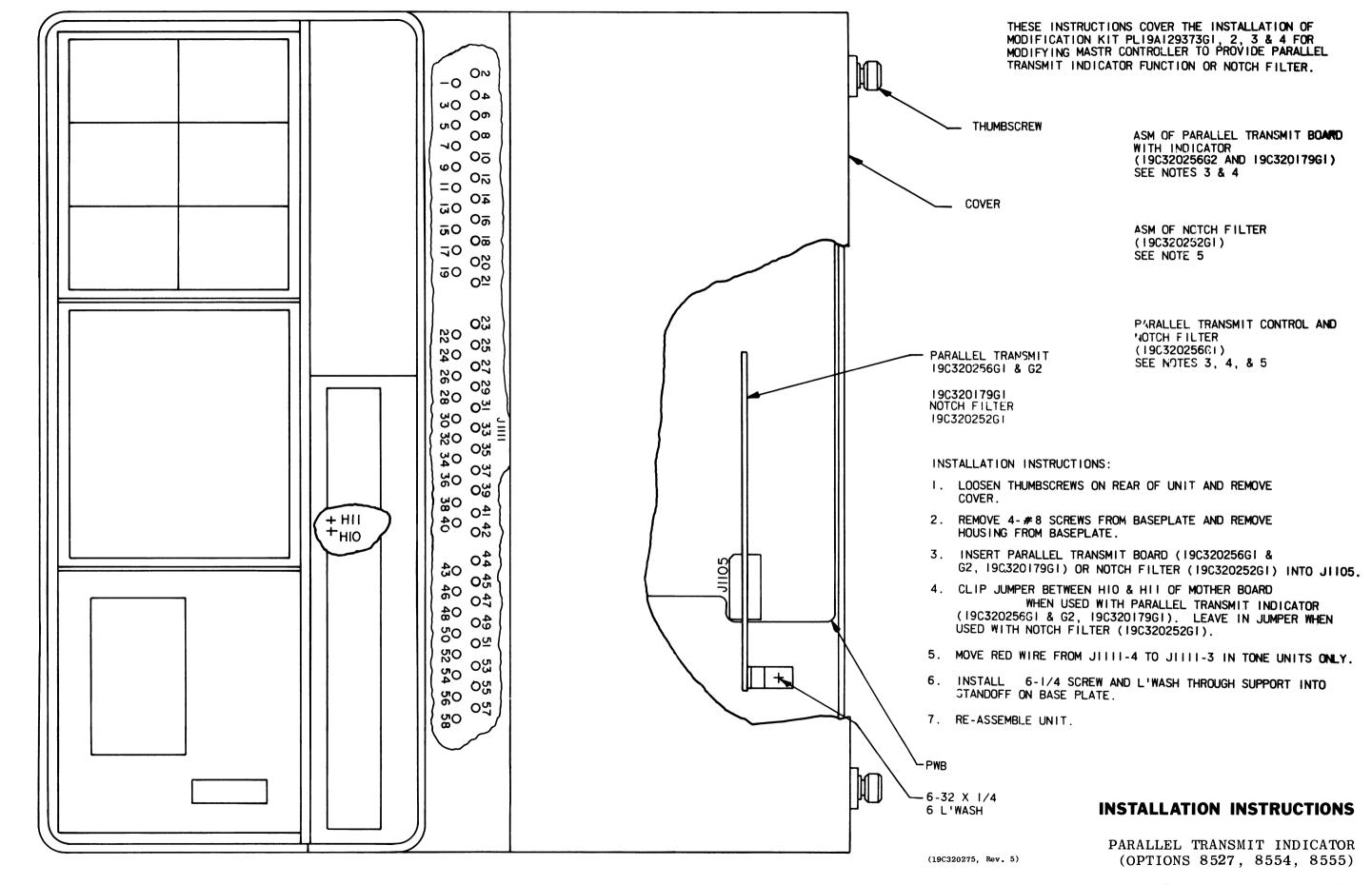
#### **PRODUCTION CHANGES**

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

Rev. A - To improve performance. Deleted C1, CR3, R1, R2, and R3. Added R4 & R5.

Schematic Diagram Was:

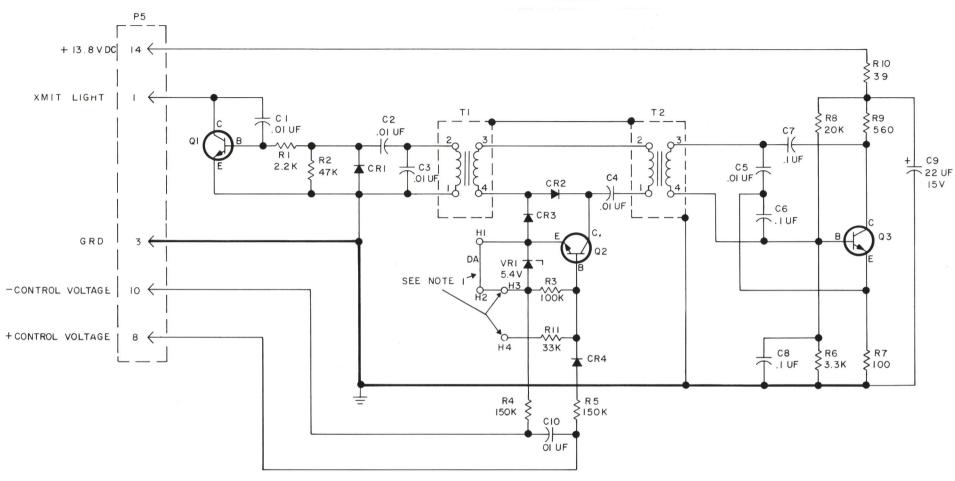




Issue 5

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## SCHEMATIC DIAGRAM



SEE APPLICABLE PRODUCTION CHANGE SHEETS IN INSTRUCTION BOOK SECTION DEALING WITH THIS UNIT, FOR DES-CRIPTION OF CHANGES UNDER EACH REVISION LETTER. THIS ELEM DIAG APPLIES TO MODEL NO PL19C320179GI

ALL RESISTORS ARE 1/4 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K=1000 OHMS OR MEG=1,000,000 OHMS -CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED BY UF = MICROFARADS, INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH= MILLIHENRYS OR H=HENRYS.

I. WHEN CG MON CURRENT IS +16 MA INSTEAD OF -2.5 MA, REMOVE JUMPER BETWEEN HI & H2 AND CONNECT A
JUMPER BETWEEN H3 & H4.

(19C320232, Rev. 1)

## **SERVICE SHEET**

DC CONTROL PARALLEL TRANSMIT INDICATOR (OPTION 8527)

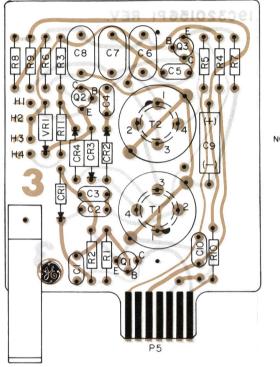
## Issue 5

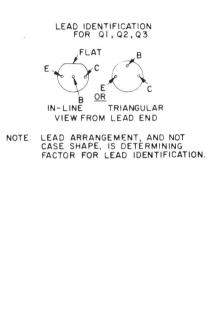
#### PARTS LIST

LBI-4544

PARALLEL TRANSMIT INDICATOR 19A129373G4

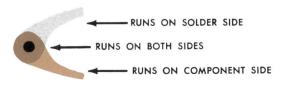
## **OUTLINE DIAGRAM**



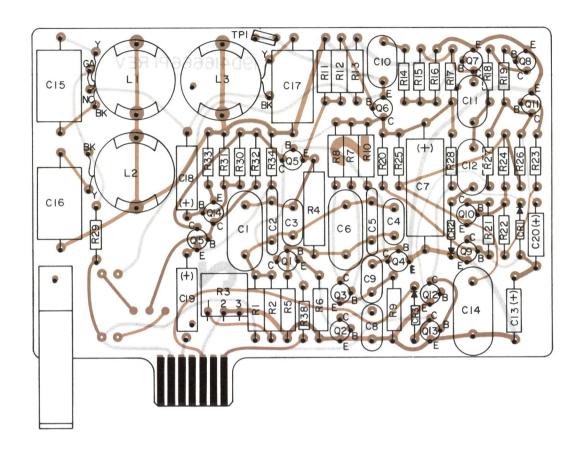


TYPICAL CONTACT FINGER NUMBERING 8 9 10 11 12 13 14 7 6 5 4 3 2 1 SOLDER SIDE

(19C320714, Rev. 1) (19C320156, Sh. 2, Rev. 3) (19C320156, Sh. 3, Rev. 3)



SYMBOL	GE PART NO.	DESCRIPTION
C1 thru C5	19A116080P1	
C6 thru C8	19A116080P7	Polyester: 0.1 µf ±20%, 50 VDCW.
C9	5496267P10	Tantalum: 22 $\mu f$ $\pm 20\%$ , 15 VDCW; sim to Sprague Type 150D.
C10	19A116080P1	Polyester: 0.01 µf ±20%, 50 VDCW.
CR1 and	19A115250P1	DIODES AND RECTIFIERS
CR2 CR3 and	4037822P2	Silicon.
P5		(Part of printed wiring board 19C320156P1).
Q1 thru Q3	19A116774P1	Silicon, NPN; sim to Type 2N5210.
		RESISTORS
R1	3R152P222J	Composition: 2200 ohms ±5%, 1/4 w.
R2	3R152P473J 3R152P104J	Composition: 47,000 ohms ±5%, 1/4 w.  Composition: 0.10 megohm ±5%, 1/4 w.
R3	3R152P154J	Composition: 0.15 megohm ±5%, 1/4 w.
and R5	51(10211010	Composition: 0.10 megami =0%, 1/1 m
R6	3R152P332J	Composition: 3300 ohms ±5%, 1/4 w.
R7	3R152P101J	Composition: 100 ohms ±5%, 1/4 w.
R8	3R152P203J	Composition: 20,000 ohms ±5%, 1/4 w.
R9	3R152P561J	Composition: 560 ohms ±5%, 1/4 w.
R10	3R152P390J	Composition: 39 ohms ±5%, 1/4 w.
R11	3R152P333J	Composition: 33,000 ohms ±5%, 1/4 w.
T1 and T2	19B219563G1	Coil.
VR1	4036887P5	VOLTAGE REGULATORS
- 5		
*COMPON	IENTS ADDED, DE	LETED OR CHANGED BY PRODUCTION CHANGES



FOR Q6,Q7,Q9-Q14

FLAT

B

C

E

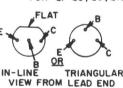
C

TRIANGULAR

VIEW FROM LEAD END

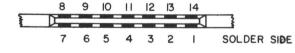
NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

LEAD IDENTIFICATION FOR QI-Q5, Q8, Q15

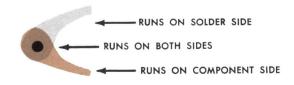


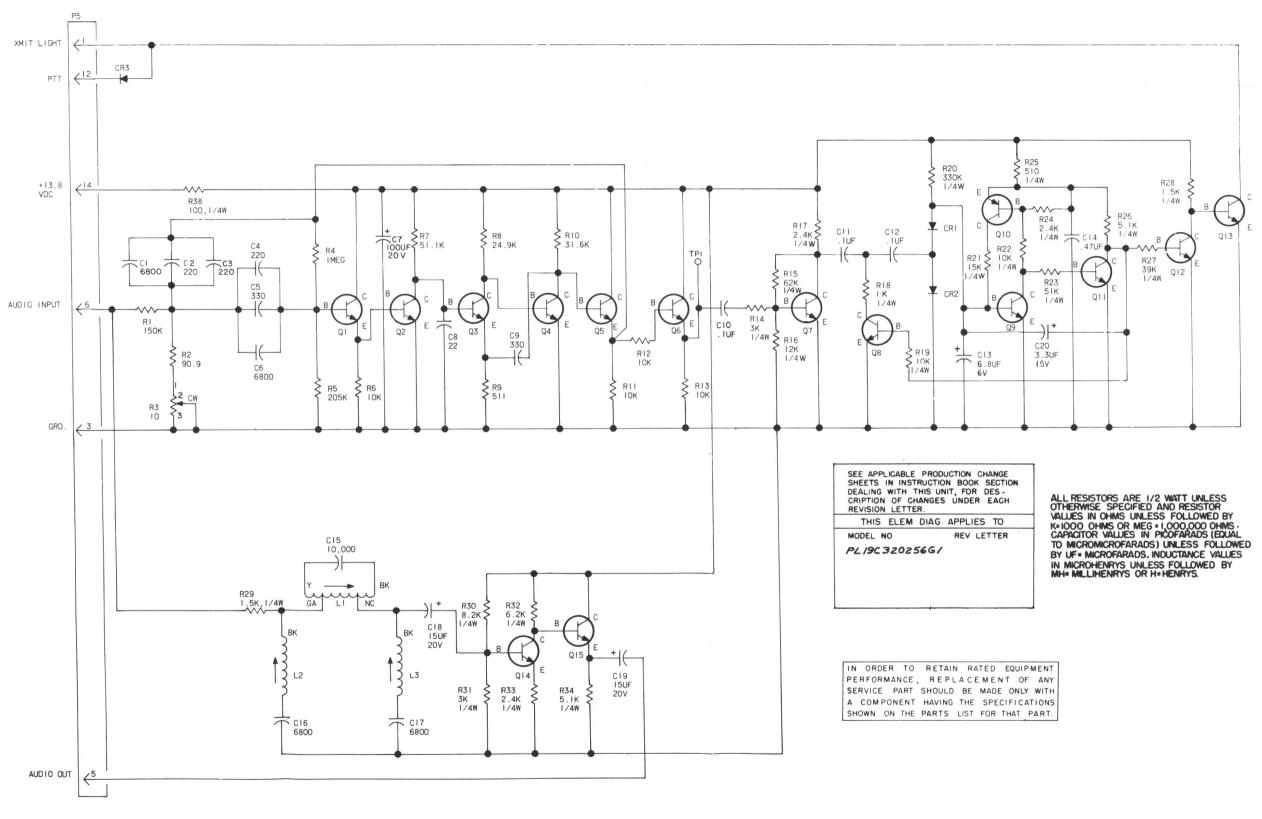
NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

TYPICAL NUMBERING OF CONTACT FINGERS



(19C320707, Rev. 0) (19D416666, Sh. 2, Rev. 2) (19D416666, Sh. 3, Rev. 2)





## **SERVICE SHEET**

(19D416679, Rev. 2)

TONE CONTROL PARALLEL TRANSMIT INDICATOR (OPTION 8554)

LBI-4478

#### PARTS LIST

## LBI-4463

PARALLEL INDICATOR KIT 19A129373G1

C1 5491871P68006 Mica: 6800 pf 12%, 300 VDCW; sim to Electro Motive Type DM=20.  C2 5496219P875 Ceramic disc: 330 pf 15%, 500 VDCW, temp coef -750 PFW.  C3 and 7489162P235 Sliver mica: 220 pf 12%, 500 VDCW; sim to Electro Motive Type DM=15.  C5 5496219P875 Ceramic disc: 330 pf 15%, 500 VDCW; temp coef -750 PFW.  C6 5491871P68006 Mica: 6800 pf 12%, 300 VDCW; sim to Electro Motive Type DM=20.  C7 5496267P16 Tantalum: 100 µf 120%, 20 VDCW; sim to Sprague Type 150D.  C8 7489162P11 Sliver mica: 22 pf 15%, 500 VDCW; sim to Electro Motive Type DM=15.  C9 7489162P39 Sliver mica: 330 pf 15%, 500 VDCW; sim to Electro Motive Type DM=15.  C10 19A116080P107 Polyester: 0.1 µf 110%, 50 VDCW; sim to Electro Motive Type DM=15.  C11 19A116080P101 Polyester: 0.1 µf 110%, 50 VDCW; sim to Sprague Type 150D.  C14 19A116080P111 Polyester: 0.7 µf 110%, 50 VDCW; sim to Mial Meries 617.  C16 19A116738P3 Polystyrene: 6800 pf 12.5%, 33 VDCW; sim to Mial Meries 617.  C18 3496267P1 Tantalum: 15 µf 120%, 20 VDCW; sim to Mial Meries 617.  C18 19A116738P2 Polystyrene: 6800 pf 12.5%, 33 VDCW; sim to Mial Meries 617.  C18 19A116738P2 Polystyrene: 6800 pf 12.5%, 33 VDCW; sim to Mial Meries 617.  C19 19A116738P3 National Series 617.  C10 19A116738P3 Slicon, MPN; sim to Type 2M5210.  C20 5496267P9 Tantalum: 3.3 µf 120%, 13 VDCW; sim to Sprague Type 150D.  C11 19A1157891 Silicon, NPN; sim to Type 2M5210.  C21 19A115889P1 Silicon, NPN; sim to Type 2M5210.  C22 19A115889P1 Silicon, NPN; sim to Type 2M5210.  C33 19A115889P1 Silicon, NPN; sim to Type 2M5210.  C44 19A115889P1 Silicon, NPN; sim to Type 2M5210.  C55 19A116774P1 Silicon, NPN; sim to Type 2M5210.  C56 19A116774P1 Silicon, NPN; sim to Type 2M5210.  C57 19A116774P1 Silicon, NPN; sim to Type 2M5210.  C57 29A116774P1 Silicon, NPN; sim to Type 2M5210.  C58 29A116774P1 Silicon, NPN; sim to Type 2M	GE PART NO.	DESCRIPTION
C1		
7-750 PPM.  7-750 PPM.  7-750 PPM.  Silver mica: 220 pf ±2%, 500 VDCW; sim to Electro Motive Type DM-15.  C5 5496219P875	5491871P6800G	Mica: 6800 pf ±2%, 300 VDCW; sim to Electro Motive Type DM-20.
Electro Motive Type DM-15.  C4  C5 5496219P875	5496219P875	Ceramic disc: 330 pf ±5%, 500 VDCW, temp coef -750 PPM.
Top PPM.	7489162P235	
Tantalum: 100 µf ±20%, 20 VDCW; sim to Sprague Type 150D.  C8 7489162P11 Silver mica: 22 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.  C9 7489162P39 Silver mica: 330 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.  C10 19A116080P107 Polyester: 0.1 µf ±10%, 50 VDCW.  C12 19A116738P3 Polyester: 0.47 µf ±10%, 50 VDCW.  C14 19A116738P3 Polyester: 0.47 µf ±10%, 50 VDCW.  C15 19A116738P2 Polyester: 0.47 µf ±10%, 50 VDCW.  C16 19A116738P2 Polyester: 0.47 µf ±10%, 50 VDCW; sim to Misal Series 617.  C18 5496267P14 Tantalum: 15 µf ±20%, 20 VDCW; sim to Misal Series 617.  C18 5496267P14 Tantalum: 15 µf ±20%, 20 VDCW; sim to Sprague Type 150D.  C20 5496267P9 Tantalum: 3.3 µf ±20%, 15 VDCW; sim to Sprague Type 150D.  CR1 19A115250P1 Silicon.  CR2 19A115250P1 Silicon.  CR3 19A115250P1 Silicon, NPN; sim to Type 2N5210.  Q1 19A11574P1 Silicon, NPN; sim to Type 2N5210.  Q2 19A115889P1 Silicon, NPN; sim to Type 2N5210.  Q3 19A115889P1 Silicon, NPN; sim to Type 2N3702.  Q1 19A115768P1 Silicon, NPN; sim to Type 2N3702.  Q11 19A115768P1 Silicon, NPN; sim to Type 2N3702.  Q11 19A115768P1 Silicon, NPN; sim to Type 2N3702.  Q15 19A115889P1 Silicon, NPN; sim to Type 2N3702.  Q15 19A11574P1 Silicon, NPN; sim to Type 2N3702.  Q16 19A115889P1 Silicon, NPN; sim to Type 2N3702.  Q17 19A115768P1 Silicon, NPN; sim to Type 2N3702.  Q18 19A115889P1 Silicon, NPN; sim to Type 2N3702.  Q19 19A115768P1 Silicon, NPN; sim to Type 2N3702.  Q10 19A115768P1 Silicon, NPN; sim to Type 2N3702.  Q11 19A115768P1 Silicon, NPN; sim to Type 2N3702.  Q15 19A116774P1 Silicon, NPN; sim to Type 2N5210.	5496219P875	Ceramic disc: 330 pf ±5%, 500 VDCW, temp coef -750 PPM.
C7 5496267P16 Tantalum: 100 μf ±20%, 20 VDCW; sim to Sprague Type 150D.  C8 7489162P11 Silver mica: 22 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.  C9 7489162P39 Silver mica: 330 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.  C10 thru 19A116080P107 Polyester: 0.1 μf ±10%, 50 VDCW.  C12 Tantalum: 6.8 μf ±20%, 6 VDCW; sim to Sprague Type 150D.  C14 19A116738P3 Polyester: 0.47 μf ±10%, 50 VDCW.  C15 19A116738P2 Polystyrene: 10,000 pf ±2.5%, 33 VDCW; sim to Mial Series 617.  C16 and 19A116738P2 Polystyrene: 6800 pf ±2.5%, 33 VDCW; sim to Mial Series 617.  C18 3496267P14 Tantalum: 15 μf ±20%, 20 VDCW; sim to Sprague Type 150D.  C20 5496267P9 Tantalum: 3.3 μf ±20%, 15 VDCW; sim to Sprague Type 150D.  C21 19A115250P1 Silicon.  C22 19A115250P1 Silicon.  C23 19A115250P1 Silicon, NPN; sim to Type 2N5210.  C3 19A115889P1 Silicon, NPN; sim to Type 2N2712.  C4 19A115889P1 Silicon, NPN; sim to Type 2N2712.  C5 19A115889P1 Silicon, NPN; sim to Type 2N2712.  C6 19A115889P1 Silicon, NPN; sim to Type 2N2712.  C7 19A115889P1 Silicon, NPN; sim to Type 2N2712.  C8 19A115889P1 Silicon, NPN; sim to Type 2N2712.  C9 19A115889P1 Silicon, NPN; sim to Type 2N2712.  C10 19A115768P1 Silicon, NPN; sim to Type 2N2712.  C11 19A115768P1 Silicon, NPN; sim to Type 2N2712.  C12 19A115889P1 Silicon, NPN; sim to Type 2N2712.  C13 19A115768P1 Silicon, NPN; sim to Type 2N2712.  C14 19A115768P1 Silicon, NPN; sim to Type 2N2712.	5491871P6800G	
C8 7489162P11 Silver mica: 22 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.  C9 7489162P39 Silver mica: 330 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.  C10 19A116080P107 polyester: 0.1 µf ±10%, 50 VDCW.  C12 Tantalum: 6.8 µf ±20%, 6 VDCW; sim to Sprague Type 150D.  C14 19A116080P111 Polyester: 0.47 µf ±10%, 50 VDCW.  C15 19A116738P3 Polystyrene: 10,000 pf ±2.5%, 33 VDCW; sim to Mial Series 617.  C16 and 19A116738P2 Polystyrene: 6800 pf ±2.5%, 33 VDCW; sim to Mial Series 617.  C18 and 2015 S496267P14 Tantalum: 15 µf ±20%, 20 VDCW; sim to Sprague Type 150D.  C20 5496267P9 Tantalum: 3.3 µf ±20%, 15 VDCW; sim to Sprague Type 150D.  CR1 thru CR3	5496267P16	
C9	7489162P11	Silver mica: 22 pf ±5%, 500 VDCW; sim to
C10 thru C12 C13	7489162P39	Silver mica: 330 pf ±5%, 500 VDCW; sim to
C13	19Al16080P107	
C14	5496267P1	Tantalum: 6.8 µf ±20%, 6 VDCW; sim to Sprague Type 150D.
Mial Series 617.	19A116080P111	
Mial Series 617.	19A116738P3	
C18 and C19  C20  5496267P9  Tantalum: 15 µf ±20%, 20 VDCW; sim to Sprague Type 150D.  Tantalum: 3.3 µf ±20%, 15 VDCW; sim to Sprague Type 150D.  CR1 thru CR3  L1  19A115250P1  Silicon.  Coil.  L2 and L3	19A116738P2	Polystyrene: 6800 pf ±2.5%, 33 VDCW; sim to Mial Series 617.
Tantalum: 3.3 µf ±20%, 15 VDCW; sim to Sprague Type 150D.  CR1 thru CR3  19A115250P1  L1 19B205354G4  Coil.  L2 and L3	5496267P14	
CR1 thru CR3	5496267P9	
thru CR3		DIODES AND RECTIFIERS
L1 19B205354G4 Coil.  L2 and L3	19A115250P1	Silicon.
L2 and L3  198205354G5  Coil.	İ	
and L3	19B205354G4	Coil.
Q1 thru Q5  Q6 19Al15889P1 Silicon, NPN; sim to Type 2N52l0.  Q8 19Al15889P1 Silicon, NPN; sim to Type 2N27l2.  Q8 19Al15889P1 Silicon, NPN; sim to Type 2N3906.  Q9 19Al15889P1 Silicon, NPN; sim to Type 2N27l2.  Q10 19Al15768P1 Silicon, NPN; sim to Type 2N3702.  Q11 thru Q14  Q15 19Al16774P1 Silicon, NPN; sim to Type 2N27l2.	19B205354G5	Coil.
thru Q5  Q6		
Q6 and Q7       19Al15889P1       Silicon, NPN; sim to Type 2N2712.         Q8       19Al15910P1       Silicon, NPN; sim to Type 2N3906.         Q9       19Al15889P1       Silicon, NPN; sim to Type 2N2712.         Q10       19Al15768P1       Silicon, PNP; sim to Type 2N3702.         Q11 thru Q14       19Al15889P1       Silicon, NPN; sim to Type 2N2712.         Q15       19Al16774P1       Silicon, NPN; sim to Type 2N5210.	19A116774P1	Silicon, NPN; sim to Type 2N5210.
Q8 19Al15910P1 Silicon, NPN; sim to Type 2N3906.  Q9 19Al15889P1 Silicon, NPN; sim to Type 2N2712.  Q10 19Al15768P1 Silicon, PNP; sim to Type 2N3702.  Q11 thru Q14  Q15 19Al16774P1 Silicon, NPN; sim to Type 2N2712.	19A115889P1	Silicon, NPN; sim to Type 2N2712.
Q9 19Al15889P1 Silicon, NPN; sim to Type 2N2712. Q10 19Al15768P1 Silicon, PNP; sim to Type 2N3702. Q11 thru Q14 Q15 19Al16774P1 Silicon, NPN; sim to Type 2N2712.	19A115910P1	Silicon, NPN; sim to Type 2N3906.
Q11 thru Q14 Silicon, NPN; sim to Type 2N2712. Q15 19Al16774Pl Silicon, NPN; sim to Type 2N5210.	1	
thru Q14 Q15 19A116774P1 Silicon, NPN; sim to Type 2N5210.	19A115768P1	Silicon, PNP; sim to Type 2N3702.
Q15	19A115889P1	Silicon, NPN; sim to Type 2N2712.
1	19A116774P1	Silicon, NPN; sim to Type 2N5210.
R1 19A116278P418 Metal film: 150,000 ohms ±2%, 1/2 w.		RESISTORS
	19A116278P418	Metal film: 150,000 ohms ±2%, 1/2 w.
		5491871P6800G 5496219P875 7489162P235 5496219P875 5496219P875 5491871P6800G 5496267P16 7489162P31 7489162P39 19A116080P107 5496267P1 19A116738P2 5496267P14 5496267P9 19A115250P1 19B205354G4 19B205354G5 19A116774P1 19A115889P1 19A115889P1 19A115889P1 19A115768P1 19A115768P1 19A115774P1

SYMBOL	GE PART NO.	DESCRIPTION
R2	19A116278P93	Metal film: 90.9 ohms ±2%, 1/2 w.
R3	19A116559P111	Variable, cermet: 10 ohms ±20%, .5 w; sim to CTS Series 360.
R4	19A116624P1	Metal film: 1 megohm ±0.1%, 1/2 w; sim to IRC Type CCA-T9.
R5	19A116278P431	Metal film: 205,000 ohms ±2%, 1/2 w.
R6	19A116278P301	Metal film: 10,000 ohms $\pm 2\%$ , 1/2 w.
R7	19A116278P369	Metal film: 51,100 ohms $\pm 2\%$ , 1/2 w.
R8	19A116278P339	Metal film: 24,900 ohms ±2%, 1/2 w.
R9	19A116278P169	Metal film: 511 ohms $\pm 2\%$ , $1/2$ w.
R10	19A116278P349	Metal film: 31,600 ohms ±2%, 1/2 w.
Rll thru Rl3	19A116278P301	Metal film: 10,000 ohms ±2%, 1/2 w.
R14	3R152P302J	Composition: 3000 ohms ±5%, 1/4 w.
R15	3R152P623J	Composition: 62,000 ohms ±5%, 1/4 w.
R16	3R152P123J	Composition: 12,000 ohms ±5%, 1/4 w.
R17	3R152P242J	Composition: 2400 ohms ±5%, 1/4 w.
R18	3R152P620J	Composition: 62 ohms ±5%, 1/4 w.
R19	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.
R20	3R152P334J	Composition: 330,000 ohms ±5%, 1/4 w.
R21	3R152P153J	Composition: 15,000 ohms ±5%, 1/4 w.
R22	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.
R23	3R152P513J	Composition: 51,000 ohms ±5%, 1/4 w.
R24	3R152P242J	Composition: 2400 ohms ±5%, 1/4 w.
R25	3R152P511J	Composition: 510 ohms ±5%, 1/4 w.
R26	3R152P512J	Composition: 5100 ohms $\pm 5\%$ , $1/4$ w.
R27	3R152P393J	Composition: 39,000 ohms ±5%, 1/4 w.
R28 and R29	3R152P152J	Composition: 1500 ohms ±5%, 1/4 w.
R30	3R152P822J	Composition: 8200 ohms ±5%, 1/4 w.
R31	3R152P302J	Composition: 3000 ohms ±5%, 1/4 w.
R32	3R152P622J	Composition: 6200 ohms ±5%, 1/4 w.
R33	3R152P242J	Composition: 2400 ohms ±5%, 1/4 w.
R34	3R152P512J	Composition: 5100 ohms ±5%, 1/4 w.
R38	3R152P101J	Composition: 100 ohms ±5%, 1/4 w.
TPl	19B211379P1	
	I	

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES



#### PARTS LIST

LB14462A

NOTCH FILTER KIT 19A129373G3 (19C320252G1)

SYMBOL GE PART NO. DESCRIPTION 19A116738P2 Polystyrene: 6800 pf  $\pm 2.5\%$ , 33 v; sim to Mial Series 617. 5496267P14 Tantalum: 15  $\mu f$   $\pm 20\%$  , 20 VDCW; sim to Sprague Type 150D. 19A116738P3 Polystyrene: 0.01  $\mu$ f  $\pm 2.5\%$ , 33 v; sim to Mial Series 617. 19A116738P2 Polystyrene:  $6800 \text{ pf } \pm 2.5\%$ , 33 v; sim to Mial Series 617. 5496267P16 Tantalum: 100  $\mu\text{f}$   $\pm20\%\text{, 20 VDCW; sim to Sprague Type 150D.$ Tantalum: 3.3  $\mu\text{f}$  ±20%, 15 VDCW; sim to Sprague Type 150D. 5496267P9 19B205354G4 Coil. Includes: 5495789P3 Tuning slug. 19B205354G5 Coil. Includes: 5495789P3 Tuning slug. - - - - - - - - - - - PLUGS - - - - - - -(Part of printed wiring board 19C320214P1). 9A115889P1 Silicon, NPN. 3R152P152J Composition: 1.5K ohms +5% 1/4 w 3R152P822J Composition: 8.2K ohms +5% . 1/4 w. 3R152P302J 3R152P622J Composition: 6.2K ohms ±5%, 1/4 w. 3R152P242J Composition: 2.4K ohms ±5%, 1/4 w. 3R152P222J Composition: 2.2K ohms ±5%, 1/4 w. 3R152P512J Composition: 5.1K ohms ±5%, 1/4 w. 3R152P101J Composition: 100 ohms ±5%, 1/4 w. ----- MISCELLANEOUS -----19A129488P1 Insulator, (Used with L1 & L3). 19B219583P1 Machine screw: No.  $6-32 \times 1/4$ . (Secures support to board). N80P13004C6 N404P13C6 Lockwasher, internal tooth: No. 6. (Secures Notch Filter support to mounting surface). N80P13005C6 Machine screw: No. 6-32 x 5/16. (Secures Notch Filter support to mounting surface).

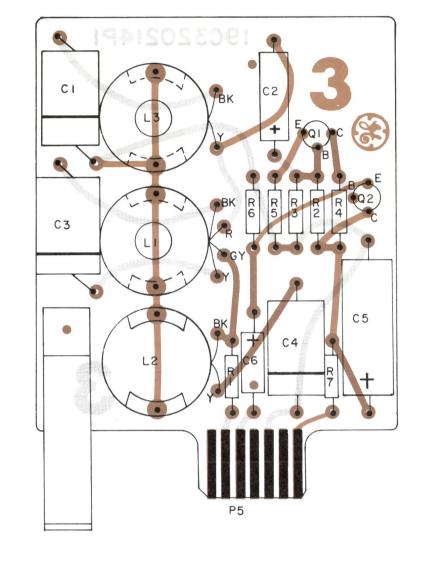
\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

## **PRODUCTION CHANGES**

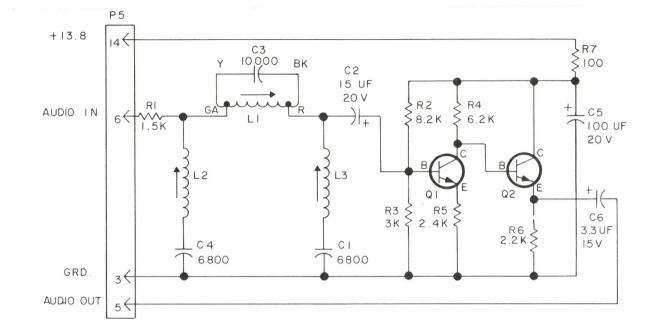
Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter," which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

REV. A - To improve performance. Changed R6.

#### **OUTLINE DIAGRAM**



#### SCHEMATIC DIAGRAM



SEE APPLICABLE PRODUCTION CHANGE SHEETS IN INSTRUCTION BOOK SECTION DEALING WITH THIS UNIT, FOR DESCRIPTION OF CHANGES UNDER EACH REVISION LETTER.

THIS ELEM DIAG APPLIES TO

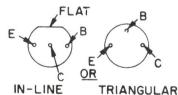
MODEL NO REV LETTER

PL19 C320252GI A

ALL RESISTORS ARE 1/4 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K=1000 OHMS OR MEG=1,000,000 OHMS CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS, INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY UF= MICROFARADS, INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH= MILLIHENRYS OR H= HENRYS.

IN ORDER TO RETAIN RATED EQUIPMENT PERFORMANCE, REPLACEMENT OF ANY SERVICE PART SHOULD BE MADE ONLY WITH A COMPONENT HAVING THE SPECIFICATIONS SHOWN ON THE PARTS LIST FOR THAT PART.

LEAD IDENTIFICATION FOR Q1 & Q2



NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

LEAD IDENTIFICATION FOR

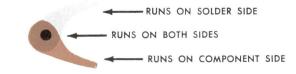
VIEW FROM LEAD END

TYPICAL CONTACT FINGER NUMBERING

8 9 10 11 12 13 14

7 6 5 4 3 2 1 SOLDER SIDE

(19C320709, Rev. 1) (19C320214, Sh. 2, Rev. 3) (19C320214, Sh. 3, Rev. 3)



(19B219646, Rev. 2)

## SERVICE SHEET

TONE CONTROL PARALLEL TRANSMIT INDICATOR NOTCH FILTER (OPTION 8555)

THESE INSTRUCTIONS COVER THE INSTALLATION OF MODIFICATION KIT PLIPAIZ9372GI - G4 FOR MODIFYING MASTR CONTROLLER TO PROVIDE I2 HOUR OR 24 HOUR CLOCK.

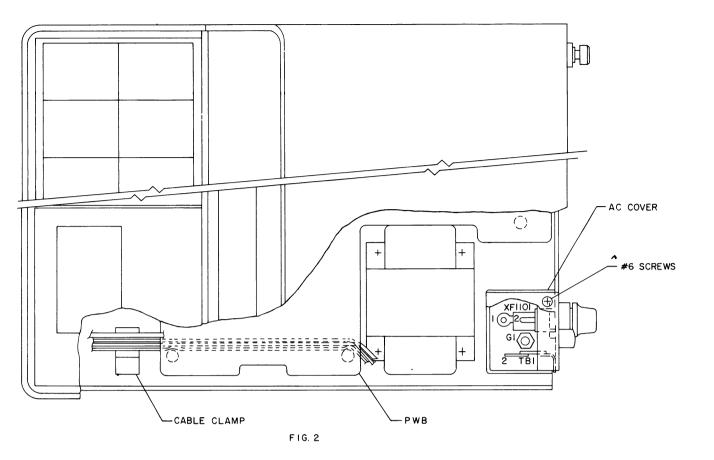
## ) INSTALLATION INSTRUCTIONS:

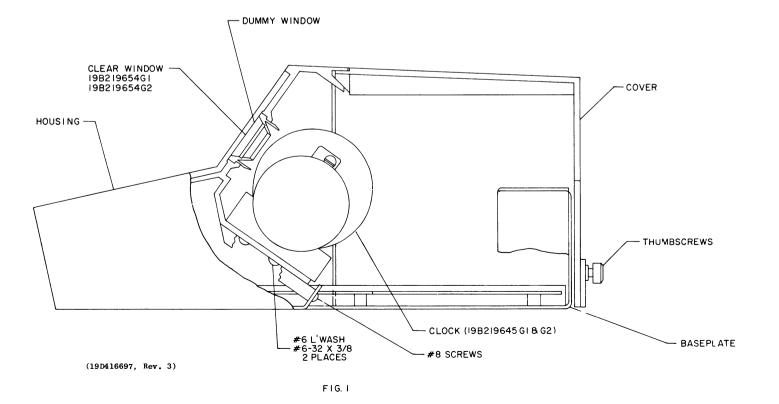
- 1. LOOSEN THUMBSCREWS ON REAR OF UNIT AND REMOVE COVER.
- REMOVE 4- #8 SCREWS FROM BASE PLATE AND REMOVE HOUSING FROM BASEPLATE.
- 3. REMOVE DUMMY WINDOW IN CLOCK OPENING AND REPLACE WITH CLEAR WINDOW FOR CLOCK. RETURN DUMMY TO STOCK.
- 4. MOUNT CLOCK AS SHOWN IN FIG. I WITH 2- #6-32X3/8 SCR. & L'WASH.
- 5. ROUTE WIRES FROM CLOCK UNDER PWB AS SHOWN IN FIG. 2
  DO NOT ROUTE THRU CABLE CLAMP OR SPOT TIE TO OTHER WIRING.
- 6. REMOVE 2- #6 SCREWS AND AC COVER.
- SOLDER ONE BLACK AND WHITE WIRE TO XFIIOI-2 AND THE OTHER BLACK AND WHITE WIRE TO TBI-2.
- REMOVE NUT FROM GI. PLACE LUG FROM GREEN WIRE ON GI FOLLOWED BY L'WASH. THEN RE-ASSEMBLE NUT.
- 9. RE-ASSEMBLE UNIT.

## **INSTALLATION INSTRUCTIONS**

12 HOUR OR 24 HOUR CLOCKS (OPTIONS 8534, 8535, 8568 & 8569)

Issue 4





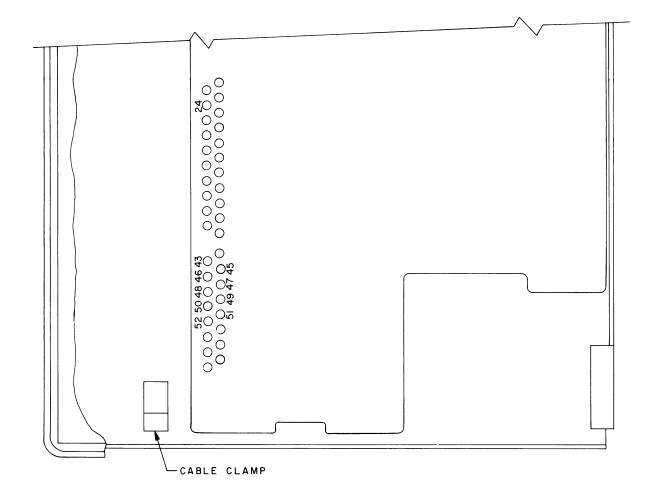
#### PARTS LIST

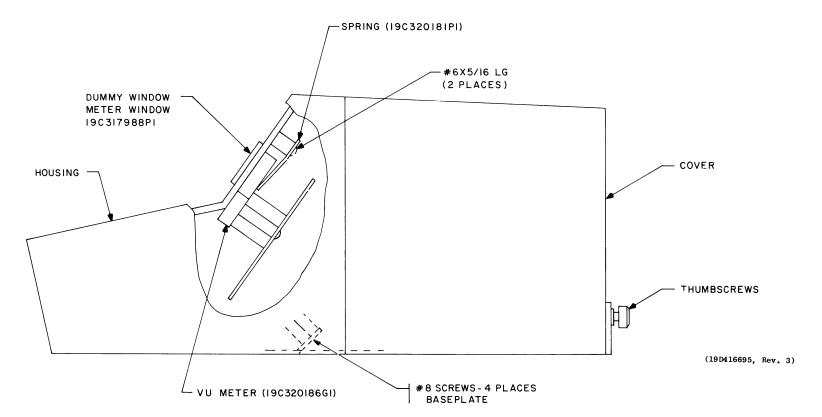
#### LBI-4677

| MODIFICATION CLOCK KITS | 19A129372G1 | 12 HOUR | 60 CYCLE | 19A129372G2 | 24 HOUR | 60 CYCLE | 19A129372G3 | 12 HOUR | 50 CYCLE | 19A129372G4 | 24 HOUR | 50 CYCLE |

SYMB0L	GE PART NO.	DESCRIPTION
		INDICATING DEVICES
мі	7491080P1	Clock, digital: 117 v, 60 Hz; sim to Pennwood Numechron 1P-12H.
<b>M</b> 2	7491080P9	Clock, digital: 117 v, 60 Hz; sim to Pennwood Numechron STD-24H.
<b>M</b> 3	7491080P5	Clock, digital: 117 v, 50 Hz; sim to Pennwood Numechron 1P-12H.
M4	7491080P10	Clock, digital: 117 v, 50 Hz; sim to Pennwood Numechron STD-24H.
	19B219654Gl	Clock frame. (12 hour clock).
	19B219654G2	Clock frame. (24 hour clock).
l		
1		

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES





THESE INSTRUCTIONS COVER THE INSTALLATION OF MODIFICATION KIT PL19A129382GI FOR MODIFYING MASTR CONTROLLER TO PROVIDE VU METER.

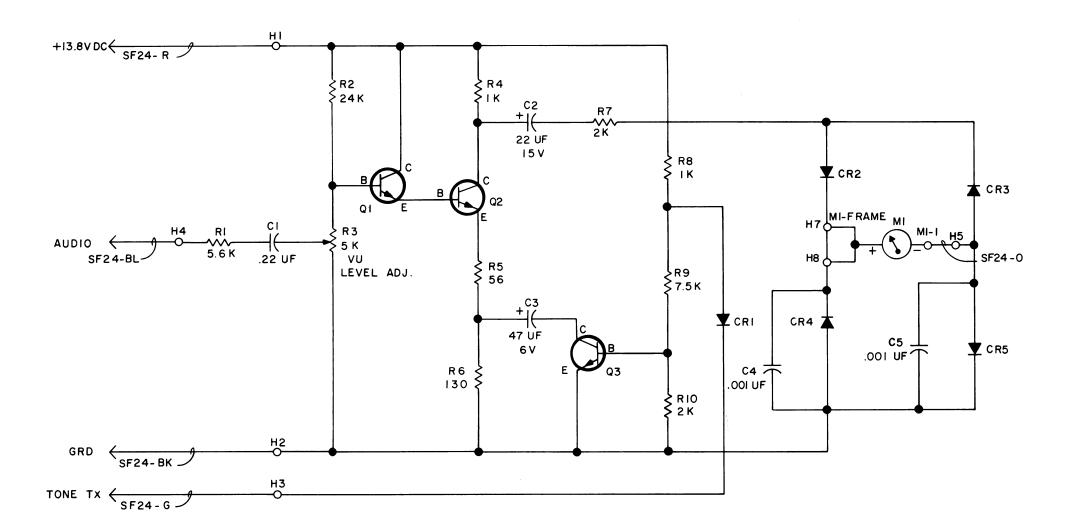
(1)

#### INSTALLATION INSTRUCTIONS:

- 1. LOOSEN THUMBSCREWS ON REAR OF UNIT AND REMOVE COVER.
- REMOVE 4- #8 SCREWS FROM BASEPLATE AND REMOVE HOUSING FROM BASEPLATE.
- 3. REMOVE DUMMY WINDOW AND INSERT METER WINDOW. RETURN DUMMY WINDOW TO STOCK.
- INSTALL SPRING (19C320181P1) LOOSELY WITH 2-#6 SCREWS AS SHOWN.
- INSTALL VU METER (19C320186G1) UNDER SPRING AND TIGHTEN SPRING HDW.
- 6. ROUTE WIRES THROUGH CABLE CLAMP.
  CONNECT THE GREEN WIRE TO JIIII 45
  CONNECT THE BLUE WIRE TO JIIII 43
  CONNECT THE BLACK WIRE TO JIIII 46 52
  CONNECT THE RED WIRE TO JIIII 24
- 7. RE-ASSEMBLE UNIT.

## **INSTALLATION INSTRUCTIONS**

VU METER KIT (OPTION 8529)



SEE APPLICABLE PRODUCTION CHANGE SHEETS IN INSTRUCTION BOOK SECTION DEALING WITH THIS UNIT, FOR DESCRIPTION OF CHANGES UNDER EACH REVISION LETTER.

THIS ELEM DIAG APPLIES TO

MODEL NO

REV LETTER

PL19C320186G1

ALL RESISTORS ARE 1/4 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K=1000 OHMS OR MEG = 1,000,000 OHMS OCAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED BY UF = MICROFARADS. INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH= MILLIHENRYS OR H= HENRYS.

**PRODUCTION CHANGES** 

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts

affected by these revisions.

19C320186G1

Rev. A - To improve performance. Changed Q3.

IN ORDER TO RETAIN RATED EQUIPMENT PERFORMANCE, REPLACEMENT OF ANY SERVICE PART SHOULD BE MADE ONLY WITH A COMPONENT HAVING THE SPECIFICATIONS SHOWN ON THE PARTS LIST FOR THAT PART.

## **SCHEMATIC DIAGRAM**

(19C320231, Rev. 2)

VU METER KIT (OPTION 8529)

## 66

#### Issue 3

#### PARTS LIST

LBI-4474A VU METER KIT 19A129382G1

SYMB0L	GE PART NO.	DESCRIPTION
		COMPONENT BOARD 19C320186G1
C1	19A116080P109	Polyester: 0.22 $\mu$ f $\pm 10\%$ , 50 VDCW.
C2	5496267P10	Tantalum: 22 $\mu f$ $\pm 20\%$ , 15 VDCW; sim to Sprague Type 150D.
С3	5496267P2	Tantalum: 47 $\mu f$ $\pm 20\%,$ 6 VDCW; sim to Sprague Type 150D.
C4 and C5	5494481P111	Ceramic disc: 1000 pf $\pm 20\%$ , 1000 VDCW; sim to RMC Type JF Discap.
		DIODES AND RECTIFIERS
CR1	19A115250P1	Silicon.
CR2 thru CR5	4038056P1	Germanium.
Ml	19A116729P1	Panel DC: 200 µa mechanism; sim to Jewell Instruments 20504003-032.
Q1 and Q2	19A115889P1	Silicon, NPN; sim to Type 2N2712.
Q3*	19A115720P1	Silicon, NPN; sim to Type 2N2222.
		Earlier than REV A:
	19A115552P1	Silicon, NPN; sim to Type 2N2714.
		RESISTORS
R1	3R152P562J	Composition: 5600 ohms ±5%, 1/4 w.
R2	3R152P243J	Composition: 24,000 ohms ±5%, 1/4 w.
R3	19B209358P105	Variable, carbon film: approx 75 to 5000 ohms ±10%, 0.25 w; sim to CTS Type X-201.
R4	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.
R5	3R152P560J	Composition: 56 ohms $\pm 5\%$ , $1/4$ w.
R6	3R152P131J	Composition: 130 ohms ±5%, 1/4 w.
R7	3R152P202J	Composition: 2000 ohms ±5%, 1/4 w.
R8	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.
R9	3R152P752J	Composition: 7500 ohms ±5%, 1/4 w.
R10	3R152P202J	Composition: 2000 ohms ±5%, 1/4 w.
	1	

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

-

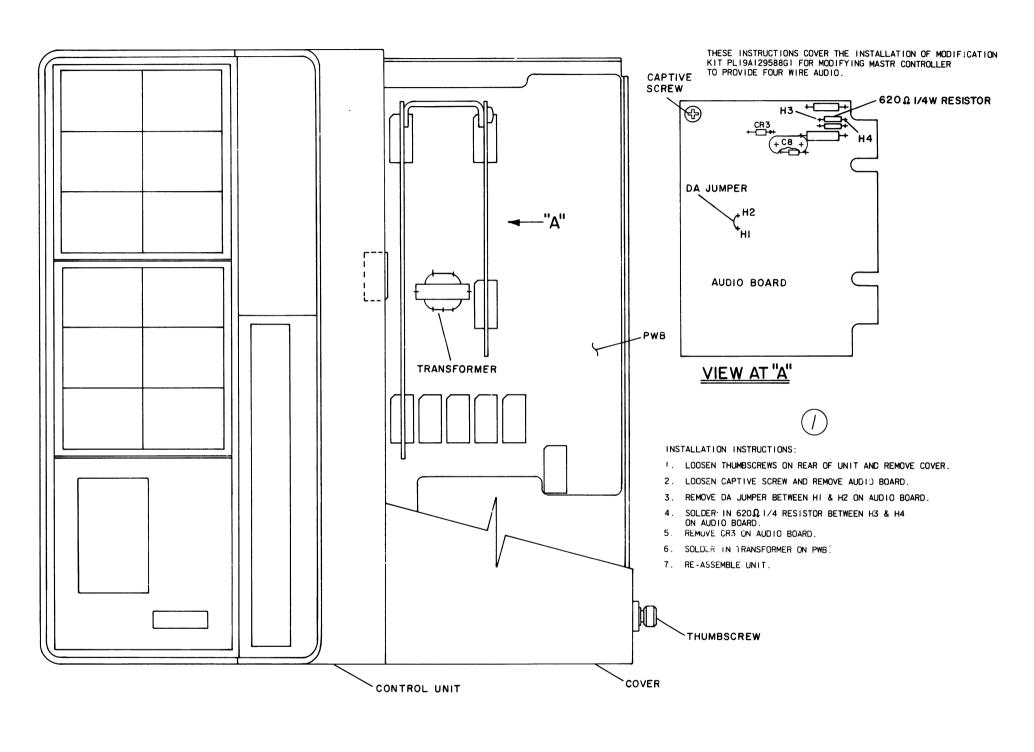
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-

LBI-4476

WIRE AUDIO KIT 19A129588G1

SYMBOL	GE PART NO.	DESCRIPTION
R1	3R152P621J	Composition: 620 ohms ±5%, 1/4 w.
T1	5491609P1	l .
		Audio: 0.3-3 KHz freq range, 6 VDC operating, Pri: 500 ohms ±10% imp CT, 29 ohms ±10% DC res, Sec: 500 ohms ±10% imp, 22 ohms ±10% DC res.
		1



(19C320425, Rev. 4)

## **INSTALLATION INSTRUCTIONS**

FOUR WIRE AUDIO KIT (OPTION 8553)

Issue 4

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\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

CONTROL UNIT

(19C320470, Sh. 1, Rev. 4)

## **INSTALLATION INSTRUCTIONS**

AUDIO LINE COMPENSATION KIT (OPTION 8532)

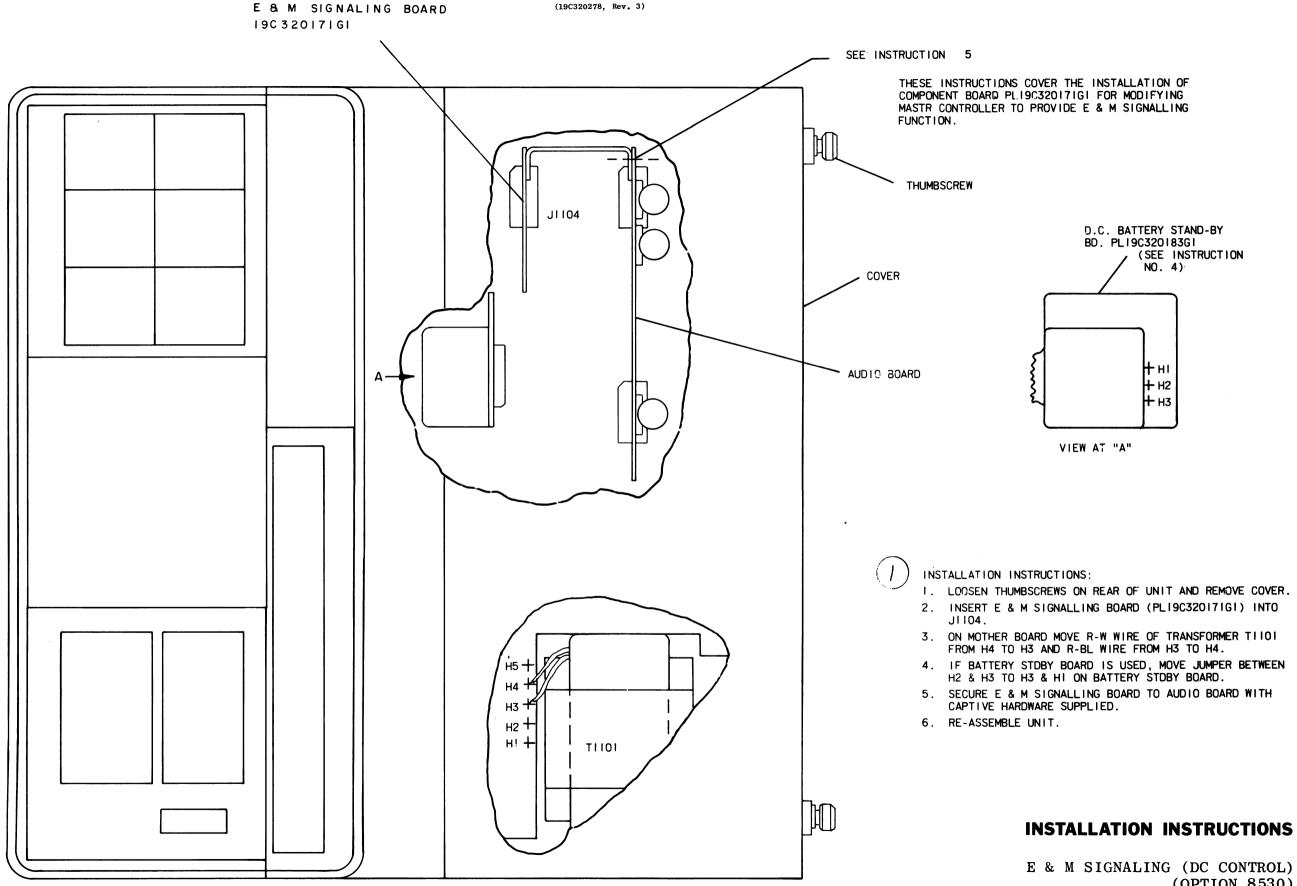
68 Issue 4

#### PARTS LIST

LBI-4469

LINE COMPENSATION KIT 19A129317G1

SYMBOL	GE PART NO.	DESCRIPTION
C1701	19A116080P204	Polyester: 0.033 μf ±5%, 50 VDCW.
L1701	19B206972G73	
R1701	19B209358P106	
W1701	19A129525G2	
	:	



E & M SIGNALING (DC CONTROL) (OPTION 8530)

CR3

示.IUF

H4 ▲

VR3 5.4V

> R6 82

≤ 4.3K

VRI

24V

VR2 30 V

R I 2.2 K 2 W

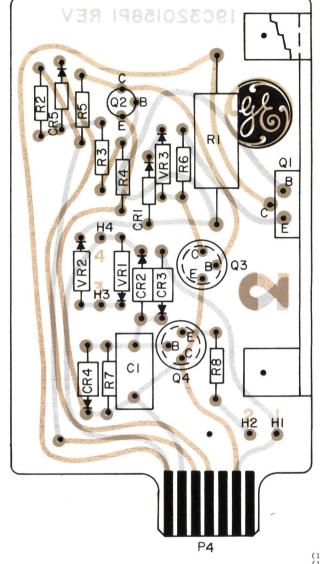
>R2

≤3.3K

≥ IOK

\$R4 {2.2K

(19C320227, Rev. 1)



P4

TYPICAL CONTACT FINGER NUMBERING

8 9 10 11 12 13 14

7 6 5 4 3 2 1

SERVICE SHEET

DC. CONTROL E & M. SIGNALING BOARD

Issue 3

SOLDER SIDE

DC CONTROL E & M SIGNALING BOARD (OPTION 8530)

70

# •

P4

CONTROL VOLTAGE | 13 ∠

HV-

HV +

+13.8V DC

GRD

CONTROL VOLTAGE



IN-LINE TRIANGULAR
VIEW FROM LEAD END

E: LEAD ARRANGEMENT, AND NOT

FOR Q2, Q3 8 Q4

LEAD IDENTIFICATION

NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

ALL RESISTORS ARE 1/4 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K=1000 OHMS OR MEG=1,000,000 OHMS CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED BY UF= MICROFARADS. INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH= MILLIHENRYS OR H=HENRYS.

R8

620

SEE APPLICABLE PRODUCTION CHANGE SHEETS IN INSTRUCTION BOOK SECTION

DEALING WITH THIS UNIT, FOR DES-CRIPTION OF CHANGES UNDER EACH

THIS ELEM DIAG APPLIES TO

REV LETTER

REVISION LETTER.

PL19C320171G1

MODEL NO

H2 ▲

▲ NOTE:

FOR 24 V DC OPERATION
CONNECT JUMPERS BETWEEN
HI & H2 AND BETWEEN H3 & H4

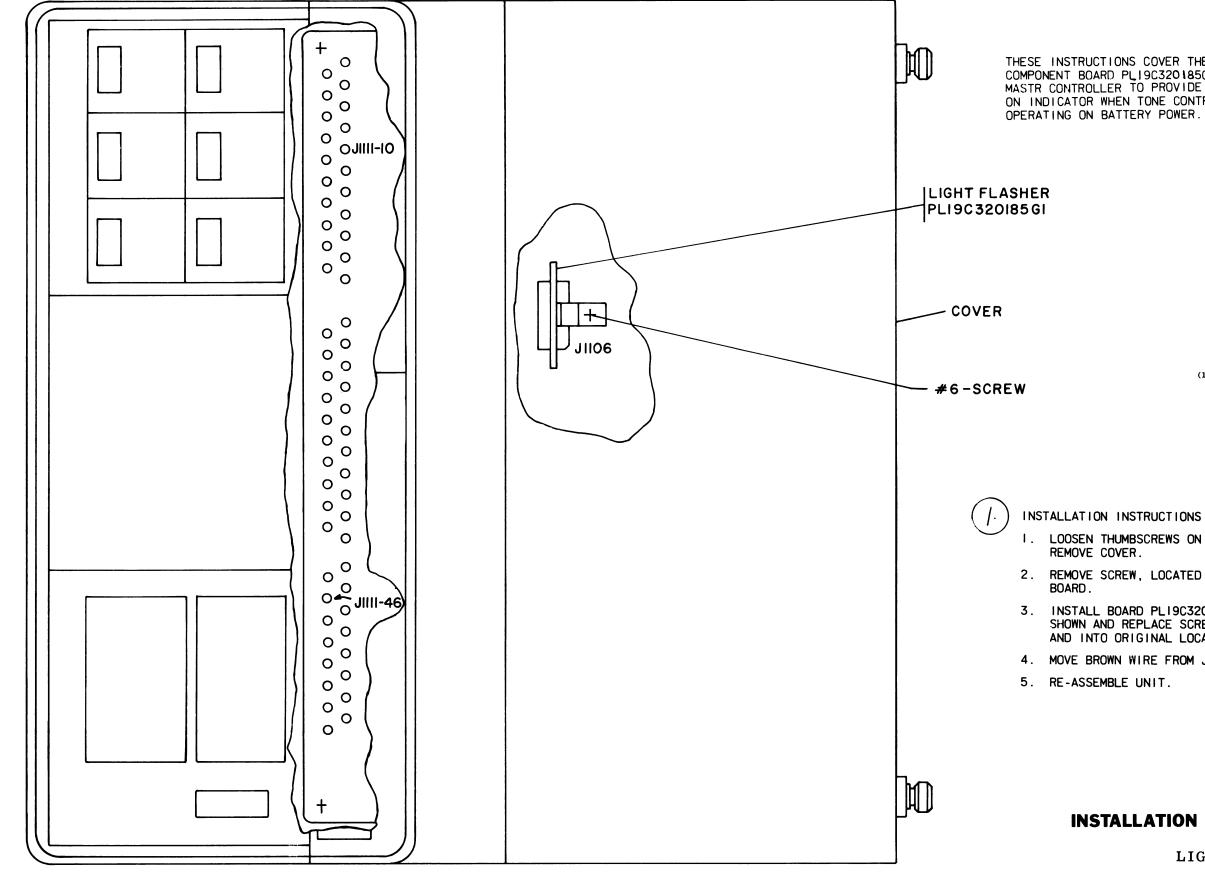
#### PARTS LIST

LBI-4457

E/M SIGNALING BOARD 19C320171G1

SYMBOL	GE PART NO.	DESCRIPTION
C1	19A116080P7	Polyester: 0.1 µf ±20%, 50 VDCW.
		DIODES AND RECTIFIERS
CR1	19A115250P1	Silicon.
CR2 thru CR4	4037822P2	Silicon,
CR5	19A115250P1	Silicon.
P4		(Part of printed wiring board, 19C320158P1).
Q1	19A129183P1	Silicon, NPN.
Q2	19A115889P1	Silicon, NPN; sim to Type 2N2712.
Q3 and Q4	19A115300P1	Silicon, NPN; sim to Type 2N3053.
		RESISTORS
Rl	3R79P222J	Composition: 2200 ohms ±5%, 2 w.
R2	3R152P332J	Composition: 3300 ohms $\pm 5\%$ , $1/4$ w.
R3	3R152P103J	Composition: 10,000 ohms $\pm 5\%$ , $1/4$ w.
R4	3R152P222J	Composition: 2200 ohms $\pm 5\%$ , $1/4$ w.
R5	3R152P432J	Composition: 4300 ohms $\pm 5\%$ , $1/4$ w.
R6	3R152P820J	Composition: 82 ohms $\pm 5\%$ , $1/4$ w.
R7	3R152P912J	Composition: 9100 ohms ±5%, 1/4 w.
R8	3R152P621J	Composition: 620 ohms $\pm 5\%$ , $1/4$ w.
		VOLTAGE REGULATORS
VR1	4036887P19	Silicon, Zener.
VR2	4036887P21	Silicon, Zener.
VR3	4036887P5	Silicon, Zener.
	1	1

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.



THESE INSTRUCTIONS COVER THE INSTALLATION OF COMPONENT BOARD PLI9C320185GI FOR MODIFYING MASTR CONTROLLER TO PROVIDE FLASHING POWER ON INDICATOR WHEN TONE CONTROL SYSTEMS ARE

(19C320287, Rev. 3)

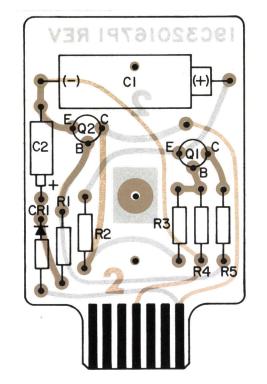
- 1. LOOSEN THUMBSCREWS ON REAR OF UNIT AND
- 2. REMOVE SCREW, LOCATED NEXT TO JIIO6, FROM
- 3. INSTALL BOARD PL19C320185GI IN LOCATION SHOWN AND REPLACE SCREW THRU BRACKET AND INTO ORIGINAL LOCATION.
- 4. MOVE BROWN WIRE FROM JIIII-46 TO JIIII-10.

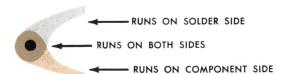
## **INSTALLATION INSTRUCTIONS**

LIGHT FLASHER KIT (OPTION 8545)

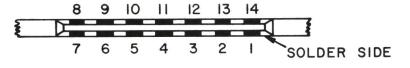
71

#### **OUTLINE DIAGRAM**



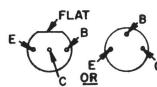


#### TYPICAL CONTACT FINGER NUMBERING



(19C320705, Rev. 0) (19C320167, Sh. 2, Rev. 2) (19C320167, Sh. 3, Rev. 2)

#### LEAD IDENTIFICATION FOR QI & Q2



IN-LINE TRIANGULAR VIEW FROM LEAD END

NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

# **SERVICE SHEET**

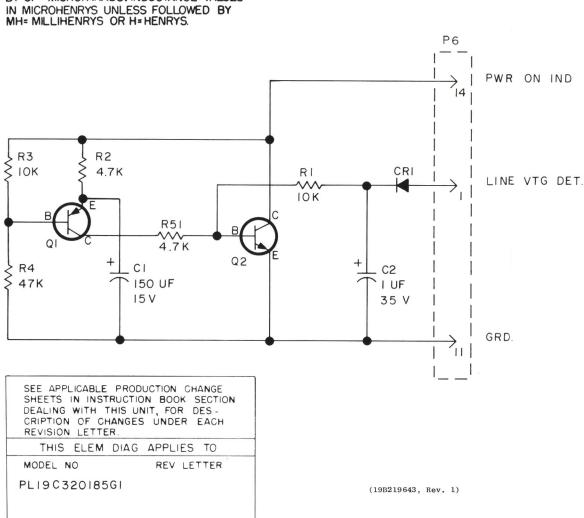
LIGHT FLASHER BOARD (OPTION 8545)

72

Issue 3

### SCHEMATIC DIAGRAM

ALL RESISTORS ARE 1/4 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K=1000 OHMS OR MEG = 1,000,000 OHMS OCAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED BY UF = MICROFARADS. INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH= MILL HENRYS OR H= HENRYS



IN ORDER TO RETAIN RATED EQUIPMENT PERFORMANCE, REPLACEMENT OF ANY SERVICE PART SHOULD BE MADE ONLY WITH A COMPONENT HAVING THE SPECIFICATIONS SHOWN ON THE PARTS LIST FOR THAT PART.

#### PARTS LIST

LBI-4461

LIGHT FLASHER

SYMBOL	GE PART NO.	DESCRIPTION
C1	5496267P12	Tantalum: 150 $\mu$ f $\pm 20\%$ , 15 VDCW; sim to Sprague Type 150D.
C2	5496267P17	Tantalum: 1.0 $\mu f$ $\pm 20\%$ , 35 VDCW; sim to Sprague Type 150D.
		DIODES AND RECTIFIERS
CR1	19A115250P1	Silicon.
P6		(Part of printed wiring board, 19C320167Pl).
Q1	19A115768P1	Silicon, PNP; sim to Type 2N3702.
Q2	19A115889P1	Silicon, NPN; sim to Type 2N2712.
		RESISTORS
R1	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.
R2	3R152P472J	Composition: 4700 ohms $\pm 5\%$ , $1/4$ w.
R3	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.
R4	3R152P473J	Composition: $47,000$ ohms $\pm 5\%$ , $1/4$ w.
R5	3R152P472J	Composition: 4700 ohms $\pm 5\%$ , $1/4$ w.
	•	•

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

CABLE CLAMP PRINTED WIRE BOARD THUMBSCREW HOOKSWITCH SCREW #8X11/2 LONG \_\_COVER AIIOI MASTR CONTROLLER (19D416928, Rev. 2)

THESE INSTRUCTIONS COVER THE INTERCONNECTIONS HOOKSWITCH, HANDSET TO MASTR CONTROLLER.

#### INSTRUCTIONS

- LOOSEN THUMB SCREW ON REAR OF CONTROL UNIT AND REMOVE COVER.
- 2. ROUTE WI THRU CABLE CLAMP AS SHOWN.
- 3. CLIP JUMPER BETWEEN HI8 & HI9 OF AIIOI.
- 4. COMPLETE WI CONNECTIONS TO MASTR CONTROLLER PER CONNECTIONS CHART.
- 5. RE-ASSEMBLE UNIT.
- MOUNT HOCKSWITCH AS DESIRED WITH (2)
   #8 X I 1/2 LG SCREWS SUPPLIED.

CONNECTIONS CHART					
WIRE	TO				
WI-N22-W	TB1101-17				
WI-N22-BL	TB1101-24				
WI-N22-BR	TB1101-25				
WI-N22-R	TB1101-23				
WI-N22-G	TB1101-21				
W1-N22-BK	TB1101-22				

# INSTALLATION INSTRUCTIONS

HANDSET HOOKSWITCH (OPTIONS 8542 & 8543)

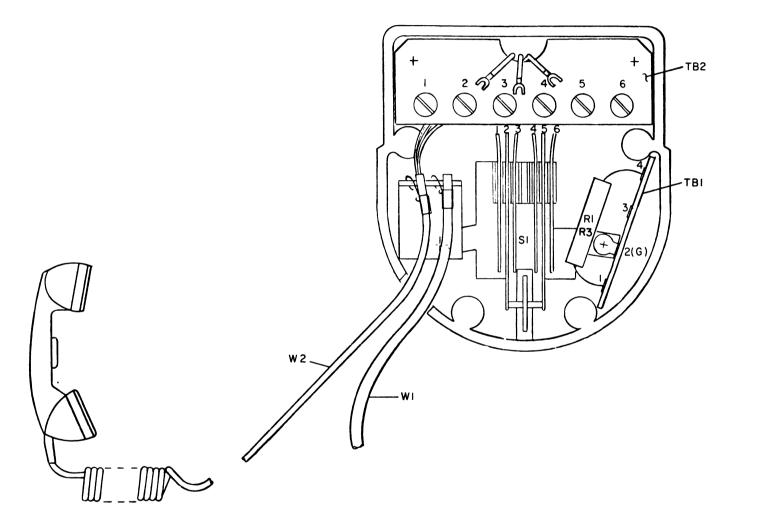
DESCRIPTION

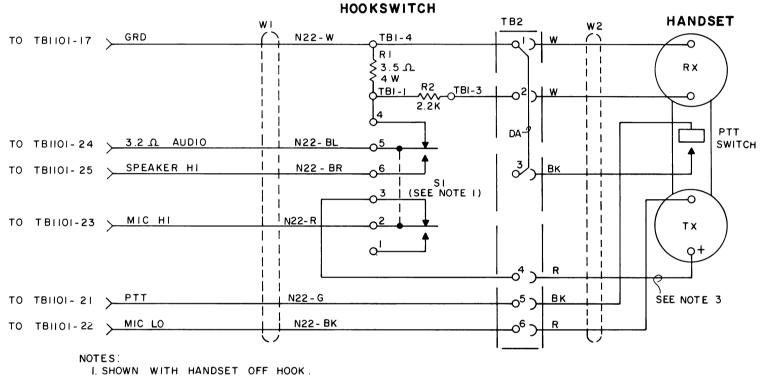
SYMBOL

GE PART NO.

## **OUTLINE DIAGRAM**

# SCHEMATIC DIAGRAM





- 2. UNLESS OTHERWISE SPECIFIED, ALL
- WIRE IS N22.
- 3. RED WIRE WITH WHITE BANDS NEAR TERMINAL MUST CONNECT TO TB2-4

(19C320716, Rev. 1)

(19B219863, Rev. 2)

# **SERVICE SHEET**

HANDSET HOOKSWITCH (OPTIONS 8542 & 8543)

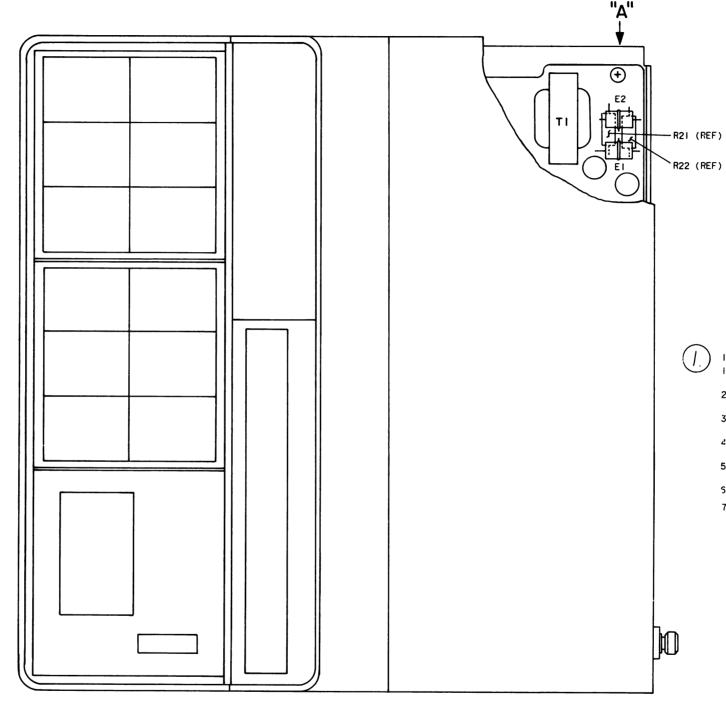
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į į		RESISTORS
R1	5493035P10	Wirewound: 3.5 ohms ±5%, 5 w; sim to Hamilton Hall Type HR.
R2	3R77P222K	Composition: 2200 ohms ±10%, 1/2 w.
		TERM INAL BOARDS
TB1	7775500P10	Phen: 4 terminals.
TB2	19B219866G1	Terminal board: 6 terminals.
W1	19B219865G1	Cable: approx 5 feet long.
ı		
		HANDSET 19A116792P3 (BLACK)
		Transmitter cartridge. Shure Brothers RP117.
ı	Ì	Receiver cartridge. ITT P75547.
W2		Cable. Telephone Components TP-601 BLACK.
		Switch. Telephone Components 741-SA. (Includes 4 springs in housing with soldered on leads).
		Case. Telephone Components 74-H-01. (Less Receiver and Transmitter caps).
		Receiver Cap. Telephone Components 74-R-01.
		Transmitter Cap. Telephone Components 74-T-01.
		MISCELLANEOUS
	19A121612P1	Handset holder. (Includes S1).
	N113P1524P2	Tap screw: No. 8-15 x 1-1/2.
1		14p 5010W. No. 0 10 x 1 1/2.
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*COMPON	IENTS ADDED, DE	LETED OR CHANGED BY PRODUCTION CHANGES

LBI-30494

TELEPHONE LINE SURGE PROTECTION KIT 19A136911G1

SYMBOL	GE PART NO.	DESCRIPTION		
El and E2	19A134356Pl	TELEPHONE PROTECTORS Telephone protector: 250-350 VDC breakdown to ground, 700 VDC breakdown Line to Line; sim to JOSLYN 2022-24.		



(19C320272, Rev. 6)

THESE INSTRUCTIONS COVER THE INSTALLATION OF MODIFICATION KIT PLI9AI3691IGI FOR MODIFYING MASTR CONTROLLER TO PROVIDE TELEPHONE LINE. VOLTAGE SURGE PROTECTION.

VIEW "A" ROTATED 180 ASM. AS SHOWN SO BODY OF COMPONENTS DO NOT TOUCH PW BOARD.

#### INSTALLATION INSTRUCTIONS

- I. LOOSEN THUMBSCREWS ON REAR OF UNIT AND REMOVE
- 2. REMOVE 4-#8 SCREWS FROM BASE PLATE AND REMOVE HOUSING FROM BASE PLATE.
- 3. REMOVE ALL SCREWS FROM COMPONENT SIDE OF PWB AND REMOVE PWB FROM BASE PLATE.
- 4. SOLDER EI, AND E2 (19A134356PI) IN PWB AS SHOWN.
- 5. TRIM LEADS ON EI AND E2 TO .09 MAX. ON SOLDER SIDE OF PWB.
- REASSEMBLE UNIT.
- 7. THE EFFECTIVENESS OF THE LINE PROTECTORS IS DEPENDENT UPON A GOOD EARTH GROUND. THE GROUND CONNECTION SHOULD BE MADE WITH A SINGLE #14 AWG OR LARGER COPPER CONDUCTOR AND SHOULD BE CONNECTED TO THE GROUND SIDE OF THE PROTECTORS AT THE BOARD MOUNTING SCREW. THE CONDUCTOR SHOULD BE SHORT, STRAIGHT AND A CONTINUOUS PIECE OF WIRE.

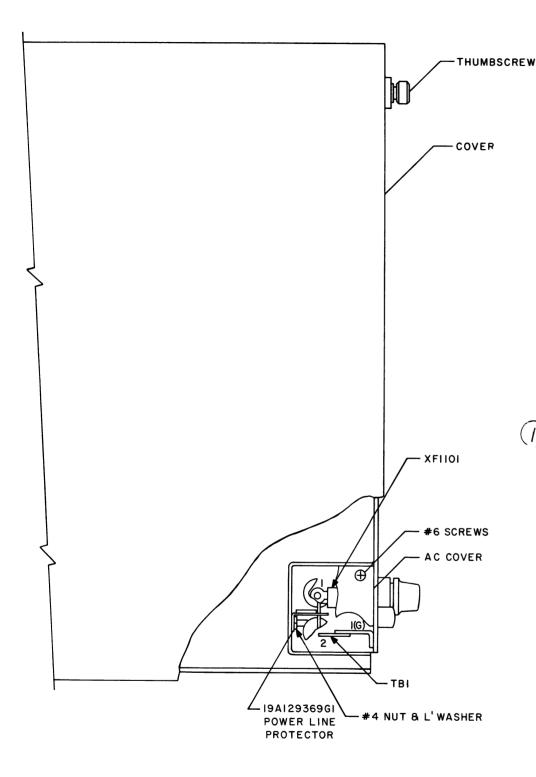
PROVIDE THE LOWEST POSSIBLE RESISTANCE AT THE CONNECTORS AT EACH END OF THE GROUND WIRE.

# **INSTALLATION INSTRUCTIONS**

(OPTION 8531)

**7**5

TELEPHONE LINE SURGE PROTECTION



THESE INSTRUCTIONS COVER THE INSTALLATION OF MODIFICATION KIT PL19A129370G1 FOR MODIFYING MASTR CONTROLLER TO PROVIDE POWER LINE VOLTAGE SURGE PROTECTION.

) INSTALLATION INSTRUCTIONS:

- 1. LOOSEN THUMB SCREWS ON REAR OF UNIT AND REMOVE COVER.
- REMOVE 2- #6 SCREWS FROM AC COVER AND REMOVE COVER.
- INSTALL POWER LINE PROTECTOR (19A129369G1) WITH #4 HDW. AS SHOWN. DISCARD EXTRA HDW.
- 4. SOLDER ONE VI8-RED WIRE TO XF1101-1 AND SOLDER THE OTHER VI8-RED WIRE TO TB1-2.
- RE-ASSEMBLE UNIT.

(19C320273, Sh. 1, Rev. 4)

# **INSTALLATION INSTRUCTIONS**

POWER LINE SURGE PROTECTION (OPTION 8556)

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Issue 5

#### **PARTS LIST**

LBI-4471A

THYRACTOR KIT 19A129370G1

SYMBOL	GE PART NO.	DESCRIPTION
		DIODES AND RECTIFIERS
CR1	19A116062P1	Selenium.
		TERM INAL BOARDS
тві	7775500P14	Phen: 4 terminals.
	N80P9005C6	Screw, phillips: panhead, No. 4-40 x 5/16.
	7141225P2	Hexnut: No. 4-40.
	N40P11C6	Lockwasher, internal tooth: No. 4.
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\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.

#### PARTS LIST

LBI-4479B

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.

		LBI-4479B			N529P20C13	Plug button. (Used with R1-R2).
		HEADSET ADAPTOR KIT			7115130P11	Lockwasher: sim to Shakeproof 1222-1. (Used
		19A129002G2		1	4033394Pl	with S1).  Knurled nut: No. 15/32. (Used with S1).
					7127662P2	Flatwasher: 5/8 dia. (Used with S1).
SYMBOL	GE PART NO.	DECODIDATION			7115195P2	Hexnut: No. 15/32-32. (Used with S1).
STWDOL	GE FART NO.	DESCRIPTION	]		NP270466	Nameplate.
					19A128163P1	Insulator board. (Used with Jl, and J2).
		ADAPTOR BOX 19C317786G2			N80P9009C6	Screw, phillips, recessed pan head: No. 4-40 x 5/16. (Used with W2 clip loop, J1, J2). mounting).
					N402P5C5	Flatwasher: No. 4. (Used with W2 clip loop).
C1	5496267P20	Tantalum: 47 µf ±20%, 35 VDCW; sim to Sprague Type 150D.			4029851P5	Clip loop, nylon: sim to Weckesser 1/4-4-128. (Used to secure W2 externally).
C2 and C3	19A115680P12	Electrolytic: 100 µf +150% -10%, 30 VDCW; sim to Mallory Type TTX.			7142162P56	Spacer. (Used when clearance between Adaptor box and mounting surface is desired).
		JACKS AND RECEPTACLES			N196P812C13	Round head, slotted: No. 8 x 3/4. (Used when mounting Adaptor box to Wood.
J1 and J2	5493473P11	Jack, panel: 3 conductors; sim to Switchcraft MT-335.			19B201074P404	Tap screw, Phillips POZIDRIV <sup>®</sup> : No. 8-32 x 1/4. (Used when mounting Adaptor box to Metal).
		RESISTORS			19A116578P1 19A116579P1	Earpiece (Option 5228).  Headband (Option 5229).
R1 R2	5491537P14 5494774P101	Variable, carbon film: 250 ohms ±20%, 0.3 w; sim to CTS Series 70.			19411637991	neadband (Option 5229).
R2	5494774P101	Variable, carbon film: 250 ohms ±20%, 0.3 w; sim to CTS Series 70 Control.				
R3	3R77P470J	Composition: 47 ohms ±5%, 1/2 w.	П			
R6	5493035P10	Wirewound: 3.5 ohms $\pm 5\%$ , 5 w; sim to Hamilton Hall Type HR.	П			
R7 and R8	3R77P101J	Composition: 100 ohms ±5%, 1/2 w.				
		SWITCHES	ıI			
S1	5491899P1	Toggle: SPDT, 3 amps at 125 VAC/VDC; sim to Cutler-Hammer 8382K13.				
		TERM INAL BOARDS	П			
TB1	7775500P23	Phen: 7 terminals.				
W2	19C317809G2	Cable, RF: approx 9 feet long. Includes:	Ιl			
	4029840P2	Contact, electrical: sim to Amp 42827-2. Quantity (8).	П			
	19B209260P103	Terminal, solderless: sim to AMP 60495-1. Quantity (8).				
		EYELET BOARD 19A129003G1				
			i			
Jl thru J4	4033513P4	Contact, electrical: sim to Bead Chain L93-3.				
		MISCELLANEOUS	Н			
	4035656P7	Spacer, threaded: thd size No. 4-40. (Used				
	19A128187G1	with eyelet board).  Cover. (Adaptor box).				
	19C317785P1	Base plate. (Adaptor box).				
	19B201074P304	Tap screw, Phillips POZIDRIV $^{\circ}$ : No. 6-32 x 1/4. (Secures Cover to Base).				
	5490407P6	Grommet, rubber. (Used with W2).				
	4029851P6	Clip loop: nylon, sim to Weckesser 5/16-4-128. (Used with W2).				
	19A115729P4	Flat washer. (Used with R1-R2).				
	19A116296P1	Knob, push on: sim to Rohden Mfg Co. 26600-35S. (Used with R1-R2).				

GE PART NO.

SYMBOL

DESCRIPTION

NOTE:
I. MOVE THE EXISTING MIC HI
LEAD FROM TBIIOI-23 TO TBIIOI-26.
(THIS TERMINAL WILL SERVE AS
A TIE POINT FOR SWITCHING
FROM THE EXISTING MIC TO
THE HEADSET MIC.) —€ TBH02-22 MIC LO —C TB1102-22 MIC LO TBIIOI-25 SPKR HI

TBIIOI-24 3.2Ω AUDIO N22-R N22-0 C TBIIOI-17 GND IN ORDER TO RETAIN RATED EQUIPMENT PERFORMANCE, REPLACEMENT OF ANY SERVICE PART SHOULD BE MADE ONLY WITH SEE APPLICABLE PRODUCTION CHANGE SHEETS IN INSTRUCTION BOOK SECTION DEALING WITH THIS UNIT, FOR DES-CRIPTION OF CHANGES UNDER EACH REVISION LETTER.

THIS ELEM DIAG APPLIES TO A COMPONENT HAVING THE SPECIFICATIONS SHOWN ON THE PARTS LIST FOR THAT PART. ALL RESISTORS ARE 1/2 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K=1000 O'N OHMS OR MEG = 1,000,000 OHMS OCAPACITOR VALUES IN POOFARADS FEQUAL TO MICROMICROFARADS, UNLESS FOLLOWED BY UF= MICROFARADS. INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH= MILLIHENRYS OR H= HENRYS. MODEL NO PL19C317786G2 REV LETTER

(19B219809, Rev. 3)

THESE INSTRUCTIONS COVER THE INSTALLATION OF HEADSET ADAPTOR BOX KIT, PL19A129002G2, TO MASTR CONTROLLER. INSTALLATION INSTRUCTIONS: LOOSEN THUMBSCREWS ON REAR OF UNIT AND REMOVE COVER. 2. MOVE THE EXISTING MIC HI LEAD FROM TBIIOI-23
TO TBIIOI-26(THIS TERMINAL WILL SERVE AS
A TIE POINT FOR SWITCHING FROM THE
EXISTING MIC TO THE HEADSET MIC). 26 3. CONNECT: W-G WIRE TO TBIIOI-23 (MIC HI)
W-R WIRE TO TBIIOI-26
BL WIRE TO TBIIOI-15(+13.5V) 25) SHIELD OF W-R TO TBIIOI-22(MIC LO) 24) SHIELD OF W-G TO TBIIOI-22(MIC LO)
W WIRE TO TBIIOI-25
R WIRE TO TBIIOI-24 ( TBIIOI O WIRE TO TBIIOI-17(GND) 4. REASSEMBLE UNIT. 22 5. MOUNT HEADSET ADAPTOR BOX WITH HARDWARE SUPPLIED. HEADSET ADAPTOR BOX PL19C317786G2 THUMBSCREW - COVER MASTR CONTROLLER

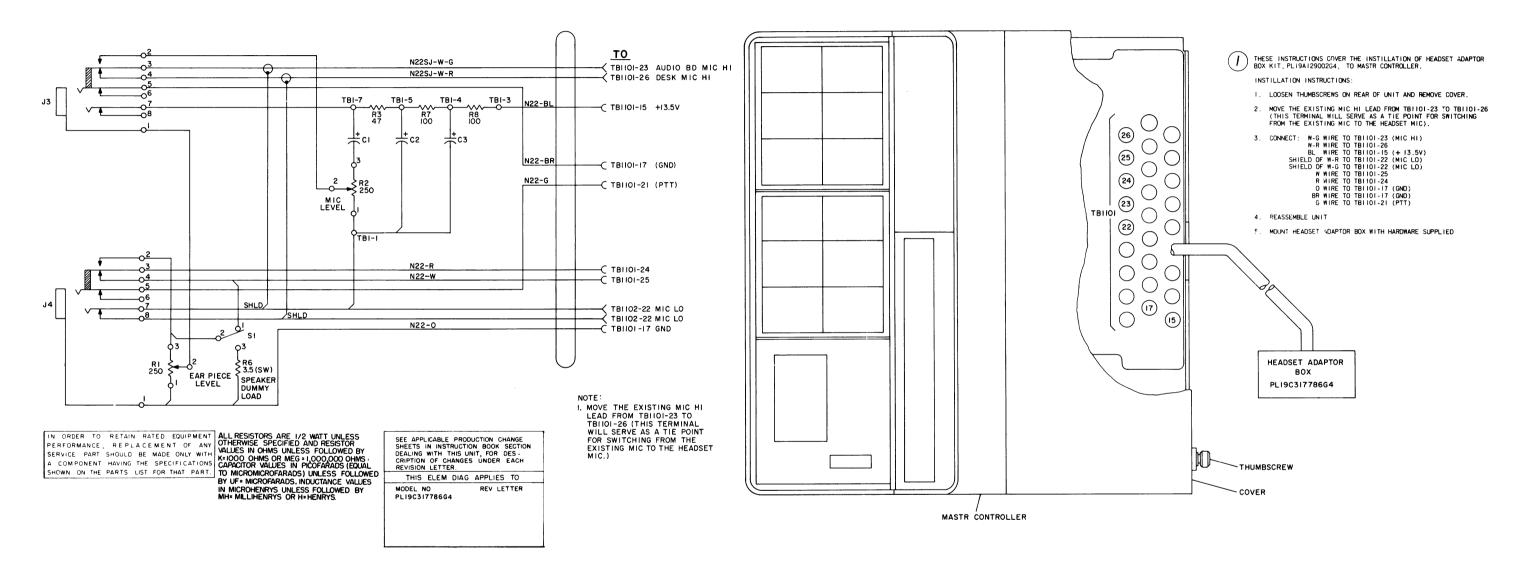
(19C320407, Rev. 2)

# **SERVICE SHEET**

HEADSET ADAPTOR KIT (OPTION 8546)

Issue 6

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(19C320805, Rev. 3)

(19C320804, Rev. 2)

# **SERVICE SHEET**

HEADSET ADAPTOR KIT (OPTION 8575)

**7**8 Issue 4

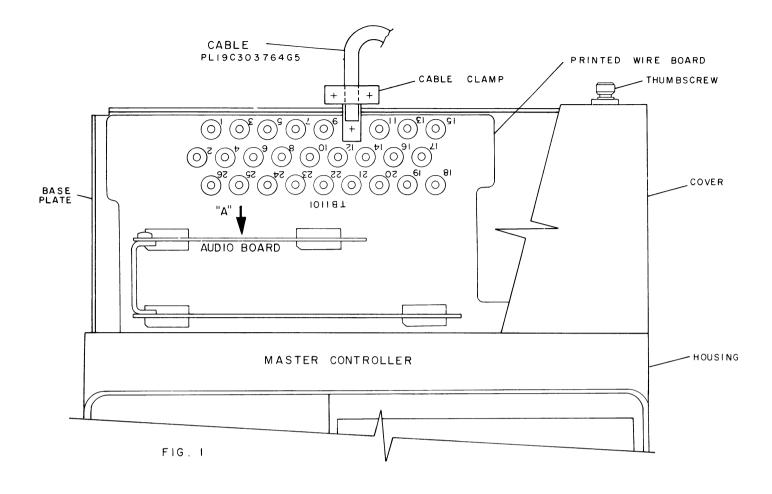
#### PARTS LIST

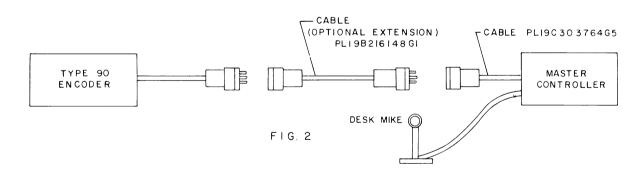
LBI-4636A

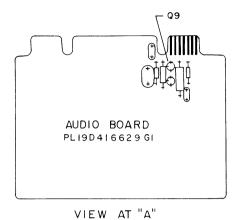
HEADSET ADAPTER KIT 19A129002G4

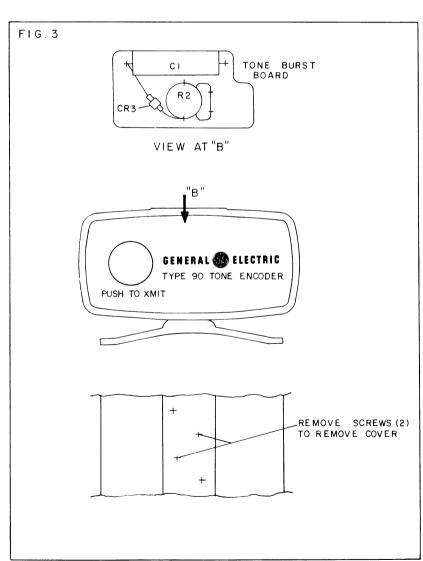
SYMBOL	GE PART NO.	DESCRIPTION
		ADAPTOR BOX 19C317786G4
c1	5496267P20	Tantalum: 47 $\mu f$ ±20%, 35 VDCW; sim to Sprague Type 150D.
2 and 3	19A115680P12	Electrolytic: 100 µf +150% -10%, 30 VDCW; sim to Mallory Type TTX.
		JACKS AND RECEPTACLES
13 and 14	5493473P13	Jack, panel: 3 conductors; sim to Audio Devel Co. PJ-280.
		RESISTORS
R1	5491537P14	Variable, carbon film: 250 ohms $\pm 20\%$ , 0.3 w; sim to CTS Series 70.
R2	5494774P101	Variable, carbon film: 250 ohms ±20%, 0.3 w; sim to CTS Series 70 Control.
R3 R6	3R77P470J	Composition: 47 ohms ±5%, 1/2 w.
R6	5493035P10	Wirewound: 3.5 ohms $\pm 5\%$ , 5 w; sim to Hamilton Hall Type HR.
R7 and R8	3R77P101J	Composition: 100 ohms ±5%, 1/2 w.
S1	5491899P1	Toggle: SPDT, 3 amps at 125 VAC/VDC; sim to
		Cutler-Hammer 8282K13.
		TERMINAL BOARDS
TBl	7775500P23	Phen: 7 terminals.
W4	19C320803G2	Cable: approx 9 feet long.
		EYELET BOARD 19A129003G2
		JACKS AND RECEPTACLES
J1 thru J4	4033513P4	Contact, electrical: sim to Bead Chain L93-3.
		MISCELLANEOUS
	4035656P7	Spacer, threaded: thd size No. 4-40. (Used
	19A128187G1	with eyelet board).  Cover. (Adaptor box).
	19C317785P1	Base plate. (Adaptor box).
	19B201074P304	Tap screw, Phillips POZIDRIV: No. 6-32 x 1/4.
	5490407P6	(Secures Cover to Base).  Grommet, rubber. (Used with W3).
	4029851P6	Clip loop: nylon, sim to Weckesser 5/16-4-128. (Used with W3).
	19A115729P4	Flat washer. (Used with R1-R2).
	19A116296P1	Knob, push on: sim to Rohden Mfg Co. 26600-35S. (Used with R1-R2).
	N529P20C13	Plug button. (Used with R1-R2).
	7115130P11	Lockwasher: sim to Shakeproof 1222-1. (Used
	4033394P1	with S1).  Knurled nut: No. 15/32. (Used with S1).

SYMBOL	GE PART NO.	DESCRIPTION
	7127662 <b>P</b> 2	Flatwasher: 5/8 dia. (Used with S1).
	7115195P2	Hexnut: No. $15/32-32$ . (Used with S1).
	NP270466 19A128163P1	Nameplate.
,	N80P9009C6	Insulator board. (Used with J3 and J4).
	Noorbooses	Screw, phillips, recessed pan head: No. 4-40 x $5/16$ . (Used with W3 clip loop, J3, J4 mounting).
1	N402P5C5	Flatwasher: No. 4. (Used with W3 clip loop).
	4029851P5	Clip loop, nylon: sim to Weckesser 1/4-4-128. (Used to secure W3 externally).
	7142162P56	Spacer. (Used when clearance between Adaptor box and mounting surface is desired).
	N196P812C13	Round head, slotted: No. 8 x 3/4. (Used when mounting Adaptor box to Wood.
	19B201074P404	Tap screw, Phillips POZIDRIV : No. 8-32 x $1/4$ . (Used when mounting Adaptor box to Metal).
	19A116578P3 19A116579P3	Earpiece (Option 5273).  Head Band (Option 5274).
	1	
」 S	1	









THESE INSTRUCTIONS COVER THE INTERCONNECTION OF TYPE 90 ENCODER TO MASTR CONTROLLER.

- ( | ) INSTRUCTIONS
  - LOOSEN THUMB SCREWS ON REAR OF MASTR CONTROLLER UNIT AND REMOVE COVER.
  - 2. CONNECT 19C3O3764G5 CABLE TO MASTR CONTROLLER PER CONNECTION CHART.
  - 3. IF THE TONE ENCODER IS EQUIPPED WITH THE TONE BURST OPTION MOVE BL WIRE FROM TBIIOI-8 TO TBIIOI-21. CLIP OUT Q9 ON AUDIO BOARD (SEE VIEW AT "A") AND CLIP OUT CR3 ON TONE BURST BOARD (AI302) FIG. 3.
  - 4. REASSEMBLE UNITS.

CONNECTION CHART				
WIRE TO				
G	TB1101-10			
SHIELD	TB1101-7			
BR	TB1101-17			
BL	TB1101-8			

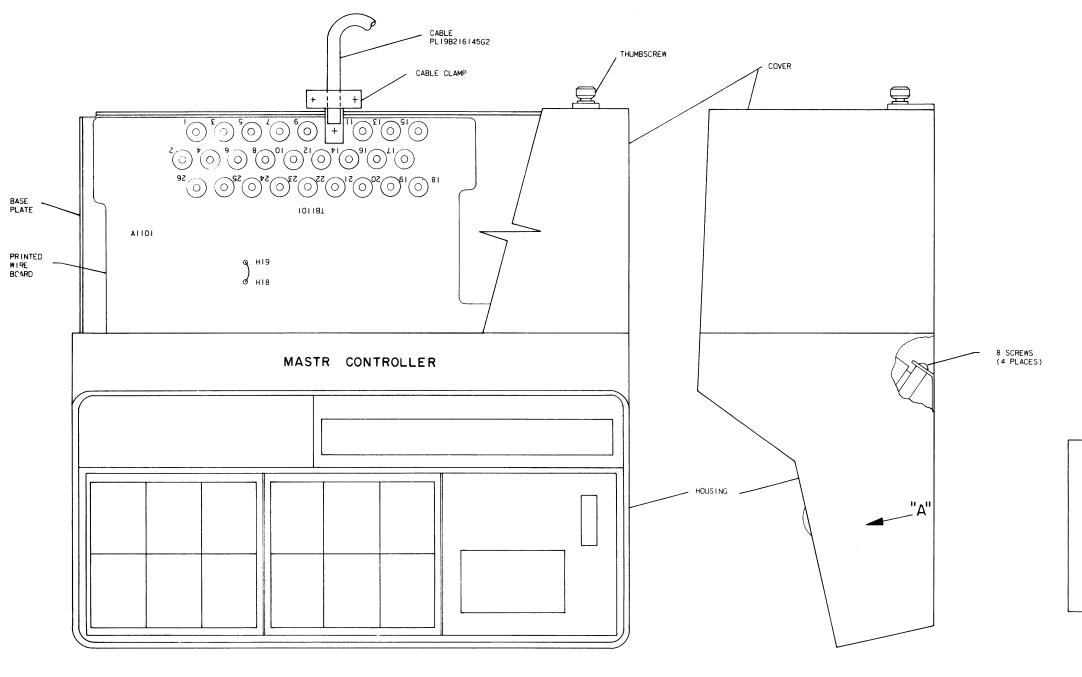
(19D416920, Rev. 2)

### **INSTALLATION INSTRUCTIONS**

TYPE 90 ENCODER (OPTION 8564)

Issue 3

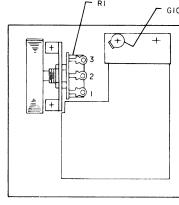
79



THESE INSTRUCTIONS COVER THE INTERCONNECTION OF TYPE 90 DECODER. TYPE 99 DECODER OR DIGITAL DECODER TO MASTR CONTROLLER. (KIT PL19A127156G3)

#### INSTRUCTIONS:

- I. LOOSEN THUMBSCREWS IN REAR OF MASTR CONTROLLER UNIT AND REMOVE COVER.
- 2. REMOVE FOUR (4) #8 SCREWS AND REMOVE HOUSING.
- 3. MOUNT GIO TERMINAL (A4036835PG) UNDER SCREW AS SHOWN IN VIEW AT "A".
- MOVE SHIELD FROM VOLUME CONTROL (RI-I) TO GIO.
- 5. CONNECT 27 OHM I/2 W RESISTOR FROM GIO TO RI-I.
- 6. CONNECT CABLE (198216145G2) TO MASTR CONTROLLER UNIT PER CONNECTION CHART. SEE FIGURE I.
- 7. REMOVE JUMPER FROM ALIOI-HIS TO ALIOI-HIS.
- 8. REASSEMBLE UNITS.



VIEW AT "A"

CONNECTION CHART				
CABLE PL19B216145G2	10	REMARKS		
R	TB1101-24			
BK	TB1101-25	SEE NOTE I		
SHIELD	TB1101-7			

#### NOTE

1. WHEN OPTION 8560 OR 8565 IS USED WITH HANDSET OPTION 8582-8585, CONNECT BK WIRE TO TBIIOI-26.

FIG. I

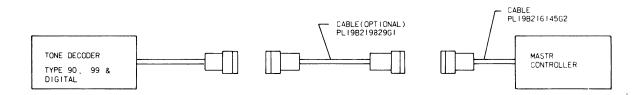
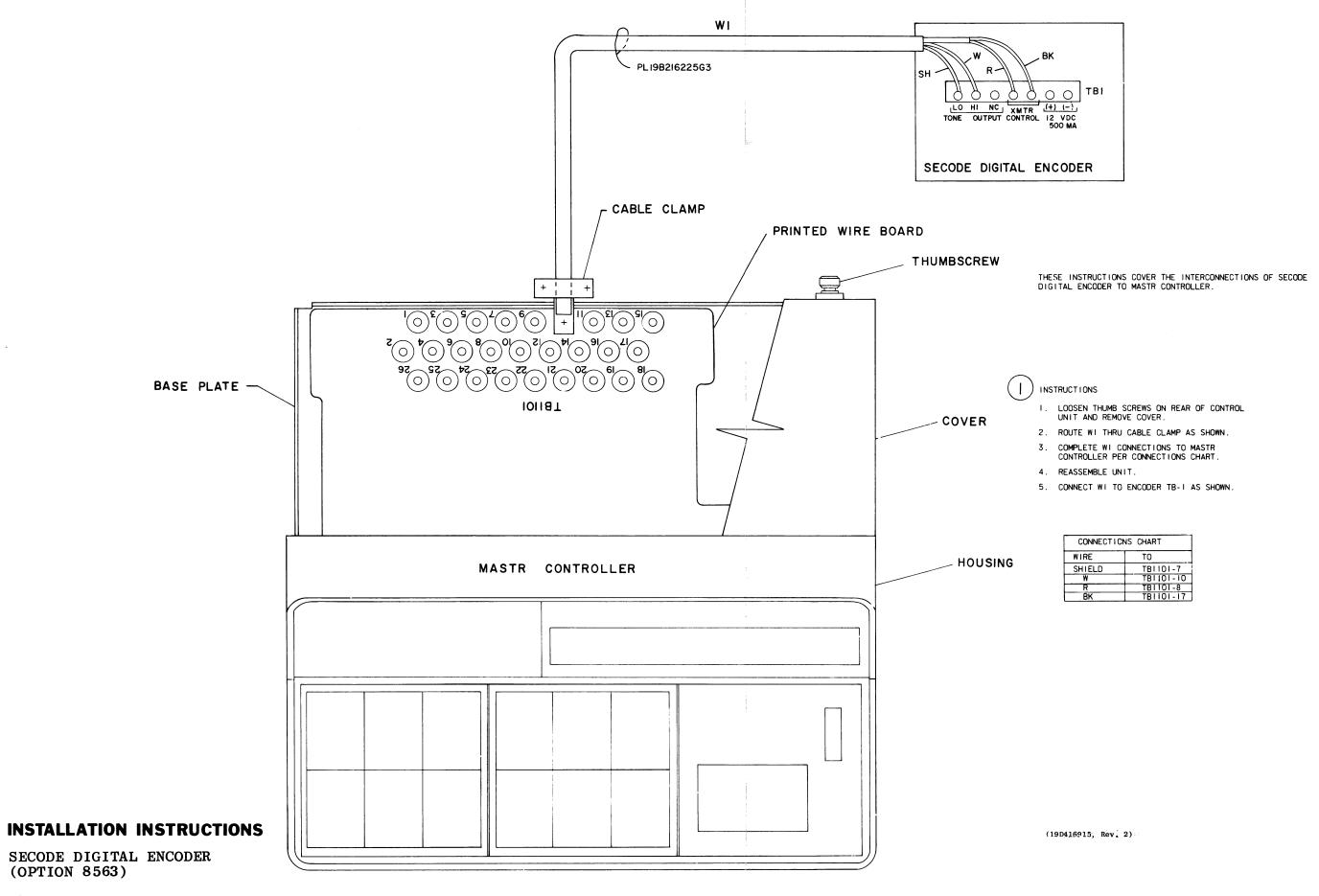


FIG. 2

(19D416922, Rev. 4)

# INSTALLATION INSTRUCTIONS

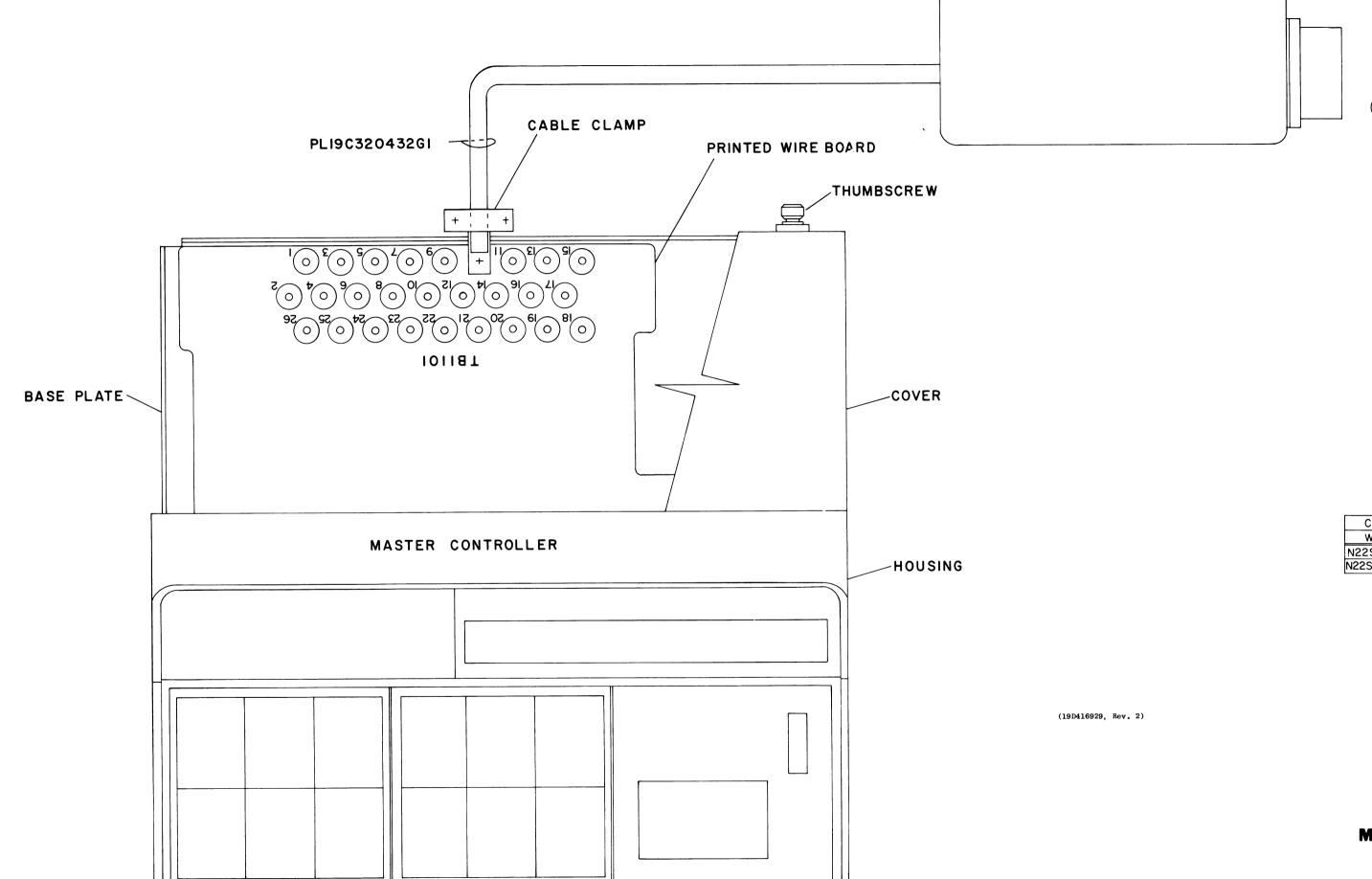
TYPE 90, TYPE 99 OR DIGITAL DECODER (OPTIONS 8560 OR 8565)



**82** 

(OPTION 8563)

Issue 3



THESE INSTRUCTIONS COVER THE INTERCONNECTIONS MIC, BOOM TO MASTR CONTROLLER.

( / )

#### INSTRUCTIONS

- LOOSEN THUMB SCREW ON REAR OF CONTROL UNIT AND REMOVE COVER.
- 2. ROUTE WI THRU CABLE CLAMP AS SHOWN.
- COMPLETE WI CONNECTIONS TO MASTR CONTROLLER PER CONNECTIONS CHART.
- 4. RE-ASSEMBLE UNIT.

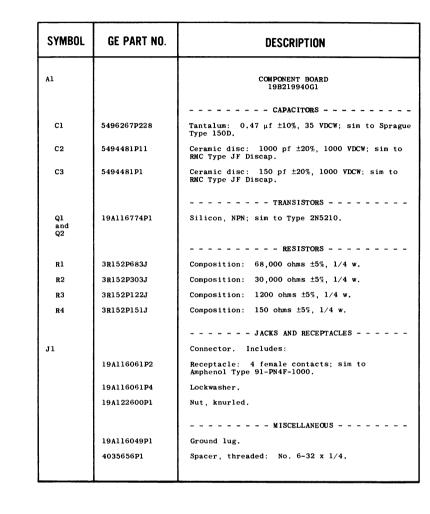
CONNECTIONS CHART
WIRE TO
N22SJ-G TBIIOI-23
N22SJ-SHIELD TBIIOI-22

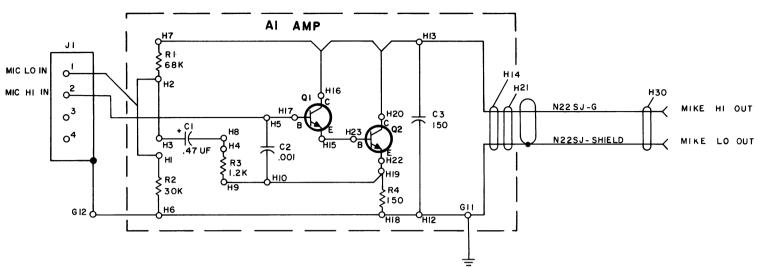
# MIKE BOOM INTERCONNECTIONS

OPTIONS 8549 & 8550

Issue 3

83





ALL RESISTORS ARE 1/4 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K-1000 OHMS OR MEG = 1,00,000 OHMS CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED BY UF= MICROFARADS, INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH= MILLIHENRYS OR H=HENRYS.

IN ORDER TO RETAIN RATED EQUIPMENT PERFORMANCE, REPLACEMENT OF ANY SERVICE PART SHOULD BE MADE ONLY WITH A COMPONENT HAVING THE SPECIFICATIONS SHOWN ON THE PARTS LIST FOR THAT PART.

UNLESS OTHERWISE NOTED ALL WIRE IS DA. 19C32O432GI

SEE APPLICABLE PRODUCTION CHANGE SHEETS IN INSTRUCTION BOOK SECTION DEALING WITH THIS UNIT, FOR DESCRIPTION OF CHANGES UNDER EACH REVISION LETTER. THIS ELEM DIAG APPLIES TO REV LETTER

SYMBOL GE PART NO. DESCRIPTION Cartridge, RP51. Cable and plug. (Includes J1, P2) RP52. Swivel hardware. RP53. Transformer and switch assembly. RP56 7774934P4 Floating arm.

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.

(19B226183, Rev. 1)

PARTS LIST

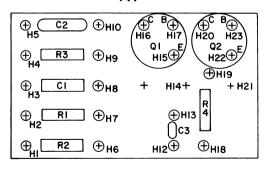
LBI-4678B

MIKE BOOM 4EM13A1

OUTLINE DIAGRAM

ΑI

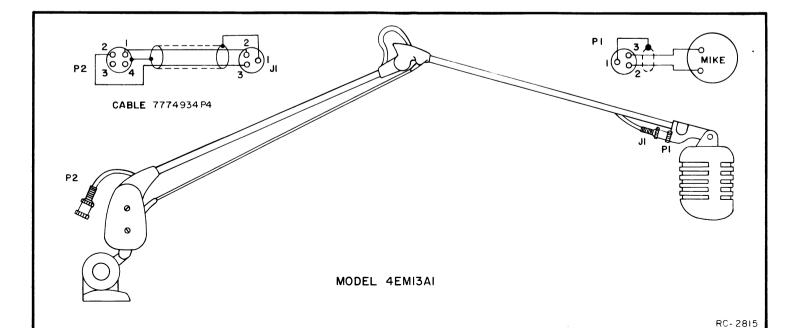
(19C320435, Rev. 3)



(19B226728, Rev. 0)

TRIANGULAR IN-LINE VIEW FROM LEAD END

NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION



VIEW AT "A"

# **SERVICE SHEET**

MIKE BOOM PRE-AMP & MICROPHONE (OPTIONS 8549 & 8550)

Issue 5

PARTS LIST

LBI-4532B

MIKE BOOM PRE-AMP 19C320432G1

### **PRODUCTION CHANGES**

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

Rev. A - To make the mike connector compatable with MASTR Controller. Added a ground lug (194116049P1) in place of the lock washer for J1.

### PARTS LIST

LBI-4473

DESK MICROPHONES 19B209458P1 (STANDARD) 19B209459P1 (CHANNEL GUARD) (SEE RC-2459)

SYMBOL	GE PART NO.	DESCRIPTION
		STANDARD DESK MICROPHONE 19B209458P1
1		Locking plate. (Part of item 4).
2		Gasket. (Part of item 4).
3		"O" Ring. (Part of item 4).
4		Head Assembly. RP122. (Includes items 1-3, 24-26).
5		(Not Used).
6		Switch Kit. RP124. (Includes items 11, 17).
7		Retaining Bar. (Part of item 9).
8		Screw, thread forming, slotted: No. 4 x 1/2. (Part of item 9).
9		Cable Kit. RP123. (Includes items 7, 8).
10		Screw, thread forming, slotted: No. 8 x 3/4. (Part of item 20).
11		Screw, thread forming, slotted: No. 4 x 5/8. (Part of item 6).
12		(Not Used).
13		(Not Used).
14		Base plate. (Part of item 16).
15		Screw, thread forming, slotted: No. 8 x 3/4. (Secures Base Plate- Part of item 16).
16		Base Assembly. RP125. (Includes items 14, 15, 19).
17		Pushbutton, Transmit. (Part of item 6).
18		(Not Used).
19		Nameplate. (Part of item 16).
20		Stem Assembly. RP121.
21		Screw, thread forming, slotted: No. 8 x 1/2. (Part of item 20).
22		Clamp. (Secures Head Assembly to Stem Assembly- Part of item 20).
23		Transistorized Cartridge. RPll7.
24		Screw, thread forming, slotted: No. 4 x 1/2. (Part of item 4).
25		Grille. (Part of item 4).
26		Dust cloth. (Part of item 4).
		CHANNEL GUARD DESK MICROPHONE 198209459P1
1		Locking plate. (Part of item 4).
2		Gasket. (Part of item 4).
3		"O" Ring. (Part of item 4).
4		Head Assembly. RP122. (Includes items 1-3, 24-26).
5		Lock spring. (Part of item 6).
6		Switch Kit. RPll9. (Includes items 5, 11, 12, 13, 17, 18).
7		
, l		Retaining Bar. (Part of item 9).  Screw, thread forming, slotted: No. 4 x 1/2.
-		(Part of item 9).
9		Cable Kit. RP118. (Includes items 7, 8).
l		

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.

SYMBOL	GE PART NO.	DESCRIPTION
10		Screw, thread forming, slotted: No. 8 x 3/4.
11		(Part of item 20).  Screw, thread forming, slotted: No. 4 x 5/8. (Part of item 6).
12		(Part of item 6).  Spring. (Part of item 6).
13		Retainer. (Part of item 1).
14		Base plate. (Part of item 16).
15		Screw, thread forming slotted: No. 8 x 3/4. (Secures Base Plate- Part of item 16).
16		Base Assembly. RP120. (Includes items 14, 15, 19).
17		Pushbutton, Monitor. (Part of item 6).
18 19		Pushbutton, Transmit. (Part of item 6).
20		Nameplate. (Part of item 16). Stem Assembly. RP121.
21		Screw, thread forming, slotted: No. 8 x 1/2.
22		(Part of item 20).  Clamp. (Secures Head Assembly to Stem Assembly
23		Part of item 20). Transistorized Cartridge. RP117.
24		Screw, thread forming, slotted: No. 4 x 1/2.
25		(Part of item 4).  Grille. (Part of item 4).
26		Dust cloth. (Part of item 4).
İ		
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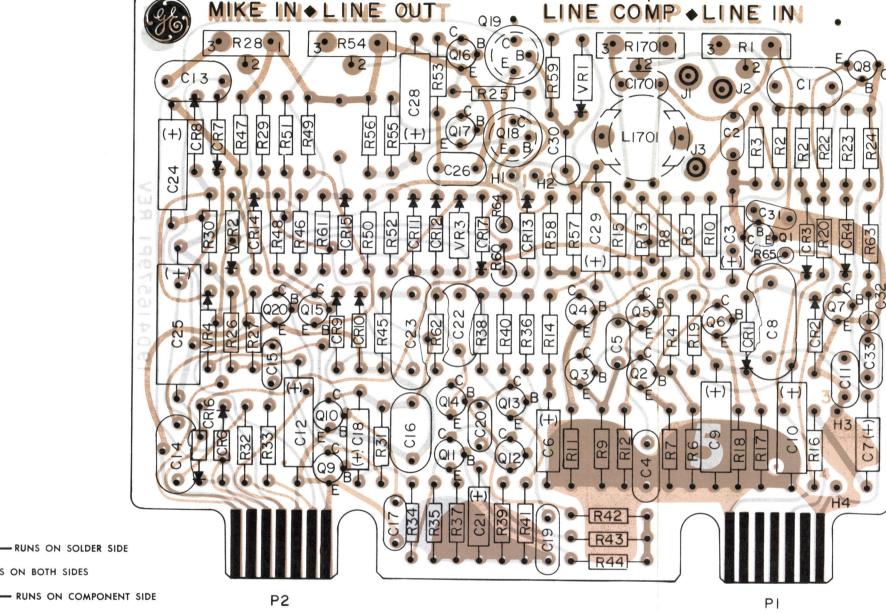
26 25 24 23 22 21	5 6	7 8
17,18 16 15 14	VIEW "A"	RC-2459

# **SERVICE SHEET**

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DESK MICROPHONES 19B209458P1 & 19B**20945**9P1

R1701, C1701 & L1701 ARE PART OF MOD. KIT PL 19 A 12 9 3 1 7 LINE COMP + LINE IN



(19D417317, Rev. 3) (19D416579, Sh. 2, Rev. 5) (19D416579, Sh. 3, Rev. 5)



TYPICAL CONTACT FINGER NUMBERING

# **OUTLINE DIAGRAM**

AUDIO BOARD 19D416629G1

Issue 4

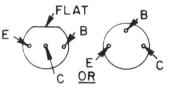
RUNS ON BOTH SIDES

86



MOUNTING FOR C30 & C32

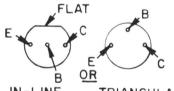
LEAD IDENTIFICATION FOR QI-Q5, Q7-QI4,QI6,Q 20



IN-LINE TRIANGULAR VIEW FROM LEAD END

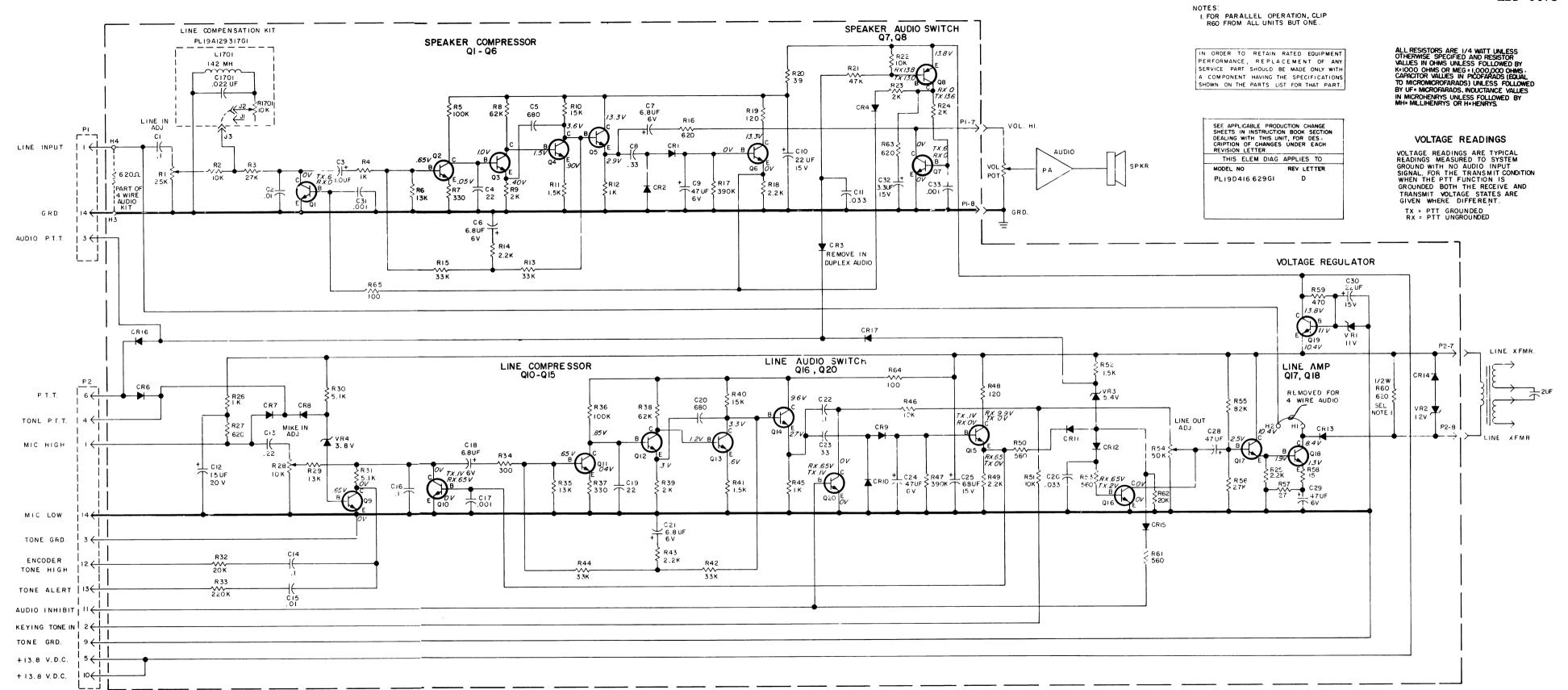
NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

LEAD IDENTIFICATION FOR Q6,Q15,Q17,Q18,Q19



IN-LINE TRIANGULAR VIEW FROM LEAD END

NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.



(19R621826, Rev. 8)

# **SCHEMATIC DIAGRAM**

AUDIO BOARD 19D416629G1

#### PARTS LIST

#### LBI-4519B

AUDIO BOARD 19D416629G1 (Part of Mastr Controller 19D416689G1)

SYMBOL	GE PART NO.	DESCRIPTION
-		
C1	19A116080P7	Polyester: 0.1 µf ±20%, 50 VDCW.
C2	19A116080P101	Polyester: 0.01 µf ±10%, 50 VDCW.
C3	5496267P17	Tantalum: 1.0 µf ±20%, 35 VDCW; sim to Sprague Type 150D.
C4	7489162P11	Silver mica: 22 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C5	5494481P109	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C6 and C7	5496267P1	Tantalum: 6.8 $\mu f$ $\pm 20\%$ , 6 VDCW; sim to Sprague Type 150D.
C8	19A116080P10	Polyester: 0.33 µf ±20%, 50 VDCW.
C9	5496267P2	Tantalum: 47 μf ±20%, 6 VDCW; sim to Sprague Type 150D.
C10	5496267P10	Tantalum: 22 μf ±20%, 15 VDCW; sim to Sprague Type 150D.
C11	19A116080P4	Polyester: 0.033 µf ±20%, 50 VDCW.
C12	5496267P14	Tantalum: 15 μf ±20%, 20 VDCW; sim to Sprague Type 150D.
C13	19A116080P9	Polyester: 0.22 µf ±20%, 50 VDCW.
C14	19A116080P7	Polyester: 0.1 µf ±20%, 50 VDCW.
C15	19A116080P101	Polyester: 0.01 µf ±10%, 50 VDCW.
C16	19A116080P7	Polyester: 0.1 µf ±20%, 50 VDCW.
C17	5494481P111	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C18	5496267Pl	Tantalum: 6.8 μf ±20%, 6 VDCW; sim to Sprague Type 150D.
C19	7489162P11	Silver mica: 22 pf $\pm 5\%$ , 500 VDCW; sim to Electro Motive Type DM-15.
C20	5494481P109	Ceramic disc: 680 pf $\pm 20\%$ , 1000 VDCW; sim to RMC Type JF Discap.
C21	5496267P1	Tantalum: 6.8 $\mu f$ ±20%, 6 VDCW; sim to Sprague Type 150D.
C22	19A116080P7	Polyester: 0.1 $\mu$ f ±20%, 50 VDCW.
C23	19A116080P10	Polyester: 0.33 $\mu f$ ±20%, 50 VDCW.
C24	5496267P2	Tantalum: 47 $\mu f$ ±20%, 6 VDCW; sim to Sprague Type 150D.
C25	5496267P11	Tantalum: 68 $\mu f$ ±20%, 15 VDCW; sim to Sprague Type 150D.
C26	19A116080P4	Polyester: 0.033 $\mu f \pm 20\%$ , 50 VDCW.
C27*	19A116080P9	Polyester: 0.22 $\mu f$ ±20%, 50 VDCW. Deleted by REV A.
C28 and C29	5496267P2	Tantalum: 47 $\mu f$ ±20%, 6 VDCW; sim to Sprague Type 150D.
C30	5496267P10	Tantalum: 22 $\mu f$ $\pm 20\%,~15$ VDCW; sim to Sprague Type 150D.
C31	5494481P111	Ceramic disc: 1000 pf $\pm 20\%$ , 1000 VDCW; sim to RMC Type JF Discap.
C32	5496267P9	Tantalum: 3.3 $\mu f$ ±20%, 15 VDCW; sim to Sprague Type 150D.
C33	5494481P111	Ceramic disc: 1000 pf $\pm 20\%$ , 1000 VDCW; sim to RMC Type JF Discap.
		DIODES AND RECTIFIERS
	19A115250Pl	Silicon.

SYMBOL	GE PART NO.	DESCRIPTION	SYMBO
CR3*	19A115100P2	Silicon; sim to Type 1N459A.	R3
		In REV A and earlier:	R4
	19A115250P1	Silicon.	R5
CR4	19A115250P1	Silicon.	R6
CR6*	19A115100P2	Silicon; sim to Type 1N459A.	R7
thru CR8*		In PRV A and could be	R8
	19All5250Pl	In REV A and earlier:	R9
CR9	19A115250P1	Silicon. Silicon.	R10
thru CR12	19411323021	Silicon.	R11
CR13* and	4037822P7	Silicon.	R12 R13
CR14*		In REV A and earlier:	R14
	4037822P2	Silicon.	R15
CR15	19A115250P1	Silicon.	R16
CR16*	19A115100P2	Silicon; sim to Type lN459A.	R17
and CR17*		In REV A and earlier:	R18
	19A115250P1	Silicon.	R19
	19811323071	Siffeon.	R20
			R21
Jl thru	4033513P4	Contact, electrical: sim to Bead Chain L93-3.	R22
J3			R23
			and R24
Pl and		(Part of printed wiring board 19D416579P1).	R25
P2			R26
		TRANSISTORS	R27
Q1	19A115552P1	Silicon, NPN; sim to Type 2N2714.	R28
Q2 thru Q5	19A115889P1	Silicon, NPN.	R29
Q6	19A116774P1	Silicon, NPN; sim to Type 2N5210.	R30 and
Q7	19Al15552Pl	Silicon, NPN; sim to Type 2N2714.	R31
Q8	19A115768P1	Silicon, PNP; sim to Type 2N3702.	R32
Q9 *	19A115720P1	Silicon, NPN; sim to Type 2N2222.	R33
		Earlier than REV A.	R34
	19A115552P1	Silicon, NPN; sim to Type 2N2714.	R35
Q10*	19A129184Pl	Silicon, NPN.	R36
		In REV B and earlier:	R37
	19A115552Pl	Silicon, NPN; sim to Type 2N2714.	R38
Qll thru	19A115889Pl	Silicon, NPN; sim to Type 2N2712.	R39
Q14			R40
Q15	19A116774P1	Silicon, NPN; sim to Type 2N5210.	R41
Q16*	19A115720P1	Silicon, NPN; sim to Type 2N2222.	R42
		Earlier than REV A:	R43
	19A115552P1	Silicon, NPN; sim to Type 2N2714.	R44 R45
Q17	19A116774P1	Silicon, NPN; sim to Type 2N5210.	R46
Q18 and Q19	19A115300P4	Silicon, NPN.	R47
Q20*	19Al 29184P1	Silicon, NPN.	R48
		In REV B and earlier:	R49
	19A115552P1	Silicon, NPN; sim to Type 2N2714.	R50
ŀ			R51
			R52
R1	19B209358P107	Variable, carbon film: approx 75 to 25,000 ohms ±10%, 0.25 w; sim to CTS Type X-201.	R53
R2	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.	R54

3R152P103J

3R152P394J

3R152P121J 3R152P222J 3R152P561J

3R152P103J

3R152P152J

3R152P561J

19B209358P108

Composition: 10,000 ohms  $\pm 5\%$ , 1/4 w.

Composition: 0.39 megohm ±5%, 1/4 w.

Composition: 560 ohms  $\pm 5\%$ , 1/4 w.

Composition: 10,000 ohms  $\pm 5\%$ , 1/4 w.

Variable, carbon film: approx 100 to 50,000 ohms  $\pm 10\%$ , 0.25 w; sim to CTS Type X-201.

Composition: 1500 ohms ±5%, 1/4 w.

Composition: 560 ohms ±5%, 1/4 w.

			\$		
SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
R3	3R152P273J	Composition: $27,000 \text{ ohms } \pm 5\%, 1/4 \text{ w.}$	R55	3R152P823J	Composition: 82,000 ohms ±5%, 1/4 w.
R4	3R152P102J	Composition: 1000 ohms $\pm 5\%$ , 1/4 w.	R56	3R152P273J	Composition: 27,000 ohms ±5%, 1/4 w.
R5	3R152P104J	Composition: 0.1 megohm $\pm 5\%$ , 1/4 w.	R57	3R152P270J	Composition: 27 ohms ±5%, 1/4 w.
R6	3R152P133J	Composition: $13,000$ ohms $\pm 5\%$ , $1/4$ w.	R58	3R152P150J	Composition: 15 ohms ±5%, 1/4 w.
R7	3R152P331J	Composition: 330 ohms $\pm 5\%$ , $1/4$ w.	R59	3R152P471J	Composition: 470 ohms ±5%, 1/4 w.
R8	3R152P623J	Composition: $62,000$ ohms $\pm 5\%$ , $1/4$ w.	R60*	3R77P621J	Composition: 620 ohms ±5%, 1/2 w.
R9	3R152P202J	Composition: 2000 ohms $\pm 5\%$ , $1/4$ w.	Í		In REV A and earlier:
R10	3R152P153J	Composition: 15,000 ohms $\pm 5\%$ , 1/4 w.	Ì	3R152P621J	Composition: 620 ohms ±5%, 1/4 w.
R11	3R152P152J	Composition: 1500 ohms $\pm 5\%$ , $1/4$ w.	R61	3R152P561J	Composition: 560 ohms ±5%, 1/4 w.
R12	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.	R62	3R152P203J	Composition: 20,000 ohms ±5%, 1/4 w.
R13	3R152P333J	Composition: 33,000 ohms $\pm 5\%$ , $1/4$ w.	R63	3R152P621J	Composition: 620 ohms ±5%, 1/4 w.
R14	3R152P222J	Composition: 2200 ohms ±5%, 1/4 w.	R64	3R152P101J	Composition: 100 ohms ±5%, 1/4 w.
R15	3R152P333J	Composition: 33,000 ohms $\pm 5\%$ , $1/4$ w.	and R65		·
R16	3R152P621J	Composition: 620 ohms $\pm 5\%$ , $1/4$ w.			VOLTAGE REGULATORS
R17	3R152P394J	Composition: 0.39 megohm ±5%, 1/4 w.	VR1	4036887P8	Silicon, Zener.
R18	3R152P222J	Composition: 2200 ohms ±5%, 1/4 w.	VR2	19A116325P4	Silicon, Zener; sim to Type 1N5349.
R19	3R152P121J	Composition: 120 ohms $\pm 5\%$ , $1/4$ w.	VR3	4036887P5	Silicon, Zener.
R20	3R152P390J	Composition: 39 ohms ±5%, 1/4 w.	VR4*	4036887P3	Silicon, Zener.
R21	3R152P473J	Composition: $47,000$ ohms $\pm 5\%$ , $1/4$ w.			In REV C and earlier:
R22	3R152P103J	Composition: $10,000$ ohms $\pm 5\%$ , $1/4$ w.		4036887P1	Silicon, Zener.
R23	3R152P202J	Composition: 2000 ohms $\pm 5\%$ , $1/4$ w.		100100111	
and R24					MISCELLANEOUS
R25	3R152P222J	Composition: 2200 ohms $\pm 5\%$ , $1/4$ w.		4036555P1	Insulator, disc. (Used with Q18 and Q19).
R26	3R152P102J	Composition: 1000 ohms $\pm 5\%$ , $1/4$ w.	11 '	4035656P70	Spacer, threaded: No. 6-32 x 5/16.
R27	3R152P621J	Composition: 620 ohms $\pm 5\%$ , $1/4$ w.		4034048P4	Screw, machine: No. 6-32 x 5/16.
R28	19B209358P106	Variable, carbon film: approx 75 to 10,000 ohms ±10%, 0.25 w; sim to CTS Type X-201.			
R29	3R152P133J	Composition: $13,000$ ohms $\pm 5\%$ , $1/4$ w.			
R30 and R31	3R152P512J	Composition: 5100 ohms $\pm 5\%$ , $1/4$ w.	- And Andrews		
R32	3R152P203J	Composition: 20,000 ohms $\pm 5\%$ , $1/4$ w.			
R33	3R152P224J	Composition: 0.22 megohm ±5%, 1/4 w.			
R34	3R152P301J	Composition: 300 ohms ±5%, 1/4 w.	]		
R35	3R152P133J	Composition: 13,000 ohms ±5%, 1/4 w.			
R36	3R152P104J	Composition: 0.1 megohm ±5%, 1/4 w.			
R37	3R152P331J	Composition: 330 ohms ±5%, 1/4 w.			
R38	3R152P623J	Composition: 62,000 ohms ±5%, 1/4 w.			
R39	3R152P202J	Composition: 2000 ohms ±5%, 1/4 w.			
R40	3R152P252J	Composition: 15,000 ohms ±5%, 1/4 w.			
R41	3R152P152J	Composition: 1500 ohms ±5%, 1/4 w.			
R42	3R152P333J	Composition: 33,000 ohms ±5%, 1/4 w.			
R42	3R152P333J 3R152P222J				
R43	3R152P222J 3R152P333J	Composition: 2200 ohms ±5%, 1/4 w.		•	
		Composition: 33,000 ohms ±5%, 1/4 w.			
R45	3R152P102J	Composition: 1000 ohms $\pm 5\%$ , $1/4$ w.			

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

## **PRODUCTION CHANGES**

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

Rev. A - To reduce distortion at 300 Hz and to reduce tone feed through. Deleted C27 and changed Q9 and Q16.

Rev. B - To add additional protection from lightning. Changed CR3, CR6, CR7, CR8, CR13, CR14, CR16, CR17 and R60.

Rev. C - To improve reliability. Changed Q10 and Q20.

REV. D - To prevent Q9 from loading the Tone Encode output. Changed VR4.

### **ORDERING SERVICE PARTS**

Each component appearing on the schematic diagram is identified by a symbol number, to simplify locating it in the parts list. Each component is listed by symbol number, followed by its description and GE Part Number.

Service parts may be obtained from Authorized GE Communication Equipment Service Stations or through any GE Radio Communication Equipment Sales Office. When ordering a part, be sure to give:

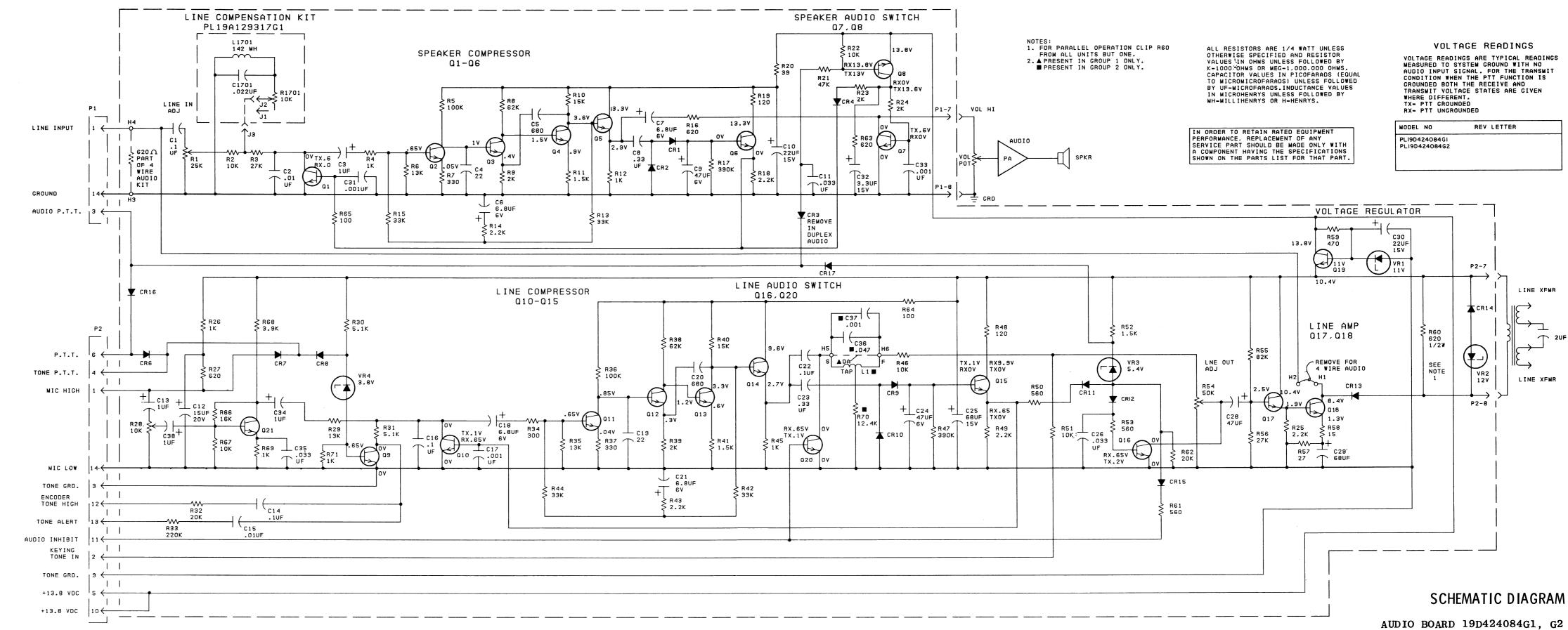
- GE Part Number for component
   Description of part
- 3. Model number of equipment
- 4. Revision letter stamped on unit

These instructions do not purport to cover all details or variations in equipment nor to provide for every possible contingency to be met in connection with installation, operation or mair tenance.

Should further information be desired, or should particular problems arise which are not covered sufficiently for the purchaser's purposes, contact the nearest Radio Communication Equipment Sales Office of the General Electric Company.

MOBILE RADIO DEPARTMENT
GENERAL ELECTRIC COMPANY ● LYNCHBURG, VIRGINIA 24502





# Addendum to LBI-4478

PARTS LIST

LBI-302

AUDIO BOARD 19D424084G1 DC CONTROL 19D424084G2 TONE CONTROL

SYMBOL	GE PART NO.	DESCRIPTION			
Cl	19A116080P7	Polyester: 0.1 µf ±20%, 50 VDCW.			
C2	19A116080P101	Polyester: 0.01 µf ±10%, 50 VDCW.			
C3	5496267P17	Tantalum: 1.0 µf ±20%, 35 VDCW; sim to Sprague Type 150D.			
C4	7489162P11	Silver mica: 22 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.			
C5	5494481P109	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.			
C6 and C7	5496267P1	Tantalum: 6.8 µf ±20%, 6 VDCW; sim to Sprague Type 150D.			
C8	19A116080P10	Polyester: 0.33 µf ±20%, 50 VDCW.			
C9	5496267P2	Tantalum: 47 µf ±20%, 6 VDCW; sim to Sprague Type 150D.			
C10	5496267P10	Tantalum: 22 µf ±20%, 15 VDCW; sim to Sprague Type 150D.			
C11	19A116080P4	Polyester: 0.033 µf ±20%, 50 VDCW.			
C12	5496267P14	Tantalum: 15 µf ±20%, 20 VDCW; sim to Sprague Type 150D.			
C13	19A116080P7	Tantalum: 1.0 µf ±20%, 35 VDCW; sim to Sprague Type 150D.			
C14 C15	<b>!</b>	Polyester: 0.1 µf ±20%, 50 VDCW.			
C16	19A116080P101 19A116080P7	Polyester: 0.01 µf ±10%, 50 VDCW.			
C17	5494481P111	Polyester: 0.1 μf ±20%, 50 VDCW.  Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.			
C18	5496267Pl	Tantalum: 6.8 µf ±20%, 6 VDCW; sim to Sprague Type 150D.			
C19	7489162P11	Silver mica: 22 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.			
C20	5494481P109	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.			
C21	5496267P1	Tantalum: 6.8 µf ±20%, 6 VDCW; sim to Sprague Type 150D.			
C22	19A116080P7	Polyester: 0.1 μf ±20%, 50 VDCW.			
C23 C24	19A116080P10 5496267P2	Polyester: 0.33 µf ±20%, 50 VDCW.  Tantalum: 47 µf ±20%, 6 VDCW; sim to Sprague			
C25	5496267P11	Type 150D.  Tantalum: 68 µf ±20%, 15 VDCW; sim to Sprague			
		Type 150D.			
C26	19A116080P4	Polyester: 0.033 µf ±20%, 50 VDCW.			
C28	5496267P2 5496267P11	Tantalum: 47 µf ±20%, 6 VDCW; sim to Sprague Type 150D.  Tantalum: 68 µf ±20%. 15 VDCW: sim to Sprague			
C <b>29</b> C <b>3</b> 0	5496267P11 5496267P10	Type 150D.  Tantalum: 22 uf ±20%. 15 VDCW: sim to Sprague			
C31	5494481P111	Type 150D.  Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to			
C32	5496267P9	RMC Type JF Discap.  Tantalum: 3.3 µf ±20%, 15 VDCW; sim to Sprague			
с33	5494481P111	Type 150D.  Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.			
C34	5496267P17	Tantalum: 1.0 µf ±20%, 35 VDCW; sim to Sprague Type 150D.			
C35	19A116080P204	Polyester: 0.033 µf ±5%, 50 VDCW.			

s	YMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
c	36	19C307114P4702G	Polystyrene: 47,000 pf ±2%, 100 VDCW, temp coef -120±30 PPM °C.	R6	3R152P133J	Composition: 13,000 ohms ±5%, 1/4 w.	R58	3R152P150J	Composition: 15 ohms ±5%, 1/4 w.
	_			R7	3R152P331J	Composition: 330 ohms ±5%, 1/4 w.	R59	3R152P471J	Composition: 470 ohms ±5%, 1/4 w.
C	57	5496203P481	Ceramic disc: 1000 pf ±5%, 500 VDCW, temp coef -5600 PPM.	R8	3R152P623J	Composition: 62,000 ohms ±5%, 1/4 w.	R60	3R77P621J	Composition: 620 ohms ±5%, 1/2 w.
CS	88	5496267P17	Tantalum: 1.0 μf ±20%, 35 VDCW; sim to Sprague Type 150D.	R9	3R152P202J	Composition: 2000 ohms ±5%, 1/4 w.	R61	3R152P561J	Composition: 560 ohms ±5%, 1/4 w.
			Type 130D.	R10	3R152P153J	Composition: 15,000 ohms ±5%, 1/4 w.	R62	3R152P203J	Composition: 20,000 ohms ±5%, 1/4 w.
			DIODES AND RECTIFIERS	R11	3R152P152J	Composition: 1500 ohms ±5%, 1/4 w.	R63	3R152P621J	Composition: 620 ohms ±5%, 1/4 w.
CF ar		19A115250P1	Silicon,	R12	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.	R64 and	3R152P101J	Composition: 100 ohms ±5%, 1/4 w.
CF				R13	3R152P333J	Composition: 33,000 ohms ±5%, 1/4 w.	R65		
CF		19A115100P2	Silicon; sim to Type 1N459A.	R14	3R152P222J	Composition: 2200 ohms ±5%, 1/4 w.	R66	3R152P163J	Composition: 16,000 ohms ±5%, 1/4 w.
CF		19A115250P1	Silicon.	R15	3R152P333J	Composition: 33,000 ohms ±5%, 1/4 w.	R67	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.
	ıru	19A115100P2	Silicon; sim to Type 1N459A.	R16	3R152P621J	Composition: 620 ohms ±5%, 1/4 w.	R68	3R152P392J	Composition: 3900 ohms ±5%, 1/4 w.
CE		10411505001	8/1/	R17	3R152P394J	Composition: 0.39 megohm ±5%, 1/4 w.	R69	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.
th	iru 112	19A115250P1	Silicon.	R18	3R152P222J	Composition: 2200 ohms ±5%, 1/4 w.	R70	19C314256P21242	Metal film: 12,400 ohms ±1%, 1/4 w.
I I	113	4037822P7	Silicon.	R19 R20	3R152P121J 3R152P390J	Composition: 120 ohms ±5%, 1/4 w.	R71	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.
ar		1001022F1	Silicon.	R20	3R152P473J	Composition: 39 ohms ±5%, 1/4 w.  Composition: 47,000 ohms ±5%, 1/4 w.			VOLTAGE REGULATORS
1 1	115	19A115250Pl	Silicon.	R21	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.	VR1	4036887P8	Silicon, Zener.
	116	19A115100P2	Silicon; sim to Type 1N459A.	R23	3R152P202J	Composition: 2000 ohms ±5%, 1/4 w.	VR2	19A116325P4	Silicon, Zener; sim to 1N5349.
ar CF	nd 117			and R24			VR3	4036887P5	Silicon, Zener.
				R25	3R152P222J	Composition: 2200 ohms ±5%, 1/4 w.	VR4	4036887P3	Silicon, Zener.
			JACKS AND RECEPTACLES	R26	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.			miscellaneous
	ru	4033513P4	Contact, electrical: sim to Bead Chain L93-3.	R27	3R152P621J	Composition: 620 ohms ±5%, 1/4 w.		4035656P70	Spacer, threaded.
J3	3			R28	19B209358P106	Variable, carbon film: approx 300 to 10,000 ohms		4036555P1	Insulator, washer: nylon. (Used with Q18 and
l I			INDUCTORS		1	±10%, 0.25 w; sim to CTS Type X-201.			Q19).
l Li		19B205354G8	Coil.	R29	3R152P133J	Composition: 13,000 ohms ±5%, 1/4 w.		4034048P4	Machine screw, pan head, 6-32 x 9/16 with .340 cutaway.
				R30 and	3R152P512J	Composition: 5100 ohms ±5%, 1/4 w.			
Pl			(Part of printed board 19D424083Pl).	R31 R32	3R152P203J	Composition, 20 000 object to 1/4 m			
ar P2	2			R32	3R152P224J	Composition: 20,000 ohms ±5%, 1/4 w.  Composition: 0.22 megohm ±5%, 1/4 w.			
				R34	3R152P2245 3R152P301J	Composition: 300 ohms ±5%, 1/4 w.			
Q1		19A115552P1	Silicon, NPN; sim to Type 2N2714.	R35	3R152P133J	Composition: 13,000 ohms ±5%, 1/4 w.			
Q2 th	ru	19A115889P1	Silicon, NPN.	R36	3R152P104J	Composition: 0.10 megohm ±5%, 1/4 w.		1	
Q5				R37	3R152P331J	Composition: 330 ohms ±5%, 1/4 w.			
Qe		19A116774P1	Silicon, NPN; sim to Type 2N5210.	R38	3R152P623J	Composition: 62,000 ohms ±5%, 1/4 w.			
Q	1	19A115552P1	Silicon, NPN; sim to Type 2N2714.	R39	3R152P202J	Composition: 2000 ohms ±5%, 1/4 w.			
Q8	- 1	19A115779P1	Silicon, PNP; sim to Type 2N3251.	R40	3R152P153J	Composition: 15,000 ohms ±5%, 1/4 w.			
QS	- 1	19A115720P1	Silicon, NPN; sim to Type 2N2222.	R41	3R152P152J	Composition: 1500 ohms ±5%, 1/4 w.			
Q1 Q1		19A129184P1 19A115889P1	Silicon, NPN. Silicon, NPN.	R42	3R152P333J	Composition: 33,000 ohms ±5%, 1/4 w.			
tì	iru	198113009F1	Silicon, NPA.	R43	3R152P222J	Composition: 2200 ohms ±5%, 1/4 w.			
QI	- 1	19A116774P1	Silicon, NPN; sim to Type 2N5210.	R44	3R152P333J	Composition: 33,000 ohms ±5%, 1/4 w.			
Qı		19A115720P1	Silicon, NPN; sim to Type 2N2222.	R45	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.			
	17	19A116774P1	Silicon, NPN; sim to Type 2N5210.	R46	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.			
Qı	.8	19A115300P4	Silicon, NPN.	R47	3R152P394J	Composition: 0.39 megohm ±5%, 1/4 w.			
ar Q1				R48	3R152P121J	Composition: 120 ohms ±5%, 1/4 w.		i	
Q	20	19A129184P1	Silicon, NPN.	R49	3R152P222J	Composition: 2200 ohms ±5%, 1/4 w.			
Q2	21	19A116774P1	Silicon, NPN; sim to Type 2N5210.	R50	3R152P561J	Composition: 560 ohms ±5%, 1/4 w.	1		
			DEST STORS	R51	3R152P103J 3R152P152J	Composition: 10,000 ohms ±5%, 1/4 w.			
R		19B209358P107		R52 R53	3R152P152J 3R152P561J	Composition: 1500 ohms ±5%, 1/4 w.  Composition: 560 ohms ±5%, 1/4 w.			
"	·	1382033007101	±10%, 0.25 w; sim to CTS Type X-201.	R54	19B209358P108	Variable, carbon film: approx 2000 to 50,000			
R	2	3R152P103J	Composition: 10,000 ohms $\pm 5\%$ , 1/4 w.		1552055501100	ohms ±10%, 0.25 w; sim to CTS Type X-201.			
R3	³	3R152P273J	Composition: 27,000 ohms ±5%, 1/4 w.	R55	3R152P823J	Composition: 82,000 ohms ±5%, 1/4 w.			
R4	۱	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.	R56	3R152P273J	Composition: 27,000 ohms ±5%, 1/4 w.			
R	·	3R152P104J	Composition: 0.10 megohm ±5%, 1/4 w.	R57	3R152P270J	Composition: 27 ohms ±5%, 1/4 w.			
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\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES